



Support & ക training



DP83TC814S-Q1, DP83TC814R-Q1 SNLS663 - DECEMBER 2021

DP83TC814x-Q1 100BASE-T1 Automotive Ethernet PHY

1 Features

- Open Alliance and IEEE 802.3bw 100BASE-T1 compliant
 - Passes Level IV emissions with Integrated LPF
- SAE J2962-3 EMC compliant
- Configurable I/O voltages: 3.3 V, 2.5 V, and 1.8 V •
- MAC interfaces: MII, RMII, RGMII and SGMII
- Optional separate voltage rail for MAC interface pins (3.3 V, 2.5 V, 1.8 V)
- AEC-Q100 qualified for automotive applications:
 - Temperature grade 1: -40°C to +125 °C ambient operating temperature
 - ±8-kV HBM ESD for pins 12 and 13
 - IEC61000-4-2 ESD classification level 4 for pins 12 and 13: ±8-kV contact discharge
- IEEE 1588 SFD support •
- TSN compliant with 802.3br frame pre-emption ٠ support
- Low active power operation: < 230 mW
- Diagnostic tool kit
 - Signal quality indication (SQI)
 - Time domain reflectometry (TDR)
 - Electrostatic discharge sensor
 - Voltage sensor
 - PRBS Built-in Self-Test
 - Loopbacks
- VQFN, wettable flank packaging

2 Applications

- ADAS
- Gateway and Body Control
- **Telematics**

3 Description

The DP83TC814-Q1 device is an IEEE 802.3bwcompliant automotive PHYTER[™] Ethernet physical layer transceiver which can work with Unshielded Twisted Pair cable. It provides all physical layer functions needed to transmit and receive data over unshielded single twisted-pair cables. The device provides xMII flexibility with support for standard MII, RMII. RGMII. and SGMII MAC interfaces. The PHY also integrates a low pass filter on the MDI side to reduce emissions.

This device includes the Diagnostic Tool Kit, providing an extensive list of real-time monitoring tools, debug tools and test modes. Within the tool kit is the first integrated electrostatic discharge (ESD) monitoring tool. It is capable of counting ESD events on MDI as well as providing real-time monitoring through the use of a programmable interrupt. Additionally, the DP83TC814S-Q1includes a pseudo random binary sequence (PRBS) frame generation tool, which is fully compatible with internal loopbacks, to transmit and receive data without the use of a MAC. The device is housed in a 6.00-mm × 6.00-mm, 36-pin VQFN wettable flank package. This device is pin-2pin compatible with DP83TG720 (1000BASE-T1). It is also form factor compatible with DP83TC811. This would allow for a single PCB layout to be used for DP83TC811, DP83TC812, DP83TC814, and DP83TG720.

Device Information

| PART NUMBER | PACKAGE (1) | BODY SIZE (NOM) | |
|---------------|-------------|-------------------|--|
| DP83TC814S-Q1 | VQFN (36) | 6.00 mm × 6.00 mm | |
| DP83TC814R-Q1 | VQFN (36) | 6.00 mm × 6.00 mm | |

For all available packages, see the orderable addendum at (1)the end of the data sheet.

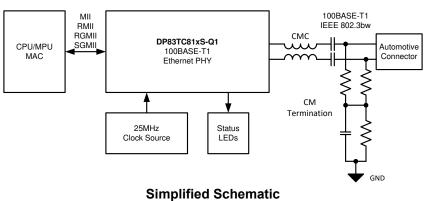






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4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| DATE REVISION | | NOTES | |
|---------------|---|-----------------|--|
| December 2021 | * | Initial Release | |



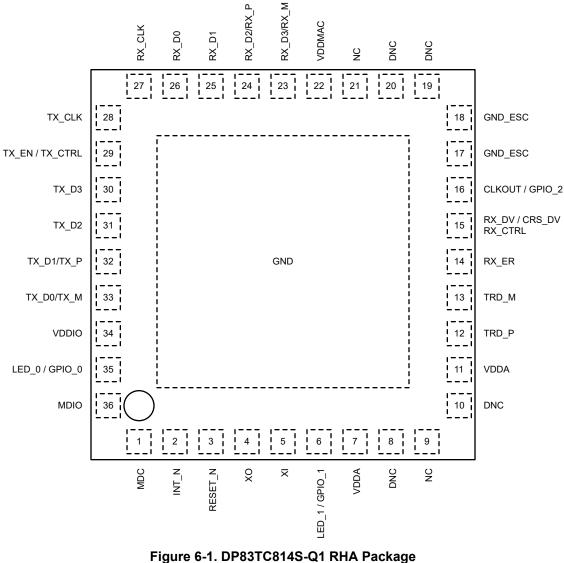
5 Device Comparison Table

| PART NUMBER | SGMII SUPPORT | OPERATING TEMPERATURE | | |
|----------------|------------------|--------------------------|--|--|
| DP83TC814R-Q1 | No | –40°C to 125°C | | |
| DP83TC814S-Q1 | Yes | –40°C to 125°C | | |





6 Pin Configuration and Functions



36-Pin VQFN

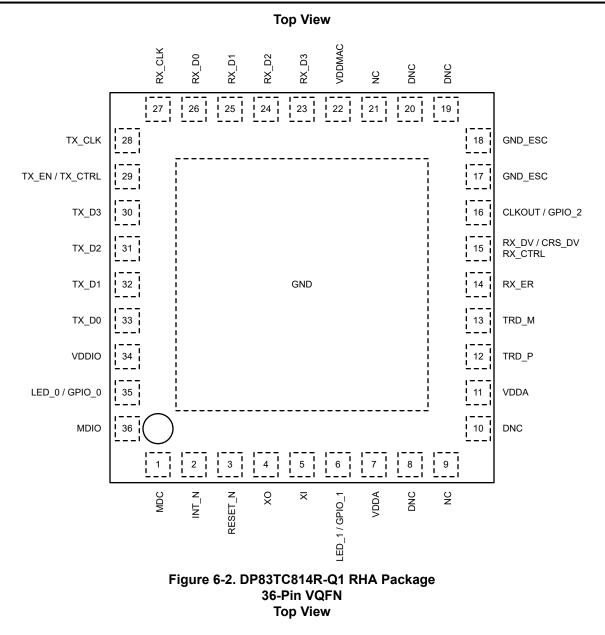




Table 6-1. Pin Functions

| PIN | | STATE ¹ | DESCRIPTION | | | |
|----------------------------|---------|--------------------|--|--|--|--|
| NAME ² | NO. | STATE | DESCRIPTION | | | |
| MAC INTERF | ACE | | | | | |
| RX_D3 RX_M | 23 | | Receive Data: Symbols received on the cable are decoded and transmitted out of these pins synchronous to the rising edge of RX_CLK. They contain valid data when RX_DV is asserted. A data nibble, RX_D[3:0], is transmitted | | | |
| RX_D2 RX_P | 24 | S, PD, O | in MII and RGMII modes. 2 bits; RX_D[1:0], are transmitted in RMII mode. RX_D[3:2] are not used when in RMII mode. | | | |
| RX_D1 | 25 | | If the PHY is bootstrapped to RMII Master mode, a 50-MHz clock reference is automatically outputted on RX_D3. This clock must be fed to the MAC. | | | |
| RX_D0 | 26 | | RX_M / RX_P: Differential SGMII Data Output. These pins transmit data from the PHY to the MAC. | | | |
| RX_CLK | 27 | PD, O | Receive Clock: In MII and RGMII modes, the receive clock provides a 25-MHz reference clock. Unused in RMII and SGMII modes | | | |
| RX_ER | 14 | S, PD, O | Receive Error: In MII and RMII modes, this pin indicates a receive error symbol has been detected within a received packet. In MII mode, RX_ER is asserted high synchronously to the rising edge of RX_CLK. In RMII mode, RX_ER is asserted high synchronously to the reference clock. This pin is not required to be used by the MAC in MII or RMII because the PHY will automatically corrupt data on a receive error. Unused in RGMII and SGMII modes | | | |
| RX_DV CRS_DV RX_CTRL | 15 | S, PD, O | Receive Data Valid: This pin indicates when valid data is presented on RX_D[3:0] for MII mode. Carrier Sense Data Valid: This pin combines carrier sense and data valid into an asynchronous signal. When CRS_DV is asserted, data is presented on RX_D[1:0] in RMII mode. RGMII Receive Control: Receive control combines receive data valid indication and receive error indication into a single signal. RX_DV is presented on the rising edge of RX_CLK and RX_ER is presented on the falling edge of RX_CLK. Unused in SGMII mode | | | |
| TX_CLK | 28 | PD, I, O | Transmit Clock: In MII mode, the transmit clock is a 25-MHz output and has constant phase referenced to the reference clock. In RGMII mode, this clock is sourced from the MAC layer to the PHY. A 25-MHz clock must be provided (not required to have constant phase to the reference clock unless synchronous RGMII is enabled) Unused in RMII and SGMII modes | | | |
| TX_EN TX_CTRL | 29 | PD, I | Transmit Enable: In MII mode, transmit enable is presented prior to the rising edge of the transmit clock. TX_EN indicates the presence of valid data inputs on TX_D[3:0]. In RMII mode, transmit enable is presented prior to the rising edge of the reference clock. TX_EN indicates the presence of valid data inputs on TX_D[1:0]. RGMII Transmit Control: Transmit control combines transmit enable and transmit error indication into a single signal. TX_EN is presented prior to the rising edge of TX_CLK; TX_ER is presented prior to the falling edge of TX_CLK. Unused in SGMII mode | | | |
| TX_D3 | 30 | | | | | |
| TX_D2 | 31 | | Transmit Data: In MII and RGMII modes, the transmit data nibble, TX_D[3:0], is received from the MAC prior to the | | | |
| TX_D1 TX_P | 32 | PD, I | rising edge of TX_CLK. In RMII mode, TX_D[1:0] is received from the MAC prior to the rising edge of the reference clock. TX_D[3:2] are not used in RMII mode. | | | |
| TX_D0 TX_M | 33 | | TX_M / TX_P: Differential SGMII Data Input. These pins receive data that is transmitted from the MAC to the PHY. | | | |
| SERIAL MAN | IAGEMEN | T INTERFACE | | | | |
| MDC | 1 | I | Management Data Clock: Synchronous clock to the MDIO serial management input and output data. This clock may be asynchronous to the MAC transmit and receive clocks. The maximum clock rate is 25 MHz. There is no minimum clock rate. | | | |
| MDIO | 36 | OD, IO | Management Data Input/Output: Bidirectional management data signal that may be sourced by the management station or the PHY. This pin requires a pullup resistor. In systems with multiple PHYs using same MDIO-MDC bus, a single pull-up resistor should be used on MDIO line. Recommended to use a resistor between 2.2 k Ω and 9 k Ω . | | | |



Table 6-1. Pin Functions (continued)

| PIN | | | |
|-----------------------|----------|--------------------|---|
| NAME ² NO. | | STATE ¹ | DESCRIPTION |
| CONTROL IN | ITERFACE | | |
| INT | 2 | PU, OD, IO | Interrupt: Active-LOW output, which will be asserted LOW when an interrupt condition occurs. This pin has a weak internal pullup. Register access is necessary to enable various interrupt triggers. Once an interrupt event flag is set, register access is required to clear the interrupt event. This pin can be configured as an Active-HIGH output using register <i>0x0011</i> . This pin can also operate as Power-Down control where asserting this pin low would put the PHY in power down mode and asserting high would put the PHY in normal mode. This feature can also be enabled via register <i>0x0011</i> . |
| RESET | 3 | PU, I | Reset: Active-LOW input, which initializes or reinitializes the PHY. Asserting this pin LOW for at least 1 µs will force a reset process to occur. All internal registers will reinitialize to their default states as specified for each bit in the Register Maps section. All bootstrap pins are resampled upon deassertion of reset. |
| CLOCK INTE | RFACE | | |
| XI | 5 | I | Reference Clock Input (RMII): Reference clock 50-MHz CMOS-level oscillator in RMII Slave mode. Reference clock 25-MHz crystal or oscillator in RMII Master mode. Reference Clock Input (Other MAC Interfaces): Reference clock 25-MHz crystal or oscillator input. The device supports either an external crystal resonator connected across pins XI and XO, or an external CMOS-level oscillator connected to pin XI only and XO left floating. This pin can also accept clock input from other devices like Ethernet MAC or another Ethernet PHY in daisy-chain operations. |
| хо | 4 | 0 | Reference Clock Output: XO pin is used for crystal only. This pin must be left floating when a CMOS-level oscillator is connected to XI. |
| LED/GPIO IN | TERFACE | | |
| LED_0 / GPIO_0 | 35 | S, PD, IO | LED_0: Link Status LED. This pin can also be used as LED or clock output via Register selection. |
| LED_1 / GPIO_1 | 6 | S, PD, IO | LED_1: Link Status and BLINK for TX/RX Activity. This pin can also be used as LED or clock output via Strap/ Register selection. |
| CLKOUT / GPIO_2 | 16 | Ю | Clock Output: 25-MHz reference clock. This pin can also be used as LED or GPIO via Strap/Register selection. |
| MEDIUM DEF | PENDENT | INTERFACE | |
| TRD_M | 13 | IO | Differential Transmit and Receive: Bidirectional differential signaling configured for 100BASE-T1 operation, IEEE |
| TRD_P | 12 | 10 | 802.3bw compliant. |
| GROUND ES | CAPE | | |
| GND_ESC | 17 | | Ground Escape: Optional ground escape pins. These pins can be connected to ground to optimize PCB layout. These pins are not substitute for power ground connection to DAP. DAP must always be connected to power ground. This pin can be left unconnected if not used. |
| GND_ESC | 18 | | Ground Escape: Optional ground escape pins. These pins can be connected to ground to optimize PCB layout. These pins are not substitute for power ground connection to DAP. DAP must always be connected to power ground. This pin can be left unconnected if not used. |
| POWER CON | INECTION | S | |
| VDDA | 11 | SUPPLY | Core Supply: 3.3 V Recommend using 0.47-μF and 0.01-μF ceramic decoupling capacitors; optional ferrite bead can be used. |
| VDDIO | 34 | SUPPLY | IO Supply: 1.8 V, 2.5 V, or 3.3 V Recommend using ferrite bead, 0.47-μF and 0.01-μF ceramic decoupling capacitors. |



Table 6-1. Pin Functions (continued)

| PIN | | STATE ¹ | DESCRIPTION | | | | |
|-------------------|------|--------------------|---|--|--|--|--|
| NAME ² | | | BEGGRI HON | | | | |
| VDDMAC 22 SUPPLY | | SUPPLY | Optional MAC Interface Supply: 1.8 V, 2.5 V, or 3.3 V Optional separate supply for MAC interface pins. This pin supplies power to the MAC interface pins and can be kept at a different voltage level as compared to other IO pins. Recommend using 0.47-μF, and 0.01-μF ceramic decoupling capacitors and ferrite bead. When separate VDDMAC is not required in the system then it must be connected to VDDIO. When connecting to VDDIO, 0.47-μF on the VDDIO can be removed. 0.47-μF must still be connected close to VDDMAC. In this case, one common ferrite bead can be used between VDDIO and VDDMAC. | | | | |
| VDDA | 7 | SUPPLY | VDDA Supply: 3.3 V Recommend using 0.1-µF ceramic decoupling capacitors. | | | | |
| GROUND | DAP | GROUND | Ground: This must always be connected to power ground. | | | | |
| DO NOT CON | NECT | | | | | | |
| DNC | 8 | | DNC: Do not connect (leave floating) | | | | |
| DNC | 10 | | DNC: Do not connect (leave floating) | | | | |
| DNC | 19 | | DNC: Do not connect (leave floating) | | | | |
| DNC | 20 | | DNC: Do not connect (leave floating) | | | | |
| NO CONNEC | T | | | | | | |
| NC | 9 | | NC: No connection. Can be left floating. Connecting to any signal will have no effect on PHY performance. | | | | |
| NC | 21 | | NC: No connection. Can be left floating. Connecting to any signal will have no effect on PHY performance. | | | | |

- 1. Pin Type:
 - I = Input
 - O = Output
 - IO = Input/Output
 - OD = Open Drain
 - PD = Internal pulldown
 - PU = Internal pullup
 - S = Bootstrap configuration pin (all configuration pins have weak internal pullups or pulldowns)
- 2. When pins are unused, follow the recommended connection requirements provided in the table above. If pins do not have required termination, they may be left floating.



| Table 6-2. Pin Domain | | | | | |
|-----------------------|----------------------|----------------|--|--|--|
| PIN NO | PIN NAME | VOLTAGE DOMAIN | | | |
| 1 | MDC | VDDIO | | | |
| 2 | INT_N | VDDIO | | | |
| 3 | RESET_N | VDDIO | | | |
| 4 | XO | VDDIO | | | |
| 5 | XI | VDDIO | | | |
| 6 | LED_1/GPIO_1 | VDDIO | | | |
| 12 | TRD_P | VDDA | | | |
| 13 | TRD_M | VDDA | | | |
| 14 | RX_ER | VDDMAC | | | |
| 15 | RX_DV/CRS_DV/RX_CTRL | VDDMAC | | | |
| 16 | CLKOUT/GPIO_2 | VDDMAC | | | |
| 23 | RX_D3/RX_M | VDDMAC | | | |
| 24 | RX_D2/RX_P | VDDMAC | | | |
| 25 | RX_D1 | VDDMAC | | | |
| 26 | RX_D0 | VDDMAC | | | |
| 27 | RX_CLK | VDDMAC | | | |
| 28 | TX_CLK | VDDMAC | | | |
| 29 | TX_EN/TX_CTRL | VDDMAC | | | |
| 30 | TX_D3 | VDDMAC | | | |
| 31 | TX_D2 | VDDMAC | | | |
| 32 | TX_D1/TX_P | VDDMAC | | | |
| 33 | TX_D0/TX_M | VDDMAC | | | |
| 35 | LED_0/GPIO_0 | VDDIO | | | |
| 36 | MDIO | VDDIO | | | |

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Table 6-3. Pin States - POWER-UP / RESET

| | 100 | POWER-UP / RESET | | | |
|--------|-------------|--------------------------|-----------|--------------------|--|
| PIN NO | PIN NAME | PIN STATE ⁽¹⁾ | PULL TYPE | PULL VALUE (kΩ) | |
| 1 | MDC | I | none | none | |
| 2 | INT | I | PU | 9 | |
| 3 | RESET | I | PU | 9 | |
| 4 | XO | 0 | none | none | |
| 5 | XI | I | none | none | |
| 6 | LED_1 | I | PD | 9 | |
| 7 | VDDA | SUPPLY | none | none | |
| 8 | DNC | I/O | PD | 455 | |
| 9 | NC | FLOAT | none | none | |
| 10 | DNC | OD, O | none | none | |
| 11 | VDDA | SUPPLY | none | none | |
| 12 | TRD_P | IO | none | none | |
| 13 | TRD_M | IO | none | none | |
| 14 | RX_ER | | PD | 6 | |
| 15 | RX_DV | | PD | 6 | |
| 16 | CLKOUT | 0 | none | none | |
| 17 | GND_ESC | FLOAT | none | none | |
| 18 | GND_ESC | I | PD | 50 | |
| 19 | DNC | FLOAT | none | none | |
| 20 | DNC | FLOAT | none | none | |
| 21 | NC | FLOAT | none | none | |
| 22 | VDDMAC | SUPPLY | none | none | |
| 23 | RX_D3 | I | PD | 9 | |
| 24 | RX_D2 | I | PD | 9 | |
| 25 | RX_D1 | I | PD | 9 | |
| 26 | RX_D0 | I | PD | 9 | |
| 27 | RX_CLK | I | PD | 9 | |
| 28 | TX_CLK | I | none | none | |
| 29 | TX_EN | I | none | none | |
| 30 | TX_D3 | I | none | none | |
| 31 | TX_D2 | I | none | none | |
| 32 | TX_D1 | I | none | none | |
| 33 | TX_D0 | I | none | none | |
| 34 | VDDIO | SUPPLY | none | none | |
| 35 | LED_0 | I | PD | 9 | |
| 36 | MDIO | OD, IO | none | none | |



| Table 6-4. Pin States - MAC ISOLATE and IEEE PWDN | | | | | | | | |
|---|---------|---------------|-----------|--------------------|--------------------------|-----------|--------------------|--|
| | PIN | MAC ISOLATE | | | | IEEE PWDN | | |
| PIN NO | NAME | PIN STATE (1) | PULL TYPE | PULL VALUE (kΩ) | PIN STATE ⁽¹⁾ | PULL TYPE | PULL VALUE (kΩ) | |
| 1 | MDC | I | none | none | I | none | none | |
| 2 | INT | OD, O | PU | 9 | OD, O | PU | 9 | |
| 3 | RESET | I | PU | 9 | I | PU | 9 | |
| 4 | XO | 0 | none | none | 0 | none | none | |
| 5 | XI | I | none | none | I | none | none | |
| 6 | LED_1 | 0 | none | none | 0 | none | none | |
| 7 | VDDA | SUPPLY | none | none | SUPPLY | none | none | |
| 8 | DNC | IO | PD | 455 | IO | PD | 455 | |
| 9 | NC | FLOAT | none | none | FLOAT | none | none | |
| 10 | DNC | OD, O | none | none | OD, O | none | none | |
| 11 | VDDA | SUPPLY | none | none | SUPPLY | none | none | |
| 12 | TRD_P | IO | none | none | IO | none | none | |
| 13 | TRD_M | IO | none | none | IO | none | none | |
| 14 | RX_ER | I | PD | 6 | I | PD | 6 | |
| 15 | RX_DV | I | PD | 6 | 0 | none | none | |
| 16 | CLKOUT | 0 | none | none | 0 | none | none | |
| 17 | GND_ESC | FLOAT | none | none | FLOAT | none | none | |
| 18 | GND_ESC | FLOAT | none | none | FLOAT | none | none | |
| 19 | DNC | FLOAT | none | none | FLOAT | none | none | |
| 20 | DNC | FLOAT | none | none | FLOAT | none | none | |
| 21 | DNC | FLOAT | none | none | FLOAT | none | none | |
| 22 | VDDMAC | SUPPLY | none | none | SUPPLY | none | none | |
| 23 | RX_D3 | I | PD | 9 | 0 | none | none | |
| 24 | RX_D2 | I | PD | 9 | 0 | none | none | |
| 25 | RX_D1 | I | PD | 9 | 0 | none | none | |
| 26 | RX_D0 | I | PD | 9 | 0 | none | none | |
| 27 | RX_CLK | I | PD | 9 | 0 | none | none | |
| 28 | TX_CLK | I | PD | 9 | I | none | none | |
| 29 | TX_EN | 1 | PD | 9 | I | none | none | |
| 30 | TX_D3 | I | PD | 9 | 1 | none | none | |
| 31 | TX_D2 | I | PD | 9 | | none | none | |
| 32 | TX_D1 | I | PD | 9 | I | none | none | |
| 33 | TX_D0 | I | PD | 9 | I | none | none | |
| 34 | VDDIO | SUPPLY | none | none | SUPPLY | none | none | |
| 35 | LED_0 | 0 | none | none | 0 | none | none | |
| 36 | MDIO | OD, IO | none | none | OD, IO | none | none | |

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Table 6-5. Pin States - MII and RGMII

| | | | | | | | RGMII | | |
|--------|---------|--------------------------|-----------|------------|--------------------------|------------|-------|--|--|
| PIN NO | PIN | | | PULL VALUE | | PULL VALUE | | | |
| | NAME | PIN STATE ⁽¹⁾ | PULL TYPE | (kΩ) | PIN STATE ⁽¹⁾ | PULL TYPE | (kΩ) | | |
| 1 | MDC | I | none | none | I | none | none | | |
| 2 | ĪNT | OD, O | PU | 9 | OD, O | PU | 9 | | |
| 3 | RESET | I | PU | 9 | I | PU | 9 | | |
| 4 | ХО | 0 | none | none | 0 | none | none | | |
| 5 | XI | I | none | none | I | none | none | | |
| 6 | LED_1 | 0 | none | none | 0 | none | none | | |
| 7 | VDDA | SUPPLY | none | none | SUPPLY | none | none | | |
| 8 | DNC | IO | PD | 455 | IO | PD | 455 | | |
| 9 | NC | FLOAT | none | none | FLOAT | none | none | | |
| 10 | DNC | OD, O | none | none | OD, O | none | none | | |
| 11 | VDDA | SUPPLY | none | none | SUPPLY | none | none | | |
| 12 | TRD_P | IO | none | none | IO | none | none | | |
| 13 | TRD_M | IO | none | none | IO | none | none | | |
| 14 | RX_ER | 0 | none | none | I | PD | 6 | | |
| 15 | RX_DV | 0 | none | none | 0 | none | none | | |
| 16 | CLKOUT | 0 | none | none | 0 | none | none | | |
| 17 | GND_ESC | FLOAT | none | none | FLOAT | none | none | | |
| 18 | GND_ESC | FLOAT | none | none | FLOAT | none | none | | |
| 19 | DNC | FLOAT | none | none | FLOAT | none | none | | |
| 20 | DNC | FLOAT | none | none | FLOAT | none | none | | |
| 21 | DNC | FLOAT | none | none | FLOAT | none | none | | |
| 22 | VDDMAC | SUPPLY | none | none | SUPPLY | none | none | | |
| 23 | RX_D3 | 0 | none | none | 0 | none | none | | |
| 24 | RX_D2 | 0 | none | none | 0 | none | none | | |
| 25 | RX_D1 | 0 | none | none | 0 | none | none | | |
| 26 | RX_D0 | 0 | none | none | 0 | none | none | | |
| 27 | RX_CLK | 0 | none | none | 0 | none | none | | |
| 28 | TX_CLK | 0 | none | none | I | none | none | | |
| 29 | TX_EN | I | none | none | I | none | none | | |
| 30 | TX_D3 | I | none | none | I | none | none | | |
| 31 | TX_D2 | I | none | none | I | none | none | | |
| 32 | TX_D1 | I | none | none | I | none | none | | |
| 33 | TX_D0 | I | none | none | I | none | none | | |
| 34 | VDDIO | SUPPLY | none | none | SUPPLY | none | none | | |
| 35 | LED_0 | 0 | none | none | 0 | none | none | | |
| 36 | MDIO | OD, IO | none | none | OD, IO | none | none | | |



| Table 6-6. Pin States - RMII MASTER and RMII SLAVE | | | | | | | | | |
|--|---------|--------------------------|-------------|--------------------|--------------------------|------------|--------------------|--|--|
| | PIN | | RMII MASTER | | | RMII SLAVE | | | |
| PIN NO | NAME | PIN STATE ⁽¹⁾ | PULL TYPE | PULL VALUE (kΩ) | PIN STATE ⁽¹⁾ | PULL TYPE | PULL VALUE (kΩ) | | |
| 1 | MDC | I | none | none | I | none | none | | |
| 2 | INT | OD, O | PU | 9 | OD, O | PU | 9 | | |
| 3 | RESET | I | PU | 9 | I | PU | 9 | | |
| 4 | XO | 0 | none | none | 0 | none | none | | |
| 5 | XI | I | none | none | I | none | none | | |
| 6 | LED_1 | 0 | none | none | 0 | none | none | | |
| 7 | VDDA | SUPPLY | none | none | SUPPLY | none | none | | |
| 8 | DNC | IO | PD | 455 | IO | PD | 455 | | |
| 9 | NC | FLOAT | none | none | FLOAT | none | none | | |
| 10 | DNC | OD, O | none | none | OD, O | none | none | | |
| 11 | VDDA | SUPPLY | none | none | SUPPLY | none | none | | |
| 12 | TRD_P | IO | none | none | IO | none | none | | |
| 13 | TRD_M | IO | none | none | IO | none | none | | |
| 14 | RX_ER | 0 | none | none | 0 | none | none | | |
| 15 | RX_DV | 0 | none | none | 0 | none | none | | |
| 16 | CLKOUT | 0 | none | none | 0 | none | none | | |
| 17 | GND_ESC | FLOAT | none | none | FLOAT | none | none | | |
| 18 | GND_ESC | FLOAT | none | none | FLOAT | none | none | | |
| 19 | DNC | FLOAT | none | none | FLOAT | none | none | | |
| 20 | DNC | FLOAT | none | none | FLOAT | none | none | | |
| 21 | DNC | FLOAT | none | none | FLOAT | none | none | | |
| 22 | VDDMAC | SUPPLY | none | none | SUPPLY | none | none | | |
| 23 | RX_D3 | O, 50MHz | none | none | I | PD | 9 | | |
| 24 | RX_D2 | I | PD | 9 | I | PD | 9 | | |
| 25 | RX_D1 | 0 | none | none | 0 | none | none | | |
| 26 | RX_D0 | 0 | none | none | 0 | none | none | | |
| 27 | RX_CLK | I | PD | 9 | I | PD | 9 | | |
| 28 | TX_CLK | I | none | none | I | none | none | | |
| 29 | TX_EN | I | none | none | I | none | none | | |
| 30 | TX_D3 | I | none | none | I | none | none | | |
| 31 | TX_D2 | I | none | none | I | none | none | | |
| 32 | TX_D1 | I | none | none | I | none | none | | |
| 33 | TX_D0 | I | none | none | I | none | none | | |
| 34 | VDDIO | SUPPLY | none | none | SUPPLY | none | none | | |
| 35 | LED_0 | 0 | none | none | 0 | none | none | | |
| 36 | MDIO | OD, IO | none | none | OD, IO | none | none | | |

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Table 6-7. Pin States - SGMII

| | PIN | | SGMII | |
|--------|---------|--------------------------|-----------|--------------------|
| PIN NO | NAME | PIN STATE ⁽¹⁾ | PULL TYPE | PULL VALUE (kΩ) |
| 1 | MDC | I | none | none |
| 2 | INT | OD, O | PU | 9 |
| 3 | RESET | I | PU | 9 |
| 4 | XO | 0 | none | none |
| 5 | XI | I | none | none |
| 6 | LED_1 | 0 | none | none |
| 7 | VDDA | SUPPLY | none | none |
| 8 | DNC | IO | PD | 455 |
| 9 | NC | FLOAT | none | none |
| 10 | DNC | OD, O | none | none |
| 11 | VDDA | SUPPLY | none | none |
| 12 | TRD_P | IO | none | none |
| 13 | TRD_M | IO | none | none |
| 14 | RX_ER | I | PD | 6 |
| 15 | RX_DV | I | PD | 6 |
| 16 | CLKOUT | 0 | none | none |
| 17 | GND_ESC | FLOAT | none | none |
| 18 | GND_ESC | FLOAT | none | none |
| 19 | DNC | FLOAT | none | none |
| 20 | DNC | FLOAT | none | none |
| 21 | DNC | FLOAT | none | none |
| 22 | VDDMAC | SUPPLY | none | none |
| 23 | RX_D3 | 0 | none | none |
| 24 | RX_D2 | 0 | none | none |
| 25 | RX_D1 | I | PD | 9 |
| 26 | RX_D0 | I | PD | 9 |
| 27 | RX_CLK | I | PD | 9 |
| 28 | TX_CLK | I | none | none |
| 29 | TX_EN | I | none | none |
| 30 | TX_D3 | 1 | none | none |
| 31 | TX_D2 | I | none | none |
| 32 | TX_D1 | I | none | none |
| 33 | TX_D0 | I | none | none |
| 34 | VDDIO | SUPPLY | none | none |
| 35 | LED_0 | 0 | none | none |
| 36 | MDIO | OD, IO | none | none |

(1) Type: I = Input O = Output IO = Input/Output

OD = Open Drain

PD = Internal pulldown PU = Internal pullup

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7 Specifications

7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

| | | MIN | TYP MAX | UNIT |
|----------------------|---|------|-----------------|------|
| Input Voltage | VDDA | -0.3 | 4 | V |
| Input Voltage | VDDIO/VDDMAC (3.3V) | -0.3 | 4 | V |
| Input Voltage | VDDIO/VDDMAC (2.5V) | -0.3 | 4 | V |
| Input Voltage | VDDIO/VDDMAC (1.8V) | -0.3 | 4 | V |
| Pins | MDI | -0.3 | 4 | V |
| Pins | MAC interface | -0.3 | VDDMAC + 0.3 | V |
| Pins | MDIO, MDC, GPIO, XI, XO, INT, RESET, CLKOUT | -0.3 | VDDIO + 0.3 | V |
| DC Output Voltage | All Pins | -0.3 | 4 | V |
| TJ | Junction Temperature | | 150 | °C |
| T _{stg} | Storage temperature | -65 | 150 | °C |

(1) Stresses beyond those listed under Absolute Maximum Rating may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Condition. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

7.2 ESD Ratings

| | | | | VALUE | UNIT |
|--------------------|-------------------------|---------------------------------|-------------------|-------|------|
| | | Human body model (HBM), per | All pins | ±2000 | |
| | | AEC Q100-002 ⁽¹⁾ | TRD_N, TRD_P pins | ±8000 | |
| V _(ESD) | Electrostatic discharge | Charged device model (CDM), per | Corner pins | ±750 | V |
| | | AEC Q100-011 | Other pins | ±750 | |
| | | IEC 61000-4-2 contact discharge | TRD_N, TRD_P pins | ±8000 | |

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

7.3 Recommended Operating Conditions

| | | MIN | NOM | MAX | UNIT |
|-------------------|-----------------------------------|------|-----|------|------|
| | IO Supply Voltage, 1.8V operation | 1.62 | 1.8 | 1.98 | |
| VDDIO / VDDMAC | IO Supply Voltage, 2.5V operation | 2.25 | 2.5 | 2.75 | V |
| | IO Supply Voltage, 3.3V operation | 2.97 | 3.3 | 3.63 | |
| VDDA | Core Supply Voltage, 3.3V | 2.97 | 3.3 | 3.63 | V |
| T _A | Ambient temperature | -40 | | 125 | °C |



7.4 Thermal Information

| | | DP83TC814 | |
|-----------------------|--|------------|------|
| | THERMAL METRIC ⁽¹⁾ | RHA (VQFN) | UNIT |
| | | 36 PINS | |
| R _{θJA} | Junction-to-ambient thermal resistance | 36.7 | °C/W |
| R _{0JC(top)} | Junction-to-case (top) thermal resistance | 27.0 | °C/W |
| R _{θJB} | Junction-to-board thermal resistance | 17.5 | °C/W |
| Ψ_{JT} | Junction-to-top characterization parameter | 0.7 | °C/W |
| Ψ_{JB} | Junction-to-board characterization parameter | 17.5 | °C/W |
| R _{0JC(bot)} | Junction-to-case (bottom) thermal resistance | 6.7 | °C/W |

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

7.5 Electrical Characteristics

| | PARAMETER | TEST CONDITIONS | MIN | TYP MAX | UNIT |
|-----------------------|---|----------------------------------|-----------------|-----------------|------|
| 100BASE | -T1 PMA CONFORMANC | E | | | |
| V _{OD-MDI} | Output Differential Voltage | $R_{L(diff)} = 100\Omega$ | | 2.2 | V |
| ₹ _{MDI-Diff} | Integrated Differential Output Termination | TRD_P and TRD_M | | 100 | Ω |
| BOOTSTR | RAP DC CHARACTERIST | ICS (2 Level) | · | | |
| MODE1 | Mode 1 Strap Voltage Range | VDDIO = 3.3V ±10%, 2-level strap | 0 | 0.8 | V |
| MODE2 | Mode 2 Strap Voltage Range | VDDIO = 3.3V ±10%, 2-level strap | 2 | VDDIO | V |
| MODE1 | Mode 1 Strap Voltage Range | VDDIO = 2.5V ±10%, 2-level strap | 0 | 0.7 | V |
| MODE2 | Mode 2 Strap Voltage Range | VDDIO = 2.5V ±10%, 2-level strap | 1.5 | VDDIO | V |
| MODE1 | Mode 1 Strap Voltage Range | VDDIO = 1.8V ±10%, 2-level strap | 0 | 0.35 x VDDIO | V |
| MODE2 | Mode 2 Strap Voltage Range | VDDIO = 1.8V ±10%, 2-level strap | 0.65 x VDDIO | VDDIO | V |
| воотетн | RAP DC CHARACTERIST | ICS (3 Level) | | | |
| MODE1 | Mode 1 Strap Voltage Range | VDDIO = 3.3V ±10%, 3-level strap | 0 | 0.18 x VDDIO | V |
| MODE2 | Mode 2 Strap Voltage Range | VDDIO = 3.3V ±10%, 3-level strap | 0.22 x VDDIO | 0.42 x VDDIO | V |
| / _{MODE3} | Mode 3 Strap Voltage Range | VDDIO = 3.3V ±10%, 3-level strap | 0.46 x VDDIO | VDDIO | V |
| / _{MODE1} | Mode 1 Strap Voltage Range | VDDIO = 2.5V ±10%, 3-level strap | 0 | 0.19 x VDDIO | V |
| / _{MODE2} | Mode 2 Strap Voltage Range | VDDIO = 2.5V ±10%, 3-level strap | 0.27 x VDDIO | 0.41 x VDDIO | V |
| / _{MODE3} | Mode 3 Strap Voltage Range | VDDIO = 2.5V ±10%, 3-level strap | 0.58 x VDDIO | VDDIO | V |
| MODE1 | Mode 1 Strap Voltage Range | VDDIO = 1.8V ±10%, 3-level strap | 0 | 0.35 x VDDIO | V |
| MODE2 | Mode 2 Strap Voltage Range | VDDIO = 1.8V ±10%, 3-level strap | 0.40 x VDDIO | 0.75 x VDDIO | V |



| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---------------------|---|--|-----------------|-----|-------------|------|
| MODE3 | Mode 3 Strap Voltage Range | VDDIO = 1.8V ±10%, 3-level strap | 0.84 x VDDIO | | VDDIO | V |
| O CHARA | ACTERISTICS | | | | | |
| √ _{IH} | High Level Input Voltage | VDDIO = 3.3V ±10% | 2 | | | V |
| V _{IL} | Low Level Input Voltage | VDDIO = 3.3V ±10% | | | 0.8 | V |
| / _{он} | High Level Output Voltage | I _{OH} = -2mA, VDDIO = 3.3V ±10% | 2.4 | | | V |
| √ _{OL} | Low Level Output Voltage | I _{OL} = 2mA, VDDIO = 3.3V ±10% | | | 0.4 | V |
| √ _{IH} | High Level Input Voltage | VDDIO = 2.5V ±10% | 1.7 | | | V |
| V _{IL} | Low Level Input Voltage | VDDIO = 2.5V ±10% | | | 0.7 | V |
| V _{OH} | High Level Output Voltage | I _{OH} = -2mA, VDDIO = 2.5V ±10% | 2 | | | V |
| V _{OL} | Low Level Output Voltage | I _{OL} = 2mA, VDDIO = 2.5V ±10% | | | 0.4 | V |
| V _{IH} | High Level Input Voltage | VDDIO = 1.8V ±10% | 0.65*VDDI O | | | V |
| V _{IL} | Low Level Input Voltage | VDDIO = 1.8V ±10% | | 0.3 | 5*VDDI O | V |
| V _{OH} | High Level Output Voltage | I _{OH} = -2mA, VDDIO = 1.8V ±10% | VDDIO-0.4 5 | | | V |
| V _{OL} | Low Level Output Voltage | I _{OL} = 2mA, VDDIO = 1.8V ±10% | | | 0.45 | V |
| I _{IH} | Input High Current ⁽¹⁾ | T_A = -40°C to 125°C, VIN=VDDIO, All pins except XI | -10 | | 10 | μA |
| I _{IH-XI} | Input High Current ⁽¹⁾ | T _A = -40°C to 125°C, VIN=VDDIO, XI pin | -15 | | 15 | μA |
| IL-XI | Input Low Current ⁽¹⁾ | T _A = -40°C to 125°C, VIN=GND, XI pin | -15 | | 15 | μA |
| IL | Input Low Current ⁽¹⁾ | $T_A = -40^{\circ}$ C to 125°C, VIN=GND, All pins except XI pin | -10 | | 10 | μA |
| lozh | Tri-state Output High Current ⁽²⁾ | T _A = -40°C to 125°C, VIN=VDDIO, All pins except RX_CTRL and RX_ER | -10 | | 10 | μA |
| lozh | Tri-state Output High Current ⁽²⁾ | $T_A = -40^{\circ}C$ to 125°C, VIN=VDDIO, RX_CTRL and RX_ER | -52 | | 52 | μA |
| lozl | Tri-state Output Low Current ⁽²⁾ | $T_A = -40^{\circ}C$ to 125°C, VOUT=GND | -10 | | 10 | μA |
| R _{pulldn} | Internal Pull Down Resistor | RX_D[3:0], RX_CLK, LED_0, LED_1 | 6.2 | 8.4 | 10.7 | kΩ |
| R _{pulldn} | Internal Pull Down Resistor | RX_CTRL, RX_ER | 4.725 | 5.8 | 7.2 | kΩ |
| R _{pullup} | Internal Pull Up Resistor | INT, RESET | 6.3 | 9 | 11.2 | kΩ |
| XI V _{IH} | High Level Input Voltage | | 1.3 | | VDDIO | V |
| XI V _{IL} | Low Level Input Voltage | | | | 0.5 | V |
| C _{IN} | Input Capacitance XI | | | 1 | | pF |
| C _{IN} | Input Capacitance INPUT PINS | | | 5 | | pF |
| C _{OUT} | Output Capacitance XO | | | 1 | | pF |
| C _{OUT} | Output Capacitance OUTPUT PINS | | | 5 | | pF |



| • | PARAMETER | TEST CONDITIONS | MIN | ТҮР | MAX | UNIT |
|---------------------|---|--|-----|-----|-----|------|
| R _{series} | Integrated MAC Series Termination Resistor | RX_D[3:0], RX_ER, RX_DV, RX_CLK | 35 | 50 | 65 | Ω |
| POWER CO | ONSUMPTION | | | | | |
| I(3V3) | MII | -40°C to 125°C | | 57 | 63 | mA |
| I(3V3) | RMII | -40°C to 125°C | | 57 | 63 | mA |
| I(3V3) | RGMII | -40°C to 125°C | | 57 | 63 | mA |
| l(3V3) | SGMII | -40°C to 125°C | | 81 | 95 | mA |
| I(VDDIO=3 .3V) | МІІ | -40°C to 125°C, VDDIO = VDDMAC | | 19 | 24 | mA |
| I(VDDIO=3 .3V) | RMII | -40°C to 125°C, VDDIO = VDDMAC | | 18 | 23 | mA |
| I(VDDIO=3 .3V) | RGMII | -40°C to 125°C, VDDIO = VDDMAC | | 13 | 21 | mA |
| I(VDDIO=3 .3V) | SGMII | -40°C to 125°C, VDDIO = VDDMAC | | 7 | 12 | mA |
| I(VDDIO=2 .5V) | МІІ | -40°C to 125°C, VDDIO = VDDMAC | | 12 | 18 | mA |
| I(VDDIO=2 .5V) | RMII | -40°C to 125°C, VDDIO = VDDMAC | | 12 | 17 | mA |
| I(VDDIO=2 .5V) | RGMII | -40°C to 125°C, VDDIO = VDDMAC | | 12 | 16 | mA |
| I(VDDIO=2 .5V) | SGMII | -40°C to 125°C, VDDIO = VDDMAC | | 6 | 9 | mA |
| I(VDDIO=1 .8V) | МІІ | -40°C to 125°C, VDDIO = VDDMAC | | 9 | 13 | mA |
| I(VDDIO=1 .8V) | RMII | -40°C to 125°C, VDDIO = VDDMAC | | 9 | 13 | mA |
| I(VDDIO=1 .8V) | RGMII | -40°C to 125°C, VDDIO = VDDMAC | | 9 | 12 | mA |
| I(VDDIO=1 .8V) | SGMII | -40°C to 125°C, VDDIO = VDDMAC | | 4 | 6 | mA |
| POWER CO | ONSUMPTION (LOW PO) | WER MODE) | | | | |
| I(VDDA3V 3) | IEEE Power Down | -40°C to 125°C, All interfaces | | 8 | 22 | mA |
| I(VDDA3V 3) | RESET | -40°C to 125°C, All interfaces | | 9 | 23 | mA |
| I(VDDA3V 3) | Standby | -40°C to 125°C, MII | | 15 | 33 | mA |
| I(VDDA3V 3) | Standby | -40°C to 125°C, RMII | | 15 | 30 | mA |
| I(VDDA3V 3) | Standby | -40°C to 125°C, RGMII | | 15 | 30 | mA |
| I(VDDA3V 3) | Standby | -40°C to 125°C, SGMII | | 15 | 30 | mA |
| I(VDDIO=3 .3V) | IEEE Power Down | -40°C to 125°C, All interfaces, VDDIO=VDDMAC | | 15 | 23 | mA |
| I(VDDIO=3 .3V) | RESET | -40°C to 125°C, All interfaces, VDDIO=VDDMAC | | 15 | 23 | mA |
| I(VDDIO=3 .3V) | Standby | -40°C to 125°C, MII, VDDIO=VDDMAC | | 19 | 25 | mA |



| | PARAMETER | TEST CONDITIONS | MIN | ТҮР | MAX | UNIT |
|----------------------|--|--|------|-----|-----|------|
| I(VDDIO=3 .3V) | Standby | -40°C to 125°C, RMII, VDDIO=VDDMAC | | 16 | 20 | mA |
| I(VDDIO=3 .3V) | Standby | -40°C to 125°C, RGMII, VDDIO=VDDMAC | | 14 | 20 | mA |
| I(VDDIO=3 .3V) | Standby | -40°C to 125°C, SGMII, VDDIO=VDDMAC | | 14 | 16 | mA |
| I(VDDIO=2 .5V) | IEEE Power Down | -40°C to 125°C, All interfaces, VDDIO=VDDMAC | | 10 | 16 | mA |
| I(VDDIO=2 .5V) | RESET | -40°C to 125°C, All interfaces, VDDIO=VDDMAC | | 10 | 16 | mA |
| I(VDDIO=2 .5V) | Standby | -40°C to 125°C, MII, VDDIO=VDDMAC | | 14 | 18 | mA |
| I(VDDIO=2 .5V) | Standby | -40°C to 125°C, RMII, VDDIO=VDDMAC | | 11 | 14 | mA |
| I(VDDIO=2 .5V) | Standby | -40°C to 125°C, RGMII, VDDIO=VDDMAC | | 9 | 14 | mA |
| I(VDDIO=2 .5V) | Standby | -40°C to 125°C, SGMII, VDDIO=VDDMAC | | 9 | 14 | mA |
| I(VDDIO=1 .8V) | IEEE Power Down | -40°C to 125°C, All interfaces, VDDIO=VDDMAC | | 7 | 11 | mA |
| I(VDDIO=1 .8V) | RESET | -40°C to 125°C, All interfaces, VDDIO=VDDMAC | | 7 | 11 | mA |
| I(VDDIO=1 .8V) | Standby | -40°C to 125°C, MII, VDDIO=VDDMAC | | 10 | 12 | mA |
| I(VDDIO=1 .8V) | Standby | -40°C to 125°C, RMII, VDDIO=VDDMAC | | 7 | 11 | mA |
| I(VDDIO=1 .8V) | Standby | -40°C to 125°C, RGMII, VDDIO=VDDMAC | | 6 | 11 | mA |
| I(VDDIO=1 .8V) | Standby | -40°C to 125°C, SGMII, VDDIO=VDDMAC | | 6 | 11 | mA |
| SGMII Inpu | t | · · · · · · · · · · · · · · · · · · · | | | I | |
| V _{IDTH} | Input differential voltage tolerance | SI_P and SI_N, AC coupled | 0.1 | | | V |
| R _{IN-DIFF} | Receiver differential input impedance (DC) | | 80 | | 120 | ohm |
| SGMII Outp | ut | | | | | |
| | Clock signal duty cycle | SO_P and SO_N, AC coupled, 0101010101 pattern | 48 | | 52 | % |
| | Output Differential Voltage | SO_P and SO_N, AC coupled | 150 | | 400 | mV |
| Voltage Ser | nsor | | | | I | |
| | VDDA Sensor Range | -40°C to +125°C | 2.7 | 3.3 | 4 | V |
| | VDDA Sensor Resolution (LSB) | -40°C to +125°C | | 8.8 | | mV |
| VDDA | VDDA Sensor Accuracy (voltage and temperature variation on single part) | -40°C to +125°C | -120 | | 120 | mV |
| | VDDA Sensor Accuracy (part-part variation) | -40°C to +125°C | -50 | | 50 | mV |



over operating free-air temperature range (unless otherwise noted)

| | PARAMETER | TEST CONDITIONS | MIN | TYP MAX | UNIT |
|-------------------|---|-----------------|------|---------|------|
| | VDDIO / VDDMAC Sensor Range | -40°C to +125°C | 1.44 | 3.9 | V |
| | VDDIO / VDDMAC Sensor Resolution (LSB) | -40°C to +125°C | | 16 | mV |
| VDDIO / VDDMAC | VDDIO / VDDMAC Sensor Accuracy (voltage and temperature variation on single part) | -40°C to +125°C | -144 | 144 | mV |
| | VDDIO / VDDMAC Sensor Accuracy (part-part variation) | -40°C to +125°C | -85 | 85 | mV |



7.6 Timing Requirements

| | PARAMETER | TEST CONDITIONS | MIN | NOM | MAX | UNIT |
|-------------------------------|--|-------------------------|------|------|-----|------|
| | G | I | | | | |
| T1.1 | TX_CLK High / Low Time | | 16 | 20 | 24 | ns |
| T1.2 | TX_D[3:0], TX_ER, TX_EN Setup to TX_CLK | | 10 | | | ns |
| T1.3 | TX_D[3:0], TX_ER, TX_EN Hold from TX_CLK | | 0 | | | ns |
| T2.1 | RX_CLK High / Low Time | | 16 | 20 | 24 | ns |
| T2.2 | RX_D[3:0], RX_ER, RX_DV Delay from RX_CLK rising | | 10 | | 30 | ns |
| RMII MAS | TER TIMING | | | | | |
| T3.1 | RMII Master Clock Period | | | 20 | | ns |
| | RMII Master Clock Duty Cycle | | 35 | | 65 | % |
| T3.2 | TX_D[1:0], TX_ER, TX_EN Setup to RMII Master Clock | | 4 | | | ns |
| T3.3 | TX_D[1:0], TX_ER, TX_EN Hold from RMII Master Clock | | 2 | | | ns |
| T3.4 | RX_D[1:0], RX_ER, CRS_DV Delay from RMII Master Clock rising edge | | 4 | 10 | 14 | ns |
| RMII SLA | VE TIMING | | | | | |
| T3.1 | Input Reference Clock Period | | | 20 | | ns |
| | Reference Clock Duty Cycle | | 35 | | 65 | % |
| T3.2 | TX_D[1:0], TX_ER, TX_EN Setup to XI Clock rising | | 4 | | | ns |
| T3.3 | TX_D[1:0], TX_ER, TX_EN Hold from XI Clock rising | | 2 | | | ns |
| T3.4 | RX_D[1:0], RX_ER, CRS_DV Delay from XI Clock rising | | 4 | | 14 | ns |
| RGMII INI | PUT TIMING | | | | | |
| T _{cyc} | Clock Cycle Duration | TX_CLK | 36 | 40 | 44 | ns |
| T _{setup(alig} n) | TX_D[3:0], TX_CTRL Setup to TX_CLK (Align Mode) | | 1 | 2 | | ns |
| T _{hold(align)} | TX_D[3:0], TX_CTRL Hold from TX_CLK (Align Mode) | | 1 | 2 | | ns |
| | ITPUT TIMING | 1 1 | | | | |
| T _{skew(align}) | RX_D[3:0], RX_CTRL Delay from RX_CLK (Align Mode Enabled) | On PHY Pins | -750 | | 750 | ps |
| T _{setup(shift}) | RX_D[3:0], RX_CTRL Delay from RX_CLK (Shift Mode Enabled, default) | On PHY Pins | 2 | | | ns |
| T _{cyc} | Clock Cycle Duration | RX_CLK | 36 | 40 | 44 | ns |
| Duty_G | Duty Cycle | RX_CLK | 45 | 50 | 55 | % |
| Tr/Tf | Rise / Fall Time (20% to 80%) | C _{LOAD} = 5pF | | | 1.2 | ns |
| SMI ТІМІМ | IG | 1 | | | | |
| T4.1 | MDC to MDIO (Output) Delay Time | 25pF load capacitance | 0 | | 40 | ns |
| T4.2 | MDIO (Input) to MDC Setup Time | | 10 | | | ns |
| T4.3 | MDIO (Input) to MDC Hold Time | | 10 | | | ns |
| | MDC Frequency | | | 2.5 | 20 | MHz |
| POWER-U | JP TIMING | · · · · · · | | | | |
| T5.1 | Supply ramp time: For all supplies ⁽¹⁾ | | 0.2 | | 8 | ms |
| T5.2 | Supply ramp delay offset: For all supplies | | | | 10 | ms |
| T5.3 | XTAL Startup / Settling: Powerup to XI good/stabilized | | | 0.35 | | ms |
| T5.4 | Oscillator stabilization time from power up | | | | 10 | ms |
| | Last Supply power up To Reset Release | | | | 10 | ms |
| T5.5 | Post power-up to SMI ready: Post Power-up wait time required before MDC preamble can be sent for register access | | 10 | | | ms |



7.6 Timing Requirements (continued)

| | PARAMETER | TEST CONDITIONS | MIN | NOM | МАХ | UNIT |
|--------|---|--------------------|------|-----|------|------|
| T5.6 | Power-up to Strap latch-in | | | | 10 | ms |
| T5.7 | CLKOUT Startup/Settling: Powerup to CLKOUT good/stabilized | | | | 10 | ms |
| T5.8 | Power-up to idle stream | | | | 10 | ms |
| RESET | TIMING (RESET_N) | | | | 1 | |
| T6.1 | Reset Pulse Width: Miminum Reset pulse width to be able to reset | | 720 | | | ns |
| T6.2 | Reset to SMI ready: Post reset wait time required before MDC preamble can be sent for register access | | 1 | | | ms |
| T6.3 | Reset to Strap latch-in: Hardware configuration pins transition to output drivers | | | 40 | | μs |
| T6.4 | Reset to idle stream | | | | 1800 | μs |
| TRANS | MIT LATENCY TIMING | | 1 | | 1 | |
| | MII Rising edge TX_CLK with assertion TX_EN to SSD symbol on MD | | 205 | | 233 | ns |
| | Slave RMII Rising edge XI clock with assertion TX_EN to SSD symbol on MDI | | 374 | | 409 | ns |
| | Master RMII Rising edge clock with assertion TX_EN to SSD symbol on MDI | | 382 | | 408 | ns |
| | RGMII Rising edge TX_CLK with assertion TX_CTRL to SSD symbol on MDI | | 370 | | 390 | ns |
| | First symbol of SGMII to SSD symbol on MDI | | 420 | | 456 | ns |
| RECEI | VE LATENCY TIMING | | | | I | |
| | SSD symbol on MDI to MII Rising edge of RX_CLK with assertion of RX_DV | | 467 | | 491 | ns |
| | SSD symbol on MDI to Slave RMII Rising edge of XI clock with assertion of CRS_DV | | 527 | | 574 | ns |
| | SSD symbol on MDI to Master RMII Rising edge of Master clock with assertion of CRS_DV | | 521 | | 557 | ns |
| | SSD symbol on MDI to Rising edge of RGMII RX_CLK with assertion of RX_CTRL | | 484 | | 511 | ns |
| | SSD symbol on MDI to first symbol of SGMII | | 708 | | 788 | ns |
| 25 MHz | 2 OSCILLATOR REQUIREMENTS | | 4 | | | |
| | Frequency Tolerance | | -100 | | +100 | ppm |
| | Rise / Fall Time (10%-90%) | | | | 8 | ns |
| | Jitter Tolerance (RMS) | | | | 25 | ps |
| | XI Duty Cycle in external clock mode | | 40 | | 60 | % |
| 50 MHz | SCILLATOR REQUIREMENTS | | | | I | |
| | Frequency | | | 50 | | MHz |
| | Frequency Tolerance and Stability Over temperature and aging | | -100 | | 100 | ppm |
| | Rise / Fall Time (10% - 90%) | | | | 4 | ns |
| | Duty Cycle | | 35 | | 65 | % |
| 25 MHz | 2 CRYSTAL REQUIREMENTS | | 1 | | | |
| | Frequency | | | 25 | | MHz |
| | Frequency Tolerance and Stability Over temperature and aging | | -100 | | 100 | ppm |
| | Equivalent Series Resistance | | | | 100 | Ω |
| OUTPU | JT CLOCK TIMING (25 MHz) | | 1 | | | |
| | Frequency (PPM) | | -100 | | 100 | - |
| | Duty Cycle | | | | | |

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7.6 Timing Requirements (continued)

| PARAMETER | | TEST CONDITIONS | MIN | NOM | MAX | UNIT |
|-----------|---------------------|--------------------|-----|-----|------|------|
| | Rise Time | | | | 5000 | ps |
| | Fall Time | | | | 5000 | ps |
| | Jitter (Short Term) | | | | 1000 | ps |
| | Frequency | | | 25 | | MHz |

(1) For supplies with ramp rate longer than 8ms, a RESET pulse will be required after the last supply becomes stable.



7.7 Timing Diagrams

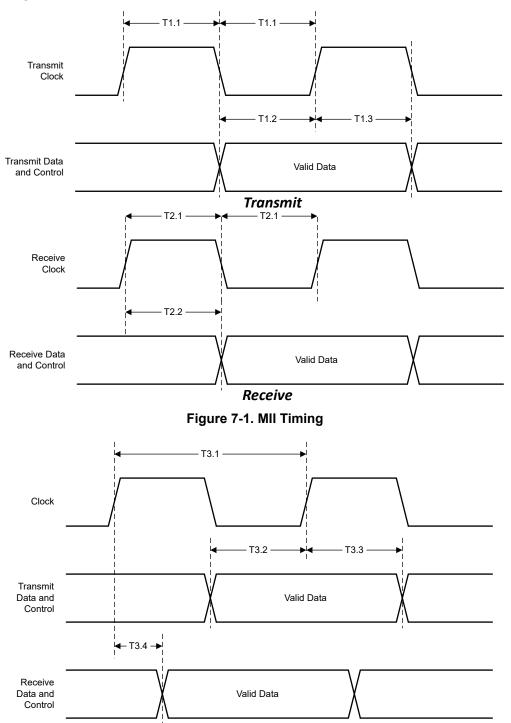


Figure 7-2. RMII Transmit and Receive Timing



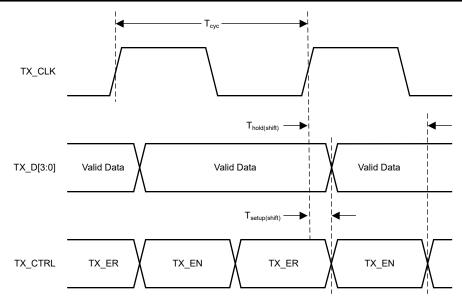


Figure 7-3. RGMII Transmit Timing (Internal Delay Enabled)

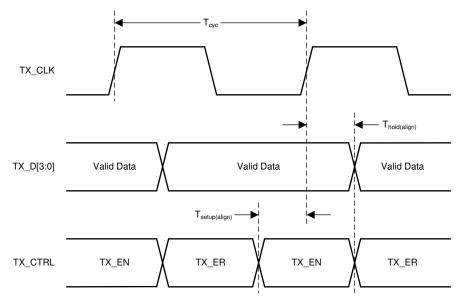


Figure 7-4. RGMII Transmit Timing (Internal Delay Disabled)



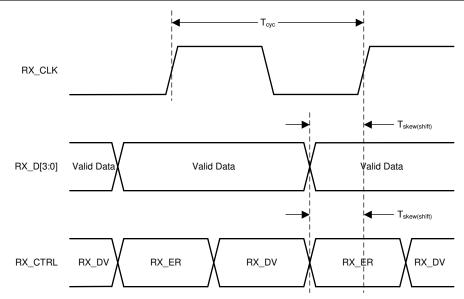


Figure 7-5. RGMII Receive Timing (Internal Delay Enabled)

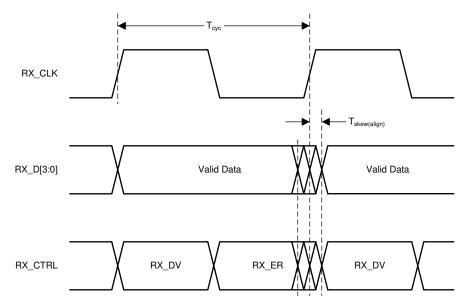


Figure 7-6. RGMII Receive Timing (Internal Delay Disabled)



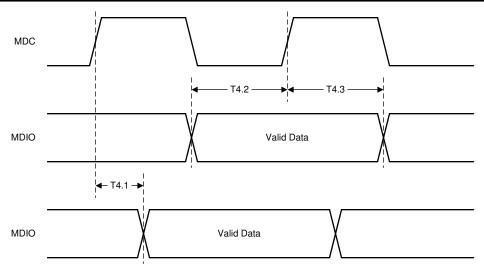


Figure 7-7. Serial Management Timing



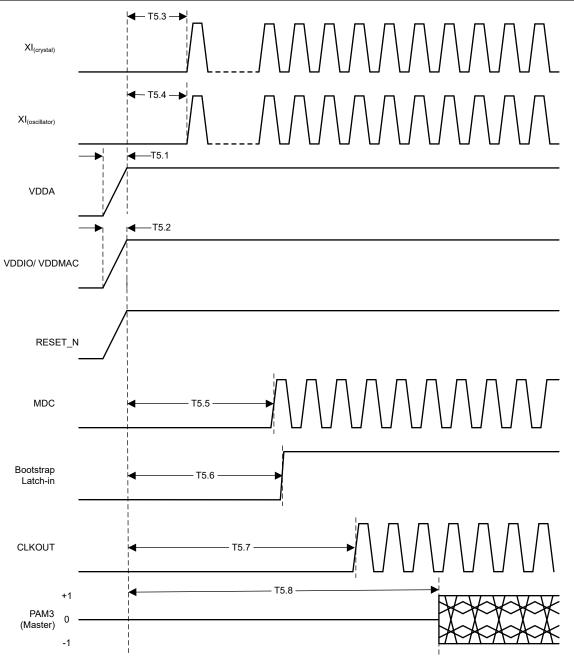


Figure 7-8. Power-Up Timing



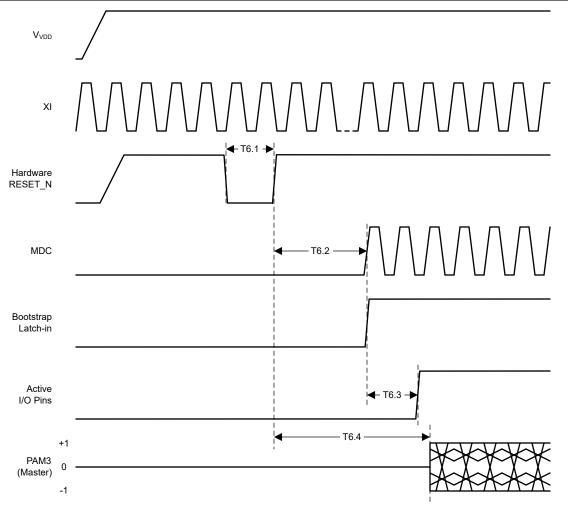
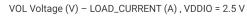
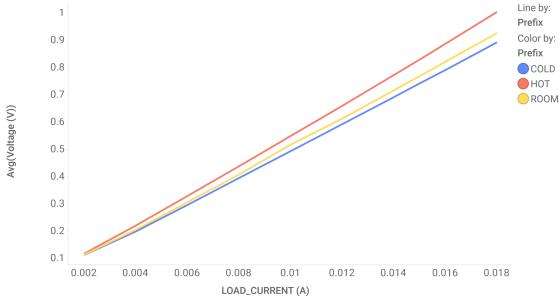


Figure 7-9. Reset Timing

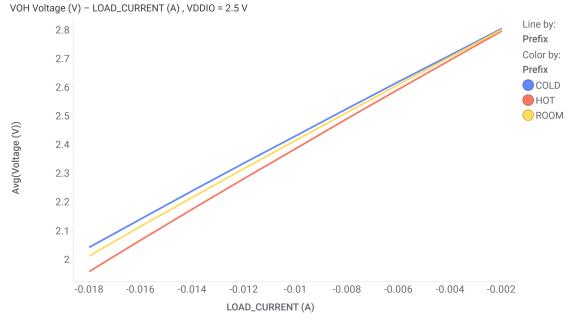
7.8 Typical Characteristics





VDDIO = 2.5 V





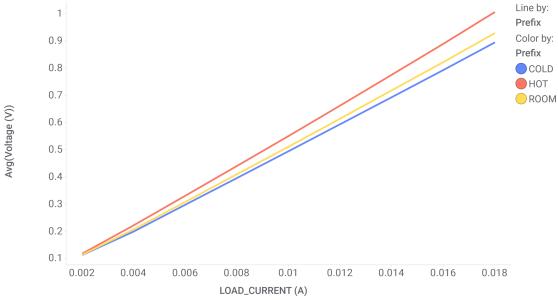
VDDIO = 2.5 V

Figure 7-11. LED pins VOH (2.5 V)



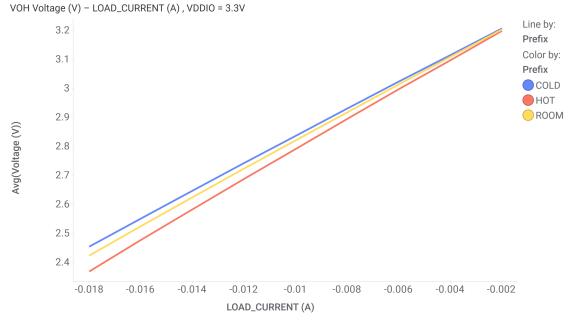
7.8 Typical Characteristics





VDDIO = 3.3 V





VDDIO = 3.3 V

Figure 7-13. LED pins VOH (3.3 V)



8 Detailed Description

8.1 Overview

The DP83TC814S-Q1 is a 100BASE-T1 automotive Ethernet Physical Layer transceiver. It is IEEE 802.3bw compliant and AEC-Q100 qualified for automotive applications. The DP83TC814S-Q1 is interoperable with both BroadR-Reach PHYs and 100BASE-T1 PHYs.

This device is specifically designed to operate at 100-Mbps speed while meeting stringent automotive EMC limits. TheDP83TC814S-Q1 transmits PAM3 ternary symbols at 66.667 MHz over unshielded single twisted-pair cable. It is application flexible; supporting MII, RMII, RGMII, and SGMII in a single 36-pin VQFN wettable flank package.

There is an extensive Diagnostic Tool Kit within the DP83TC814S-Q1 for both in-system use as well as debug, compliance and system prototyping for bring-up. The DP83TC814S-Q1 can meet IEC61000-4-2 Level 4 electrostatic discharge limits and it also includes an on-chip ESD sensor for detecting ESD events in real-time.



8.2 Functional Block Diagram

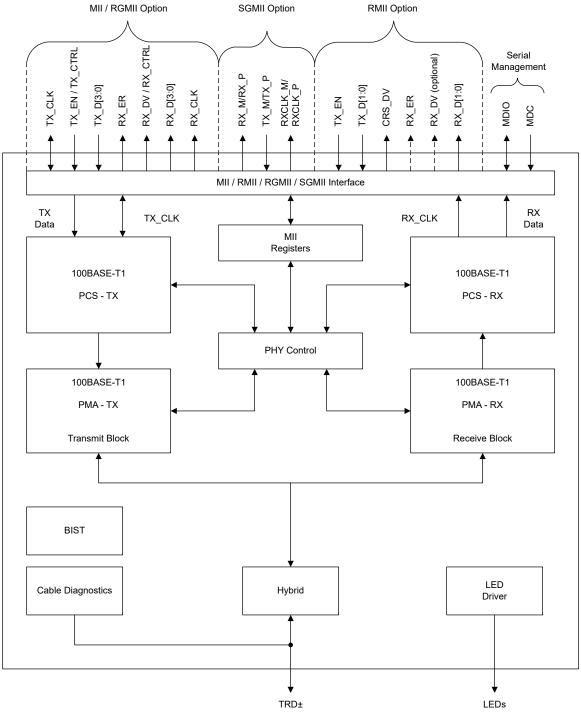


Figure 8-1. DP83TC814S-Q1



8.3 Feature Description

Note

Refer to SNLA389 Application Note for more information about the register settings used for compliance testing. It is necessary to use these register settings in order to achieve the same performance as observed during compliance testing.

8.3.1 Diagnostic Tool Kit

The DP83TC814 diagnostic tool kit provides mechanisms for monitoring normal operation, device-level debugging, system-level debugging, fault detection, and compliance testing. This tool kit includes a built-in self-test with PRBS data, various loopback modes, Signal Quality Indicator (SQI), Time Domain Reflectometry (TDR), undervoltage monitor, electrostatic discharge monitor, and IEEE 802.3bw test modes.

8.3.1.1 Signal Quality Indicator

When the DP83TC814S-Q1 is active, the Signal Quality Indicator may be used to determine the quality of link based on SNR readings made by the device. SQI is presented as a 8-level indication. Signal quality indication is accessible through register 0x871. SQI is continuously monitored by the PHY to allow for real-time link signal quality status.

Bits[3:1] in register 0x871 provide SQI value while bits [7:5] provide the worst SQI value since the last read. The SQI value reported in register 0x871[3:1] map directly to the SQI levels required by Open Alliance.

In order to get the most accurate SQI reporting, use the initialization routine explained in SNLA389 application note.

| REG 0x871[3:1] | OPEN ALLIANCE SQI LEVEL | LINK QUALITY | | | |
|----------------|-------------------------|-----------------------|--|--|--|
| 0x0 | 0 (Worst) | | | | |
| 0x1 | 1 | - Poor/ No Link | | | |
| 0x2 | 2 | | | | |
| 0x3 | 3 | | | | |
| 0x4 | 4 | Good / Excellent Link | | | |
| 0x5 | 5 | | | | |
| 0x6 | 6 | 1 | | | |
| 0x7 | 7 (Best) | 1 | | | |
| | | | | | |

Table 8-1. Signal Quality Indicator

8.3.1.2 Electrostatic Discharge Sensing

Electrostatic discharge is a serious issue for electronic circuits and if not properly mitigated can create short-term issues (signal integrity, link drops, packet loss) as well as long-term reliability faults. The DP83TC814 has robust integrated ESD circuitry and offers an ESD sensing architecture. ESD events can be detected on MDI pins independently for further analysis and debug.

Additionally, the DP83TC814 provides an interrupt status flag; *Register 0x12[11]* is set when an ESD event is logged. This interrupt can be routed to the INT_N pin using bit[3] of the same register. *Register 0x442[14:9]* store the number of ESD events that have occurred since power-up. Hardware and software resets are ignored by the ESDS register to prevent unwarranted clearing.

8.3.1.3 Time Domain Reflectometry

Time domain reflectometry helps determine the quality of the cable, connectors and terminations in addition to estimating OPEN and SHORT faults along a cable. The DP83TC814-Q1 transmits a test pulse down the attached twisted-pair cable. Transmitted pulses continue down the cable and reflect from each imperfection and fault, allowing the device to measure the time to return and strength (amplitude) of all reflections. This technique enables the DP83TC814-Q1 to identify cable OPENs and SHORTs.

TDR is activated by setting bit[15] in register 0x1E. The procedure is as follows.



- Configure the DP83TC814-Q1 as per the initilization settings from SNLA389 Application Note
- Ensure that the Link Partner connected to the PHY is slient. Link will be down during TDR execution.
- Run the Pre-TDR configuration settings as listed in SNLA389.
- Start TDR by setting register 0x1E[15] to '1'.
- Wait 100ms, read register 0x1E[1:0]
 - If it reads 0b10 then TDR has executed successfully.
- If TDR executed successfully then read register 0x310 to get TDR results.
 - 0x310[8]: 0 = Half Wire Open not detected or 1 = Half Wire Open detected
 - 0x310[7]: 0 = Cable fault not detected or 1 = Cable fault detected
 - 0x310[6]: 0 = Cable fault is OPEN or 1 = Cable fault is SHORT
 - If valid cable fault is detected then 0x310[5:0] will store the location value in meters.

8.3.1.4 Voltage Sensing

The DP83TC814 offers sensors for monitoringvoltage at the supply pins. Undervoltage monitoring are always active in the DP83TC814 by default. If an undervoltage condition is detected, interrupt status flag is set in register 0x0013. These interrupts can also be optionally routed to the INT pin using the same register.

The following method should be used to read each sensor.

- Step 1: Program register 0x0467 = 0x6004 ; Initial configuration of monitors
- Step 2: Program register 0x046A = 0x00A3; Enable Monitors
- Step 3: Configure register 0x0468 with the corresponding setting to select the required sensor.
 - VDDA Sensor: Use 0x0468 = 0x0920
 - VSLEEP Sensor: Use 0x0468 = 0x1920
 - VDDMAC Sensor: Use 0x0468 = 0x2920
 - VDDIO Sensor: Use 0x0468 = 0x3920
- Step 4: Read register 0x047B[14:7] and convert this output code to decimal.
- Step 5: Use the output code in the following equations to get the sensor's absolute value. Refer to Table 8-2 table for constant values for corresponding sensors.
 - vdda_value = 3.3 + (vdda_output_code vdda_output_mean_code)*slope_vdda_sensor
 - vsleep_value = 3.3 + (vsleep_output_code vsleep_output_mean_code)*slope_vsleep_sensor
 - vddmac_value = 3.3 + (vddmac_output_code vddmac_output_mean_code)*slope_vddmac_sensor
 - vddio_value = 3.3 + (vddio_output_code vddio_output_mean_code)*slope_vddio_sensor

| Sensor | Constant | Value |
|--------|-------------------------|--------|
| VDDA | vdda_output_mean_code | 126 |
| | slope_vdda_sensor | 0.0088 |
| VSLEEP | vsleep_output_mean_code | 134 |
| | slope_vsleep_sensor | 0.0088 |
| VDDMAC | vddmac_output_mean_code | 205 |
| | slope_vddmac_sensor | 0.016 |
| VDDIO | vddio_output_mean_code | 205 |
| | slope_vddio_sensor | 0.016 |

Table 8-2. Sensors Constant Values



8.3.1.5 BIST and Loopback Modes

DP83TC814 incorporates a data-path's Built-In-Self-Test (BIST) to check the PHY level and system level data-paths. BIST has following integrated features which make the system level data transfer tests (through-put etc) and diagnostics possible without relying on MAC or external data generator hardware/software.

The following features are available in the DP83TC814 which can be used for easy evaluation.

- 1. Loopback modes
- 2. Data Generator
 - a. Customizable MAC packets generator
 - b. Transmitted packet counter
 - c. PRBS stream generator
- 3. Data Checker
 - a. Received MAC packets error checker
 - b. Received packet counter: Counts total packets received and packets received with errors
 - c. PRBS lock and PRBS error checker

8.3.1.5.1 Data Generator and Checker

DP83TC814 supports inbuilt Pseudo-random data generator and checker which can be used in conjuction with Loopback modes to check the data path. Data generator can be programmed to generate either user defined MAC packets or PRBS stream.

Following parameters of generated MAC packets can be configured (refer to registers<0x061B>,register<0x061A> and register<0x0624> for required configuration):

- Packet Length
- Inter-packet gap
- Defined number of packets to be sent or continuous transmission
- Packet data-type: Incremental/Fixed/PRBS
- Number of valid bytes per packet

8.3.1.5.2 xMII Loopback

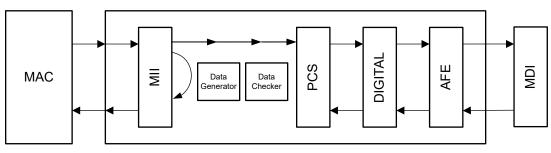


Figure 8-2. xMII Loopback Without Data Generator

xMII Loopback is the shallowest loop through the PHY. It is a useful test mode to validate communications between the MAC and the PHY. When in xMII Loopback, data transmitted from a connected MAC on the TX path is internally looped back in the DP83TC814 to the RX pins where it can be checked by the MAC. There is no link indication when in xMII loopback.

Enable Loopback

Write register 0x0000 = 0x6100



Enable data generator/checker for MAC side

Data will be generated externally on the MAC TX pins.

Use the following register settings to enable checker depending on the MAC interface mode.

- For RGMII, write register 0x0619 = 0x1004
- For SGMII, write register 0x0619 = 0x1114
- For RMII, write register 0x0619 = 0x1224
- For MII, write register 0x0619 = 0x1334

Check incoming data from MAC side

Data can be verified at MAC interface RX pins.

Data can also be checked internally by reading registers 0x063C, 0x063D, 0x063E

Enable data generator/checker for Cable side

Not applicable as data will be generated externally on the MAC interface TX pins.

Check data for Cable side

Not applicable as PRBS stream checker works with only internal PRBS generator.

Other system requirements

Generated data will be going to cable side.

8.3.1.5.3 PCS Loopback

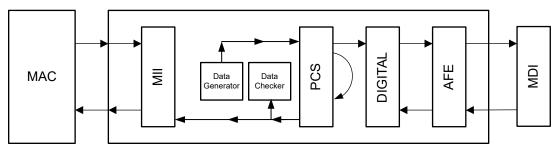


Figure 8-3. PCS Loopback with data generator

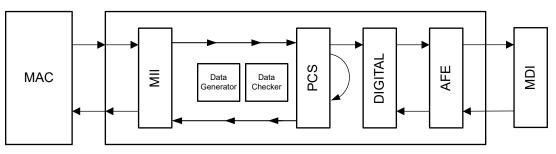


Figure 8-4. PCS Loopback without data generator

PCS Loopback will loop back data prior to it exiting the PCS and entering the PMA. Data received from the MAC on the transmit path is brought through the digital block within the PHY where it is then routed back to the MAC through the receive path. The DP83TC814 receive PMA circuitry is configured for isolation to prevent contention.

Enable Loopback

Write register 0x0016 = 0x0102

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Enable data generator/checker for MAC side

Write register 0x0619 = 0x1555

Write register 0x0624 = 0x55BF

Check incoming data from MAC side

Data can also be checked internally by reading registers 0x063C, 0x063D, 0x063E

Enable data generator/checker for Cable side

Write register 0x0619 = 0x0557

Write register 0x0624 = 0x55BF

Check data for Cable side

- 1. Write register 0x0620[1] = 1'b1
- 2. Read register 0x620
 - a. Bit [7:0] = Number of errors bytes received
 - b. Bit [8] = PRBS checker lock status on incoming data (1'b1 indicates lock)

Repeat steps 1 and 2 to continously check error status of incoming data stream.

Other system requirements

Data generate by the internal PRBS will be transmitted over the MDI and the MAC interface.

8.3.1.5.4 Digital Loopback

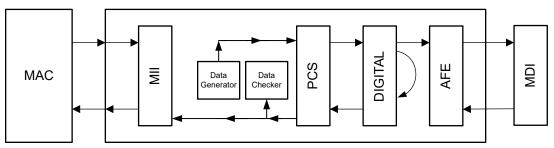


Figure 8-5. Digital loopback with data generator

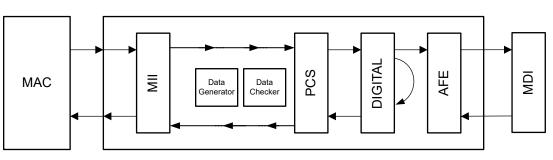


Figure 8-6. Digital loopback without data generator

Digital Loopback will loop back data prior to it exiting the Digital and entering the AFE. Data received from the MAC on the transmit path is brought through the digital block within the PHY where it is then routed back to the MAC through the receive path. The DP83TC814 receive Analog circuitry is configured for isolation to prevent contention.



Enable Loopback

Write register 0x0016 = 0x0104

Enable data generator/checker for MAC side

Write register 0x0619 = 0x1555Write register 0x0624 = 0x55BF

Check incoming data from MAC side

Data can also be checked internally by reading registers 0x063C, 0x063D, 0x063E

Enable data generator/checker for Cable side

Write register 0x0619 = 0x0557

Write register 0x0624 = 0x55BF

Check data for Cable side

- 1. Write register 0x0620[1] = 1'b1
- 2. Read register 0x620
 - a. Bit [7:0] = Number of errors bytes received
 - b. Bit [8] = PRBS checker lock status on incoming data (1'b1 indicates lock)

Repeat steps 1 and 2 to continously check error status of incoming data stream.

Other system requirements

Data generate by the internal PRBS will be transmitted over the MDI and the MAC interface.



8.3.1.5.5 Analog Loopback

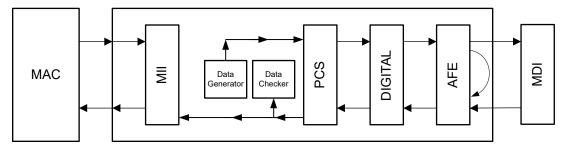


Figure 8-7. Analog loopback with data generator

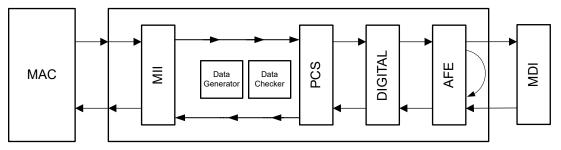


Figure 8-8. Analog loopback with data generator

Analog Loopback uses the echoed signals from the unterminated MDI and decodes these signals in the Hybrid to return the data to the MAC.

Enable Loopback

Write register 0x0016 = 0x0108

Enable data generator/checker for MAC side

Write register 0x0619 = 0x1555

Write register 0x0624 = 0x55BF

Check incoming data from MAC side

Data can also be checked internally by reading registers 0x063C, 0x063D, 0x063E

Enable data generator/checker for Cable side

Write register 0x0619 = 0x0557

Write register 0x0624 = 0x55BF

Check data for Cable side

- 1. Write register 0x0620[1] = 1'b1
- 2. Read register 0x620
 - a. Bit [7:0] = Number of errors bytes received
 - b. Bit [8] = PRBS checker lock status on incoming data (1'b1 indicates lock)

Repeat steps 1 and 2 to continously check error status of incoming data stream.



Other system requirements

Data generate by the internal PRBS will be transmitted over the MDI and the MAC interface.

8.3.1.5.6 Reverse Loopback

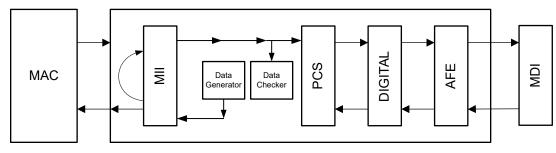


Figure 8-9. Reverse Loopback With Data Generator

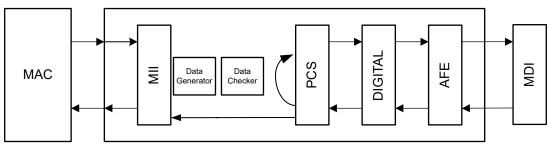


Figure 8-10. Reverse Loopback Without Data Generator

Reverse Loopback receives data on the MDI and passes it through the entire receive block where it is then looped back within the PCS layer to the transmit block. The data is transmitted back out on the MDI to the attached Link Partner. To avoid contention, MAC transmit path is isolated.

Enable Loopback

Write register 0x0016 = 0x0110

Enable data generator/checker for MAC side

Use the following register settings to enable checker depending on the MAC interface mode.

- For RGMII, write register 0x0619 = 0x1004
- For SGMII, write register 0x0619 = 0x1114
- For RMII, write register 0x0619 = 0x1224
- For MII, write register 0x0619 = 0x1334

Write register 0x0624 = 0x55BF

Check incoming data from MAC side

Data can also be checked internally by reading registers 0x063C, 0x063D, 0x063E



Enable data generator/checker for Cable side

Write register 0x0619 = 0x0557

Write register 0x0624 = 0x55BF

Check data for Cable side

- 1. Write register 0x0620[1] = 1'b1
- 2. Read register 0x620
 - a. Bit [7:0] = Number of errors bytes received
 - b. Bit [8] = PRBS checker lock status on incoming data (1'b1 indicates lock)

Repeat steps 1 and 2 to continously check error status of incoming data stream.

Other system requirements

Data generate by the internal PRBS will be transmitted over the MDI and the MAC interface.

8.3.2 Compliance Test Modes

Note

Refer to SNLA389 Application Note for more information about the register settings used for compliance testing. It is necessary to use these register settings in order to achieve the same performance as observed during compliance testing.

There are four PMA compliance test modes required in IEEE 802.3bw, sub-clause 96.5.2, which are all supported by the DP83TC814-Q1. These compliance test modes include: transmitter waveform Power Spectral Density (PSD) mask, amplitude, distortion, 100BASE-T1 Master jitter, 100BASE-T1 Slave jitter, droop, transmitter frequency, frequency tolerance, return loss, and mode conversion.

Any of the three GPIOs can be used to output TX_TCLK for the 100BASE-T1 Slave jitter measurement. For routing TX_TCLK to CLKOUT pin for 100BASE-T1 Slave Jitter measurement, write to register 0x045F = 0x000D. The device should be configured in Slave mode.

8.3.2.1 Test Mode 1

Test mode 1 evaluates transmitter droop. In test mode 1, the DP83TC814-Q1 transmits '+1' symbols for a minimum of 600 ns followed by '-1' symbols for a minimum of 600 ns. This pattern is repeated continuously until the test mode is disabled.

Test mode 1 is enabled by setting bits[15:13] = 0b001 in the MMD1_PMA_TEST_MODE_CTRL Register (0x1836).

8.3.2.2 Test Mode 2

Test mode 2 evaluates the transmitter 100BASE-T1 Master mode jitter. In test mode 2, the DP83TC814-Q1 transmits a {+1,-1} data symbol sequence. The transmitter synchronizes the transmitted symbols from the local reference clock.

Test mode 2 is enabled by setting bits[15:13] = 0b010 in MMD1_PMA_TEST_MODE_CTRL Register (0x1836).

8.3.2.3 Test Mode 4

Test mode 4 evaluates the transmitter distortion. In test mode 4, the DP83TC814-Q1 transmits the sequence of symbols generated by Equation 1:

$$g(x) = 1 + x^9 + x^{11}$$

(1)

The bit sequences, x0n and x1n, are generated from combinations of the scrambler in accordance to Equation 2 and Equation 3:



 $x0_n = Scr_n[0]$

 $x1_n = Scr_n[1] \wedge Scr_n[4]$

(2)

(3)

Example streams of the 3-bit nibbles are shown in Table 8-3.

Table 8-3. Transmitter Test Mode 4 Symbol Mapping

| x1n | x0n | PAM3 SYMBOL |
|-----|-----|-------------|
| 0 | 0 | 0 |
| 0 | 1 | +1 |
| 1 | 0 | 0 |
| 1 | 1 | -1 |

Test mode 4 is enabled by setting bits[15:13] = 0b100 in MMD1_PMA_TEST_MODE_CTRL Register (0x1836).

8.3.2.4 Test Mode 5

Test mode 5 evaluates the transmitter PSD mask. In test mode 5, the DP83TC814-Q1 transmits a pseudo-random sequence of PAM3 symbols.

Test mode 5 is enabled by setting bits[15:13] = 0b101 in MMD1_PMA_TEST_MODE_CTRL Register (0x1836).

8.4 Device Functional Modes

8.4.1 Power Down

When any of the supply rails are below the POR threshold (~0.6V), the PHY is in a power-down state. All digital IOs will remain in high impedance states and analog blocks are disabled. PMA termination is not present when powered down.

8.4.2 Reset

Reset is activated upon power-up, when RESET is pulled LOW (for the minimum reset pulse time) or if hardware reset is initiated by setting bit[15] in register 0x1F. All digital circuitry is cleared along with register settings during reset. Once reset completes, device bootstraps are re-sampled and associated bootstrap registers are set accordingly. PMA termination is not present in reset.

8.4.3 Standby

The device (100BASE-T1 Master mode only) automatically enters into standby post power-up and reset so long that all supplies are available and the device is bootstrapped for managed operation.

In standby, all PHY functions are operational except for PCS and PMA blocks. The PMA termination is also not present. Link establishment is not possible in standby and data cannot be transmitted or received. SMI functions are operational and register configurations are maintained.

If the device is configured for autonomous operation through bootstrap setting, the PHY automatically switches to normal operation once POR is complete.

8.4.4 Normal

Normal mode can be entered from either autonomous or managed operation. When in autonomous operation, the PHY will automatically try to establish a link with a valid Link Partner once POR is complete.

In managed operation, SMI access is required to allow the device to exit standby (100BASE-T1 Master mode only); commands issued through the SMI allow the device to exit standby and enables both the PCS and PMA blocks. All device features are operational in normal mode.

Autonomous operation can be enabled through SMI access by setting bit[6] in the register 0x18B.



8.4.5 Media Dependent Interface

8.4.5.1 100BASE-T1 Master and 100BASE-T1 Slave Configuration

100BASE-T1 Master and 100BASE-T1 Slave are configured using either hardware bootstraps or through register access.

LED_0 controls the 100BASE-T1 Master and 100BASE-T1 Slave bootstrap configuration. By default, 100BASE-T1 Slave mode is configured because there is an internal pulldown resistor on LED_0 pin. If 100BASE-T1 Master mode configuration through hardware bootstrap is preferred, an external pullup resistor is required.

Additionally, bit[14] in the **MMD1_PMA_CTRL_2 Register (Address 0x1834)** controls the 100BASE-T1 Master and 100BASE-T1 Slave configuration. When this bit is set, 100BASE-T1 Master mode is enabled.

8.4.5.2 Auto-Polarity Detection and Correction

During the link training process, the DP83TC814-Q1 100BASE-T1 Slave device is able to detect polarity reversal and automatically corrects the error. If polarity reversal is detected, the 100BASE-T1 Slave will invert its own transmitted signals to account for the error and ensure compatibility with the 100BASE-T1 Master. Polarity at the 100BASE-T1 Master is always observed as correct because polarity detection and correction is handled entirely by the 100BASE-T1 Slave.

Auto-polarity correction may be disabled in cases where it is not required. Disabling of auto-polarity correction is achieved via register 0x0553.

8.4.5.3 Jabber Detection

The jabber function prevents the PCS Receive state machine from locking up into a DATA state if the Endof-Stream Delimiters, ESD1 and ESD2, are never detected or received within the rcv_max_timer. When the maximum receive DATA state timer expires, the PCS Receive state machine is reset and transitions into IDLE state. IEEE 802.3bw specifies that jabber timeout be set to 1.08 ms \pm 54 µs. By default, jabber timeout in the DP83TC814 is set to 1.1 ms. This timer is configurable in *Register 0x496[10:0]*.

8.4.5.4 Interleave Detection

The interleave function allows for the DP83TC814-Q1 to detect and de-interleave the serial stream from a connected link partner. The two possible interleave sequences of ternary symbols include: (TA_n, TB_n) or (TB_n, TA_n) .

8.4.6 MAC Interfaces

8.4.6.1 Media Independent Interface

The Media Independent Interface (MII) is a synchronous 4-bit wide nibble data interface that connects the PHY to the MAC. The MII is fully compliant with IEEE 802.3-2015 clause 22. The PHY has internal series termination resistors on MII output pins including TX_CLK output when the PHY is operating in MII mode. In this mode, it is recommended to not leave the MII-TX pins floating or High-Z.

The MII signals are summarized in Table 8-4:

| Table 8-4. MII Signals | | | |
|------------------------|--|--|--|
| PINS | | | |
| TX_D[3:0] | | | |
| RX_D[3:0] | | | |
| TX_EN, TX_ER | | | |
| RX_DV, RX_ER | | | |
| TX_CLK | | | |
| RX_CLK | | | |
| | | | |



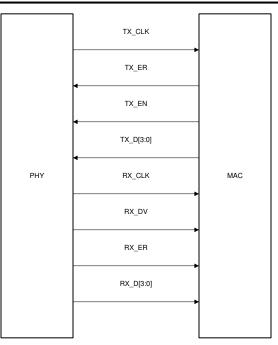


Figure 8-11. Mll Signaling

Table 8-5. MII Transmit Encoding

| TX_ER | TX_D[3:0] | DESCRIPTION |
|-------|---|---|
| 0 | 0000 through 1111 | Normal Inter-Frame |
| 1 | 0000 through 1111 | Reserved |
| 0 | 0000 through 1111 | Normal Data Transmission |
| 1 | 0000 through 1111 | Transmit Error Propagation |
| | TX_ER 0 1 0 1 0 1 | 0 0000 through 1111 1 0000 through 1111 0 0000 through 1111 |



| RX_DV | RX_ER | RX_D[3:0] | DESCRIPTION |
|-------|-------|-------------------|----------------------------|
| 0 | 0 | 0000 through 1111 | Normal Inter-Frame |
| 0 | 1 | 0000 | Normal Inter-Frame |
| 0 | 1 | 0001 through 1101 | Reserved |
| 0 | 1 | 1110 | False Carrier Indication |
| 0 | 1 | 1111 | Reserved |
| 1 | 0 | 0000 through 1111 | Normal Data Reception |
| 1 | 1 | 0000 through 1111 | Data Reception with Errors |

Table 8-6. MII Receive Encoding

8.4.6.2 Reduced Media Independent Interface

The DP83TC814-Q1 incorporates the Reduced Media Independent Interface (RMII) as defined in the RMII Revision 1.2 and 1.0 from the RMII consortium. The purpose of this interface is to provide a reduced pin count alternative to the IEEE 802.3u MII as specified in Clause 22. Architecturally, the RMII specification provides an additional reconciliation layer on either side of the MII, but can be implemented in the absence of an MII.

The DP83TC814-Q1 offers two types of RMII operations: RMII Slave and RMII Master. In RMII Slave Mode, the DP83TC814-Q1 operates off a 50-MHz CMOS-level oscillator, which is either provided by the MAC or synchronous to the MAC's reference clock. In RMII Master operation, the DP83TC814-Q1 operates off of either a 25-MHz CMOS-level oscillator connected to XI pin or a 25-MHz crystal connected across XI and XO pins. When bootstrapping to RMII Master Mode, a 50-MHz output clock will automatically be enabled on RX_D3. This 50-MHz output clock should be routed to the MAC.

The RMII specification has the following characteristics:

- Single clock reference shared between MAC and PHY
- Provides independent 2-bit wide transmit and receive data paths

In this mode, data transfers are two bits for every clock cycle using the 50-MHz reference clock for both transmit and receive paths.

The RMII signals are summarized in Table 8-7:

| Table 0-7. Nini Ognals | | |
|------------------------|-----------|--|
| FUNCTION | PINS | |
| Dota Signala | TX_D[1:0] | |
| Data Signals | RX_D[1:0] | |
| Control Signals | TX_EN | |
| Control Signals | CRS_DV | |

Table 8-7. RMII Signals



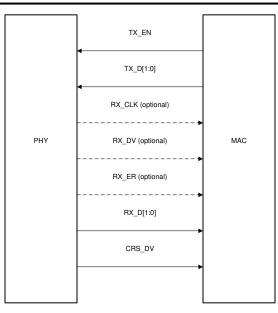


Figure 8-12. RMII Signaling

| Table 8-8. RMII Transmit Encoding | Table | 8-8. RMII | Transmit | Encoding |
|-----------------------------------|-------|-----------|----------|----------|
|-----------------------------------|-------|-----------|----------|----------|

| TX_EN | TX_D[1:0] DESCRIPTION | | |
|-------|-----------------------|--------------------------|--|
| 0 | 00 through 11 | Normal Inter-Frame | |
| 1 | 00 through 11 | Normal Data Transmission | |

Table 8-9. RMII Receive Encoding

| CRS_DV | RX_ER | RX_D[1:0] | DESCRIPTION |
|--------|-------|---------------|----------------------------|
| 0 | 0 | 00 through 11 | Normal Inter-Frame |
| 0 | 1 | 00 | Normal Inter-Frame |
| 0 | 1 | 01 through 11 | Reserved |
| 1 | 0 | 00 through 11 | Normal Data Reception |
| 1 | 1 | 00 through 11 | Data Reception with Errors |

RMII Slave: Data on TX_D[1:0] are latched at the PHY with reference to the rising edge of the reference clock at the XI pin. Data is presented on RX_D[1:0] with reference to the same rising clock edges at the XI pin.

RMII Master: Data on TX_D[1:0] are latched at the PHY with reference to the rising edge of the reference clock at the RX_D3 pin. Data is presented on RX_D[1:0] with reference to the same rising clock edges at the RX_D3 pin.

The DP83TC814-Q1 RMII supplies an RX_DV signal, which provides a simpler method to recover receive data without the need to separate RX_DV from the CRS_DV indication. RX_ER is also supported even though it is not required by the RMII specification.

RMII includes a programmable FIFO to adjust for the frequency differences between the reference clock and the recovered clock. The programmable FIFO, located in the register 0x0011[9:8] and register 0x0648[9:7], minimizes internal propagation delay based on expected maximum packet size and clock accuracy.

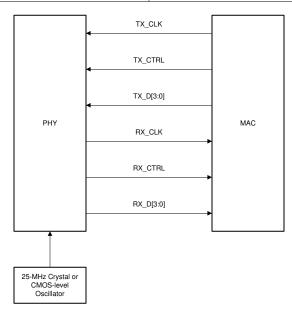
8.4.6.3 Reduced Gigabit Media Independent Interface

The DP83TC814-Q1 also supports Reduced Gigabit Media Independent Interface (RGMII) as specified by RGMII version 2.0 with LVCMOS. RGMII is designed to reduce the number of pins required to connect MAC and PHY. To accomplish this goal, the control signals are multiplexed. Both rising and falling edges of the clock are used to sample the control signal pin on transmit and receive paths. Data is samples on just the rising edge of the clock. For 100-Mbps operation, RX_CLK and TX_CLK operate at 25 MHz.



The RGMII signals are summarized in Table 8-10:

| Table 8-10. RGMII Signals | | |
|---------------------------------|-----------|--|
| FUNCTION | PINS | |
| Data Signals Control Signals | TX_D[3:0] | |
| | RX_D[3:0] | |
| | TX_CTRL | |
| | RX_CTRL | |
| Clock Signals | TX_CLK | |
| | RX_CLK | |





| Table 8-11. | RGMII | Transmit | Encoding |
|-------------|-------|----------|-----------|
| 10010 0 111 | | | Encouning |

| TX_CTRL (POSITIVE EDGE) | TX_CTRL (NEGATIVE EDGE) | TX_D[3:0] | DESCRIPTION |
|----------------------------|----------------------------|-------------------|----------------------------|
| 0 | 0 | 0000 through 1111 | Normal Inter-Frame |
| 0 | 1 | 0000 through 1111 | Reserved |
| 1 | 0 | 0000 through 1111 | Normal Data Transmission |
| 1 | 1 | 0000 through 1111 | Transmit Error Propagation |

| RX_CTRL (POSITIVE EDGE) | RX_CTRL (NEGATIVE EDGE) | RX_D[3:0] | DESCRIPTION |
|----------------------------|----------------------------|-------------------|----------------------------|
| 0 | 0 | 0000 through 1111 | Normal Inter-Frame |
| 0 | 1 | 0000 through 1101 | Reserved |
| 0 | 1 | 1110 | False Carrier Indication |
| 0 | 1 | 1111 | Reserved |
| 1 | 0 | 0000 through 1111 | Normal Data Reception |
| 1 | 1 | 0000 through 1111 | Data Reception with Errors |

During packet reception, RX_CLK may be stretched on either the positive or negative pulse to accommodate the transition from the internal free running clock to a recovered clock (data synchronous). Data may be duplicated



on the falling edge of the clock because double data rate (DDR) is only required for 1-Gbps operation, which is not supported by the DP83TC814-Q1.

The DP83TC814-Q1 supports in-band status indication to help simplify link status detection. Inter-frame signals on RX_D[3:0] pins as specified in Table 8-13.

| RX_CTRL | RX_D3 | RX_D[2:1] | RX_D0 | | | |
|---|----------------|-----------|--|--|--|--|
| 00 Note: In-band status is only valid when RX_CTRL is low | Buplox Glataol | | Link Status: 0 = Link not established 1 = Valid link established | | | |
| | | | | | | |

8.4.7 Serial Management Interface

The Serial Management Interface (SMI) provides access to the DP83TC814S-Q1 internal register space for status information and configuration. The SMI frames and base registers are compatible with IEEE 802.3 clause 22. The implemented register set consists of the registers required by the IEEE 802.3 plus several others to provide additional visibility and controllability of the DP83TC814S-Q1. Additionally, the DP83TC814S-Q1 includes control and status registers added to clause 45 as defined by IEEE 802.3bw. Access to clause 45 register field is achieved using clause 22 access.

The SMI includes the management clock (MDC) and the management input and output data pin (MDIO). MDC is sourced by the external management entity, also called Station (STA), and can run at a maximum clock rate of 24 MHz. MDC is not expected to be continuous, and can be turned off by the external management entity when the bus is idle.

MDIO is sourced by the external management entity and by the PHY. The data on the MDIO pin is latched on the rising edge of the MDC. MDIO pin requires a pullup resistor (2.2 K Ω), which pulls MDIO high during IDLE and turnaround.

Up to 9 DP83TC814S-Q1 PHYs can share a common SMI bus. To distinguish between the PHYs, a 4-bit address is used. During power-up-reset, the DP83TC814S-Q1 latches the PHYAD[3:0] configuration pins to determine its address.

The management entity must not start an SMI transaction in the first cycle after power-up-reset. To maintain valid operation, the SMI bus must remain inactive at least one MDC cycle after hard reset is deasserted. In normal MDIO transactions, the register address is taken directly from the management-frame reg_addr field, thus allowing direct access to 32 16-bit registers (including those defined in IEEE 802.3 and vendor specific). The data field is used for both reading and writing. The Start code is indicated by a <01> pattern. This pattern makes sure that the MDIO line transitions from the default idle line state. Turnaround is defined as an idle bit time inserted between the Register Address field and the Data field. To avoid contention during a read transaction, no device may actively drive the MDIO signal during the first bit of turnaround. The addressed DP83TC814S-Q1 drives the MDIO with a zero for the second bit of turnaround and follows this with the required data.

For write transactions, the station-management entity writes data to the addressed DP83TC814S-Q1 , thus eliminating the requirement for MDIO Turnaround. The turnaround time is filled by the management entity by inserting <10>.

| SMI PROTOCOL <idle> <start> <op code=""> <device address=""> <reg address=""> <turnaround> <data> <idle></idle></data></turnaround></reg></device></op></start></idle> | | | |
|--|--|--|--|
| Read Operation | <idle><01><10><aaaaa><rrrrr><z0><xxxx xxxx=""><idle></idle></xxxx></z0></rrrrr></aaaaa></idle> | | |
| Write Operation <idle><01><01><aaaaa><rrrrr><10><xxxx xxxx=""><idle></idle></xxxx></rrrrr></aaaaa></idle> | | | |

Table 8-14. SMI Protocol Structure

8.4.8 Direct Register Access

Direct register access can be used for the first 31 registers (0x0 through 0x1F).



8.4.9 Extended Register Space Access

The DP83TC814S-Q1 SMI function supports read and write access to the extended register set using registers REGCR (0xD) and ADDAR (0xE) and the MDIO Manageable Device (MMD) indirect method defined in IEEE 802.3ah Draft for Clause 22 for accessing the Clause 45 extended register set.

REGCR (0xD) is the MDIO Manageable MMD access control. In general, register REGCR[4:0] is the device address DEVAD that directs any accesses of ADDAR (0xE) register to the appropriate MMD.

The DP83TC814S-Q1 supports 3 MMD device addresses:

- 1. DEVAD[4:0] = 11111 is used for general MMD register accesses for IEEE defined registers as well as vendor defined registers.
- 2. DEVAD[4:0] = 00001 is used for 100BASE-T1 PMA MMD register accesses. Register names for registers accessible at this device address are preceded by MMD1.
- 3. DEVAD[4:0] = 00011 is used for vendor specific registers. This registers space is called MMD3.

All accesses through register REGCR and ADDAR must use the correct DEVAD. Transactions with other DEVADs are ignored. REGCR[15:14] holds the access function: address (00), data with no post increment (01), data with post increment on read and writes (10) and data with post increment on writes only (11).

- ADDAR is the address and data MMD register. ADDAR is used in conjunction with REGCR to provide the
 access to the extended register set. If register REGCR[15:14] is (00), then ADDAR holds the address of
 the extended address space register. Otherwise, ADDAR holds the data as indicated by the contents of
 its address register. When REGCR[15:14] is set to (00), accesses to register ADDAR modify the extended
 register set address register. This address register must always be initialized to access any of the registers
 within the extended register set.
- When REGCR[15:14] is set to (01), accesses to register ADDAR access the register within the extended register set selected by the value in the address register.
- When REGCR[15:14] is set to (10), access to register ADDAR access the register within the extended register set selected by the value in the address register. After that access is complete, for both reads and writes, the value in the address register is incremented.
- When REGCR[15:14] is set to (11), access to register ADDAR access the register within the extended register set selected by the value in the address register. After that access is complete, for write access only, the value in the address register is incremented. For read accesses, the value of the address register remains unchanged.

The following sections describe how to perform operations on the extended register set using register REGCR and ADDAR.

8.4.10 Write Address Operation

To set the address register:

- 1. Write the value 0x1F (address function field = 00, DEVAD = '11111') to register REGCR.
- 2. Write the register address to register ADDAR.

Subsequent writes to register ADDAR (step 2) continue to write the address register.

8.4.10.1 MMD1 - Write Address Operation

For writing register addresses within MMD1 field:

- 1. Write the value 0x1 (address function field = 00, DEVAD = '00001') to register REGCR.
- 2. Write the register address to register ADDAR.

8.4.11 Read Address Operation

To read the address register:

- 1. Write the value 0x1F (address function field = 00, DEVAD = '11111') to register REGCR.
- 2. Read the register address from register ADDAR.

Subsequent reads to register ADDAR (step 2) continue to read the address register.



8.4.11.1 MMD1 - Read Address Operation

For reading register addresses within MMD1 field:

- 1. Write the value 0x1 (address function field = 00, DEVAD = '00001') to register REGCR.
- 2. Read the register address from register ADDAR.

8.4.12 Write Operation (No Post Increment)

To write a register in the extended register set:

- 1. Write the value 0x1F (address function field = 00, DEVAD = '11111') to register REGCR.
- 2. Write the desired register address to register ADDAR.
- 3. Write the value 0x401F (data, no post increment function field = 01, DEVAD = '11111') to register REGCR.
- 4. Write the content of the desired extended register set to register ADDAR.

Subsequent writes to register ADDAR (step 4) continue to rewrite the register selected by the value in the address register.

Note

Steps (1) and (2) can be skipped if the address register was previously configured.

8.4.12.1 MMD1 - Write Operation (No Post Increment)

To write a register in the MMD1 extended register set:

- 1. Write the value 0x1 (address function field = 00, DEVAD = '00001') to register REGCR.
- 2. Write the desired register address to register ADDAR.
- 3. Write the value 0x4001 (data, no post increment function field = 01, DEVAD = '00001') to register REGCR.
- 4. Write the content of the desired extended register set to register ADDAR.

8.4.13 Read Operation (No Post Increment)

To read a register in the extended register set:

- 1. Write the value 0x1F (address function field = 00, DEVAD = '11111') to register REGCR.
- 2. Write the desired register address to register ADDAR.
- 3. Write the value 0x401F (data, no post increment function field = 01, DEVAD = '11111') to register REGCR.
- 4. Read the content of the desired extended register set in register ADDAR.

Subsequent reads to register ADDAR (step 4) continue to reading the register selected by the value in the address register.

Note

Steps (1) and (2) can be skipped if the address register was previously configured.



8.4.13.1 MMD1 - Read Operation (No Post Increment)

To read a register in the MMD1 extended register set:

- 1. Write the value 0x1 (address function field = 00, DEVAD = '00001') to register REGCR.
- 2. Write the desired register address to register ADDAR.
- 3. Write the value 0x4001 (data, no post increment function field = 01, DEVAD = '00001') to register REGCR.
- 4. Read the content of the desired extended register set in register ADDAR.

8.4.14 Write Operation (Post Increment)

To write a register in the extended register set with post increment:

- 1. Write the value 0x1F (address function field = 00, DEVAD = '11111') to register REGCR.
- 2. Write the desired register address to register ADDAR.
- 3. Write the value 0x801F (data, post increment function field = 10, DEVAD = '11111') or the value 0xC01F (data, post increment on writes function field = 11, DEVAD = '11111') to register REGCR.
- 4. Write the content of the desired extended register set to register ADDAR.

Subsequent writes to register ADDAR (step 4) write the next higher addressed data register selected by the value of the address register; the address register is incremented after each access.

8.4.14.1 MMD1 - Write Operation (Post Increment)

To write a register in the MMD1 extended register set with post increment:

- 1. Write the value 0x1 (address function field = 00, DEVAD = '00001') to register REGCR.
- 2. Write the desired register address to register ADDAR.
- 3. Write the value 0x8001 (data, post increment function field = 10, DEVAD = '00001') or the value 0xC001 (data, post increment on writes function field = 11, DEVAD = '00001') to register REGCR.
- 4. Write the content of the desired extended register set to register ADDAR.

8.4.15 Read Operation (Post Increment)

To read a register in the extended register set and automatically increment the address register to the next higher value following the write operation:

- 1. Write the value 0x1F (address function field = 00, DEVAD = '11111') to register REGCR.
- 2. Write the desired register address to register ADDAR.
- 3. Write the value 0x801F (data, post increment function field = 10, DEVAD = '11111') to register REGCR.
- 4. Read the content of the desired extended register set in register ADDAR.

Subsequent reads to register ADDAR (step 4) read the next higher addressed data register selected by the value of the address register; the address register is incremented after each access.

8.4.15.1 MMD1 - Read Operation (Post Increment)

To read a register in the MMD1 extended register set and automatically increment the address register to the next higher value following the write operation:

- 1. Write the value 0x1 (address function field = 00, DEVAD = '00001') to register REGCR.
- 2. Write the desired register address to register ADDAR.
- 3. Write the value 0x8001 (data, post increment function field = 10, DEVAD = '00001') to register REGCR.
- 4. Read the content of the desired extended register set in register ADDAR.



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8.5 Programming

8.5.1 Strap Configuration

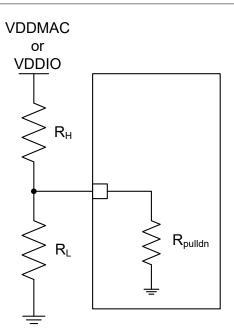
The DP83TC814S-Q1 uses functional pins as strap options to place the device into specific modes of operation. The values of these pins are sampled at power up and hardware reset (through either the RESET pin or register access). Some strap pins support 3 levels and some strap pins support 2 levels, which are described in greater detail below. PHY address straps, RX_DV/RX_CTRL and RX_ER, are 3-level straps while all other straps are two levels. Configuration of the device may be done through strapping or through serial management interface.

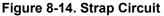
Note

Because strap pins are functional pins after reset is deasserted, they must not be connected directly to VDDIO or VDDMAC or GND. Either pullup resistors, pulldown resistors, or both are required for proper operation.

Note

When using VDDMAC and VDDIO separately, it is important to connect strap resistors to the correct voltage rail. Each pin's voltage domain is listed in the Table 8-17 table below.





R_{pulldn} value is included in the Electrical Characteristics table of the datasheet.

Table 8-15. Recommended 3-Level Strap Resistor Ratios for PHY Address

| MODE ³ | IDEAL RH ($k\Omega$) (VDDIO = 3.3V) ¹ | IDEAL RH (k Ω) (VDDIO = 2.5V) ² | IDEAL RH (kΩ) (VDDIO = 1.8V) ¹ |
|-------------------|--|--|--|
| 1 | OPEN | OPEN | OPEN |
| 2 | 13 | 12 | 4 |
| 3 | 4.5 | 2 | 0.8 |

1. Strap resistors with 10% tolerance.

- 2. Strap resistors with 1% tolerance.
- 3. RL is optional and can be added if voltage on bootstrap pins needs to be adjusted.



Table 8-16. Recommended 2-Level Strap Resistors

| MODE | IDEAL RH (kΩ) ^{1, 2} |
|------|-------------------------------|
| 1 | OPEN |
| 2 | 2.49 |

- 1. Strap resistors with upto 10% tolerance can be used.
- 2. To gain more margin in customer application for 1.8V VDDIO, either 2.1k Ω +/-10% pull-up can be used or resistor accuracy of 2.49k Ω resistor can be limited to 1%.

The following table describes the PHY configuration bootstraps:

| PIN NAME | PIN NO. | DOMAIN | DEFAULT MODE | | STRAP FUNCTIO | • | DESCRIPTION |
|-------------|---------|--------|-----------------|------|---------------|-----------|--|
| | | | | MODE | PHY_AD[0] | PHY_AD[2] | |
| RX DV/ | | | 1 | 1 | 0 | 0 | PHY_AD: PHY Address ID |
| RX_CTRL | 15 | VDDMAC | | 2 | 0 | 1 | |
| | | | | 3 | 1 | 1 | - |
| | | | | MODE | PHY_AD[1] | PHY_AD[3] | |
| | 14 | VDDMAC | 1 | 1 | 0 | 0 | |
| RX_ER | 14 | VDDMAC | 1 | 2 | 0 | 1 | PHY_AD: PHY Address ID |
| | | | | 3 | 1 | 1 | |
| CLKOUT | 16 | VDDMAC | 1 | MODE | AUTO | | AUTO: Autonomous Disable. |
| | | | | 1 | 0 | | This is a duplicate strap for LED_1. If CLKOUT pin is configured as LED 1 |
| | | | | 2 | 1 | | pin then the AUTOstrap functionality also moves to the CLKOUT pin. |
| | | | | MODE | MAC[0] | | |
| RX_D0 | 26 | VDDMAC | 1 | 1 | 0 | | MAC: MAC Interface Selection |
| | | | | 2 | 1 | | |
| | | | | MODE | MAC[1] | | |
| RX_D1 | 25 | VDDMAC | 1 | 1 | 0 | | MAC: MAC Interface Selection |
| | | | | 2 | 1 | | |
| | | | | MODE | MAC[2] | | |
| RX_D2 | 24 | VDDMAC | 1 | 1 | 0 | | MAC: MAC Interface Selection |
| | | | | 2 | 1 | | |
| | | | | MODE | CLKOUT_PIN | | |
| RX_D3 | 23 | VDDMAC | 1 | 1 | 0 | | CLKOUT_PIN: This strap determines which pin will be used for output clock. |
| | | | | 2 | 1 | | ······ |
| | | | | MODE | MS | | |
| LED_0 | 35 | VDDIO | 1 | 1 | 0 | | MS: 100BASE-T1 Master & 100BASE-T1 Slave Selection |
| | | | | 2 | 1 | | |
| | | | | MODE | AUTO | | AUTO: Autonomous Disable |
| LED_1 | 6 | VDDIO | 1 | 1 | 0 | | This is the default strap pin for controlling AUTO feature. If this pin is configured as |
| | Č | | | 2 | | | CLKOUT, the AUTO feature will move to pin 16. |

Table 8-17. Bootstraps



Note

Refer to SNLA389 Application Note for more information about the register settings used for compliance testing. It is necessary to use these register settings in order to achieve the same performance as observed during compliance testing. Managed mode strap option is recommended to prevent the link up process from initiating while the software configuration from SNLA389 is being executed. Once the software configuration is completed, the PHY can be removed from Managed mode by setting bit 0x018B[6] to '0'

RX_D3 strap pin has a special functionality of controlling the output status of CLKOUT (pin 16) and LED_1 (pin 6). The Table 8-18 table below shows how pin 16 and pin 6 will be affected by RX_D3 strap status. Note that RX_D3 option only changes the pin functionality but not their voltage domains. Pin 16 will always be in VDDMAC domain and Pin 6 will always be in VDDIO domain. If VDDIO and VDDMAC are at separate voltage levels, it must be ensured that pin 16 and pin 6 are strapped to their respective voltage domains.

In clock output daisy chain applications, if VDDMAC and VDDIO are at different voltages then clock output should be routed to pin 6. Internal oscillator of the DP83TC814 operates in the VDDIO domain, so clock ouput should also be used on the pin in VDDIO domain i.e. pin 6. In clock output daisy chain applications where VDDMAC and VDDIO are same, this requirement can be ignored. This requirement can also be ignored in applications where clock output is not being used.

| CLKOUT_PIN | DESCRIPTION | | |
|------------|--|--|--|
| 0 | Pin 16 is Clock output, Pin 6 is LED_1 pin. AUTO will be controlled by straps on pin 6. | | |
| 1 | Pin 6 is Clock output, Pin 16 is LED_1 pin. AUTO will be controlled by straps on pin 16. | | |

Table 8-18. Clock Output Pin Selection

Table 8-19. 100BASE-T1 Master and 100BASE-T1 Slave Selection Bootstrap

| MS | DESCRIPTION | |
|----|---------------------------------|--|
| 0 | 100BASE-T1 Slave Configuration | |
| 1 | 100BASE-T1 Master Configuration | |

| Table 8-20. Autonomous Mode Bootstrap | | | |
|--|--|--|--|
| AUTO DESCRIPTION | | | |
| 0 Autonomous Mode, PHY able to establish link after power-up | | | |
| 1 Managed Mode, PHY must be allowed to establish link after power-up based on register write | | | |

able 8-21, MAC Interface Selection Bootstraps

| Table 8-21. MAC Interface Selection Bootstraps | | | | | | |
|--|--------|--------|---------------------------------------|--|--|--|
| MAC[2] | MAC[1] | MAC[0] | DESCRIPTION | | | |
| 0 | 0 | 0 | SGMII (4-wire) ⁽¹⁾ | | | |
| 0 | 0 | 1 | MII | | | |
| 0 | 1 | 0 | RMII Slave | | | |
| 0 | 1 | 1 | RMII Master | | | |
| 1 | 0 | 0 | RGMII (Align Mode) | | | |
| 1 | 0 | 1 | RGMII (TX Internal Delay Mode) | | | |
| 1 | 1 | 0 | RGMII (TX and RX Internal Delay Mode) | | | |
| 1 | 1 | 1 | RGMII (RX Internal Delay Mode) | | | |
| | | | | | | |

(1) SGMII strap mode is only available on 'S' type device variant. For 'R' type device variant, this strap mode is RESERVED

Table 8-22. PHY Address Bootstraps

| PHY_AD[3:0] | RX_CTRL STRAP MODE | RX_ER STRAP MODE | DESCRIPTIONSection 8.5.1 | | |
|-------------|--------------------|------------------|----------------------------|--|--|
| 0000 | 1 | 1 | PHY Address: 0b00000 (0x0) | | |
| 0001 | - | - | NA | | |
| 0010 | - | - | NA | | |



| Table 8-22. PHY Address Bootstraps (continued) | | | | | | | | | |
|--|--------------------|------------------|----------------------------|--|--|--|--|--|--|
| PHY_AD[3:0] | RX_CTRL STRAP MODE | RX_ER STRAP MODE | DESCRIPTIONSection 8.5.1 | | | | | | |
| 0011 | - | - | NA | | | | | | |
| 0100 | 2 | 1 | PHY Address: 0b00100 (0x4) | | | | | | |
| 0101 | 3 | 1 | PHY Address: 0b00101 (0x5) | | | | | | |
| 0110 | - | - | NA | | | | | | |
| 0111 | - | - | NA | | | | | | |
| 1000 | 1 | 2 | PHY Address: 0b01000 (0x8) | | | | | | |
| 1001 | - | - | NA | | | | | | |
| 1010 | 1 | 3 | PHY Address: 0b01010 (0xA) | | | | | | |
| 1011 | - | - | NA | | | | | | |
| 1100 | 2 | 2 | PHY Address: 0b01010 (0xC) | | | | | | |
| 1101 | 3 | 2 | PHY Address: 0b01011 (0xD) | | | | | | |
| 1110 | 2 | 3 | PHY Address: 0b01110 (0xE) | | | | | | |
| 1111 | 3 | 3 | PHY Address: 0b01111 (0xF) | | | | | | |

Table 0.00 DUV Address Destations (sentimusd)

8.5.2 LED Configuration

The DP83TC814S-Q1 supports up to three configurable Light Emitting Diode (LED) pins: LED_0, LED_1, and LED_2 (CLKOUT). Several functions can be multiplexed onto the LEDs for different modes of operation. LED operations are selected using registers 0x0450.

Because the LED output pins are also used as strap pins, external components required for strapping and the user must consider the LED usage to avoid contention. Specifically, when the LED outputs are used to drive LEDs directly, the active state of each output driver is dependent on the logic level sampled by the corresponding input upon power up or hardware reset.

Figure 8-15 shows the two proper ways of connecting LEDs directly to the DP83TC814S-Q1.

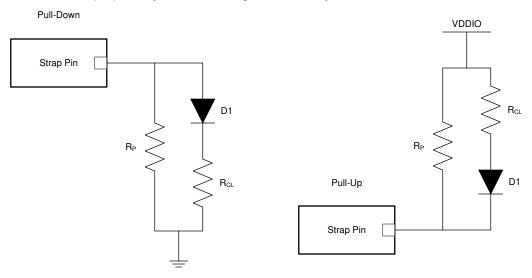


Figure 8-15. Example Strap Connections

8.5.3 PHY Address Configuration

The DP83TC814S-Q1 can be set to respond to any of 9 possible PHY addresses through bootstrap pins. The PHY address is latched into the device upon power-up or hardware reset. Each PHY on the serial management bus in the system must have a unique PHY address.

By default, DP83TC814S-Q1 will latch to a PHY address of 0 (<0b0000>). This address can be changed by adding pullup resistors to bootstrap pins found in Section 8.5.3.



8.6 Register Maps

8.6.1 Register Access Summary

There are two different methods for accessing registers within the field. Direct register access method is only allowed for the first 31 registers (0x0 through 0x1F). Registers beyond 0x1F must be accessed by use of the Indirect Method (Extended Register Space) described in *Section 8.4.9*.

Table 8-23. MMD Register Space Division

| MMD REGISTER SPACE | REGISTER ADDRESS RANGE |
|--------------------|------------------------|
| MMD1F | 0x0000 - 0x0EFD |
| MMD1 | 0x1000 - 0x1836 |
| MMD3 | 0x3000 - 0x3001 |

Note

For MMD1 and MMD3, the most significant nibble of the register address is used to denote the respective MMD space. This nibble must be ignored during actual register access operation. For example, to access register 0x1836, use 0x1 as the MMD indicator and 0x0836 as the register address.

Table 8-24, Register Access Summary

| REGISTER FIELD | REGISTER ACCESS METHODS |
|-----------------------------|---|
| | Direct Access |
| 0x0 through 0x1F | Indirect Access, MMD1F = '11111' Example: to read register 0x17 in MMD1F field with no post increment Step 1) write 0x1F to register 0xD Step 2) write 0x17 to register 0xE Step 3) write 0x401F to register 0xD Step 4) read register 0xE |
| MMD1F Field 0x20 - 0xFFF | Indirect Access, MMD1F = '11111' Example: to read register 0x462 in MMD1F field with no post increment Step 1) write 0x1F to register 0xD Step 2) write 0x462 to register 0xE Step 3) write 0x401F to register 0xD Step 4) read register 0xE |
| MMD1 Field 0x0 - 0xFFF | Indirect Access, MMD1 = '00001' Example: to read register 0x7 in MMD1 field (register 0x1007) with no post increment Step 1) write 0x1 to register 0xD Step 2) write 0x7 to register 0xE Step 3) write 0x4001 to register 0xD Step 4) read register 0xE |



8.6.2 DP83TC814 Registers

DP83TC814 Registers lists the memory-mapped registers for the DP83TC814 registers. All register offset addresses not listed in DP83TC814 Registers should be considered as reserved locations and the register contents should not be modified.

| | Table 8-25. DP83TC814 R | egisters |
|---------|-------------------------|------------------|
| Address | Acronym Register Name | Section |
| 0h | BMCR | Section 8.6.2.1 |
| 1h | BMSR | Section 8.6.2.2 |
| 2h | PHYIDR1 | Section 8.6.2.3 |
| 3h | PHYIDR2 | Section 8.6.2.4 |
| 10h | PHYSTS | Section 8.6.2.5 |
| 11h | PHYSCR | Section 8.6.2.6 |
| 12h | MISR1 | Section 8.6.2.7 |
| 13h | MISR2 | Section 8.6.2.8 |
| 15h | RECR | Section 8.6.2.9 |
| 16h | BISCR | Section 8.6.2.10 |
| 18h | MISR3 | Section 8.6.2.11 |
| 19h | REG_19 | Section 8.6.2.12 |
| 1Eh | CDCR | Section 8.6.2.13 |
| 1Fh | PHYRCR | Section 8.6.2.14 |
| 41h | Register_41 | Section 8.6.2.15 |
| 133h | Register_133 | Section 8.6.2.16 |
| 18Ch | LPS_CFG3 | Section 8.6.2.17 |
| 18Eh | LPS_STATUS | Section 8.6.2.18 |
| 300h | TDR_TX_CFG | Section 8.6.2.19 |
| 301h | TAP_PROCESS_CFG | Section 8.6.2.20 |
| 302h | TDR_CFG1 | Section 8.6.2.21 |
| 303h | TDR_CFG2 | Section 8.6.2.22 |
| 304h | TDR_CFG3 | Section 8.6.2.23 |
| 305h | TDR_CFG4 | Section 8.6.2.24 |
| 306h | TDR_CFG5 | Section 8.6.2.25 |
| 310h | TDR_TC1 | Section 8.6.2.26 |
| 430h | A2D_REG_48 | Section 8.6.2.27 |
| 450h | LEDS_CFG_1 | Section 8.6.2.28 |
| 451h | LEDS_CFG_2 | Section 8.6.2.29 |
| 452h | IO_MUX_CFG_1 | Section 8.6.2.30 |
| 453h | IO_MUX_CFG_2 | Section 8.6.2.31 |
| 456h | IO_MUX_CFG | Section 8.6.2.32 |
| 457h | IO_STATUS_1 | Section 8.6.2.33 |
| 458h | IO_STATUS_2 | Section 8.6.2.34 |
| 45Dh | CHIP_SOR_1 | Section 8.6.2.35 |
| 45Fh | LED1_CLKOUT_ANA_CTRL | Section 8.6.2.36 |
| 485h | PCS_CTRL_1 | Section 8.6.2.37 |
| 486h | PCS_CTRL_2 | Section 8.6.2.38 |
| 489h | TX_INTER_CFG | Section 8.6.2.39 |
| 496h | JABBER_CFG | Section 8.6.2.40 |
| 497h | TEST_MODE_CTRL | Section 8.6.2.41 |

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Table 8-25. DP83TC814 Registers (continued)

| Address | Acronym Register Name | Section |
|---------|------------------------|------------------|
| 4A0h | RXF_CFG | Section 8.6.2.42 |
| 553h | PG_REG_4 | Section 8.6.2.43 |
| 560h | TC1_CFG_RW | Section 8.6.2.44 |
| 561h | TC1_LINK_FAIL_LOSS | Section 8.6.2.45 |
| 562h | TC1_LINK_TRAINING_TIME | Section 8.6.2.46 |
| 600h | RGMII_CTRL | Section 8.6.2.47 |
| 601h | RGMII_FIFO_STATUS | Section 8.6.2.48 |
| 602h | RGMII_CLK_SHIFT_CTRL | Section 8.6.2.49 |
| 603h | RGMII_EEE_CTRL | Section 8.6.2.50 |
| 608h | SGMII_CTRL_1 | Section 8.6.2.51 |
| 609h | SGMII_EEE_CTRL_1 | Section 8.6.2.52 |
| 60Ah | SGMII_STATUS | Section 8.6.2.53 |
| 60Bh | SGMII_EEE_CTRL_2 | Section 8.6.2.54 |
| 60Ch | SGMII_CTRL_2 | Section 8.6.2.55 |
| 60Dh | SGMII_FIFO_STATUS | Section 8.6.2.56 |
| 618h | PRBS_STATUS_1 | Section 8.6.2.57 |
| 619h | PRBS_CTRL_1 | Section 8.6.2.58 |
| 61Ah | PRBS_CTRL_2 | Section 8.6.2.59 |
| 61Bh | PRBS_CTRL_3 | Section 8.6.2.60 |
| 61Ch | PRBS_STATUS_2 | Section 8.6.2.61 |
| 61Dh | PRBS_STATUS_3 | Section 8.6.2.62 |
| 61Eh | PRBS_STATUS_4 | Section 8.6.2.63 |
| 620h | PRBS_STATUS_5 | Section 8.6.2.64 |
| 622h | PRBS_STATUS_6 | Section 8.6.2.65 |
| 623h | PRBS_STATUS_7 | Section 8.6.2.66 |
| 624h | PRBS_CTRL_4 | Section 8.6.2.67 |
| 625h | PATTERN_CTRL_1 | Section 8.6.2.68 |
| 626h | PATTERN_CTRL_2 | Section 8.6.2.69 |
| 627h | PATTERN_CTRL_3 | Section 8.6.2.70 |
| 628h | PMATCH_CTRL_1 | Section 8.6.2.71 |
| 629h | PMATCH_CTRL_2 | Section 8.6.2.72 |
| 62Ah | PMATCH_CTRL_3 | Section 8.6.2.73 |
| 639h | TX_PKT_CNT_1 | Section 8.6.2.74 |
| 63Ah | TX_PKT_CNT_2 | Section 8.6.2.75 |
| 63Bh | TX_PKT_CNT_3 | Section 8.6.2.76 |
| 63Ch | RX_PKT_CNT_1 | Section 8.6.2.77 |
| 63Dh | RX_PKT_CNT_2 | Section 8.6.2.78 |
| 63Eh | RX_PKT_CNT_3 | Section 8.6.2.79 |
| 648h | RMII_CTRL_1 | Section 8.6.2.80 |
| 649h | RMII_STATUS_1 | Section 8.6.2.81 |
| 64Ah | RMII_OVERRIDE_CTRL | Section 8.6.2.82 |
| 871h | dsp_reg_71 | Section 8.6.2.83 |
| 1000h | MMD1_PMA_CTRL_1 | Section 8.6.2.84 |
| 1001h | MMD1_PMA_STATUS_1 | Section 8.6.2.85 |
| 1007h | MMD1_PMA_STAUS_2 | Section 8.6.2.86 |

Table 8-25. DP83TC814 Registers (continued)

| Address | Acronym | Register Name | Section |
|---------|-----------------------------|---------------|------------------|
| 100Bh | MMD1_PMA_EXT_ABILITY_1 | | Section 8.6.2.87 |
| 1012h | MMD1_PMA_EXT_ABILITY_2 | | Section 8.6.2.88 |
| 1834h | MMD1_PMA_CTRL_2 | | Section 8.6.2.89 |
| 1836h | MMD1_PMA_TEST_MODE_CTR L | | Section 8.6.2.90 |
| 3000h | MMD3_PCS_CTRL_1 | | Section 8.6.2.91 |
| 3001h | MMD3_PCS_Status_1 | | Section 8.6.2.92 |

Complex bit access types are encoded to fit into small table cells. DP83TC814 Access Type Codes shows the codes that are used for access types in this section.

| Access Type | Code | Description |
|-----------------|---------|--|
| Read Type | | |
| Н | Н | Set or cleared by hardware |
| R | R | Read |
| RH | R H | Read Set or cleared by hardware |
| Write Type | | |
| W | W | Write |
| W0S | W 0S | Write 0 to set |
| W1S | W 1S | Write 1 to set |
| WSC | W | Write |
| Reset or Defaul | t Value | |
| -n | | Value after reset or the default value |

Table 8-26. DP83TC814 Access Type Codes



8.6.2.1 BMCR Register (Address = 0h) [Reset = 2100h]

BMCR is shown in BMCR Register and described in BMCR Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-16. BMCR Register | | | | | | | |
|----------------------------|---------------|----------------------|--------------------------------|------------|---------|----------|-------------|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| MII_reset | xMII Loopback | Manual_speed_ MII | Auto- Negotiation Enable | Power Down | Isolate | RESERVED | Duplex Mode |
| RH/W1S-0b | R/W-0b | R-1b | R-0b | R/W-0b | R/W-0b | R-0b | R-1b |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| RESERVED | | | | RESERVED | | | |
| R/W-0b | | | | R-0b | | | |

Table 8-27. BMCR Register Field Descriptions

| Bit | Field | Туре | Reset | Description | |
|-----|-------------------------|--------|-------|--|--|
| 15 | MII_reset | RH/W1S | Ob | MII Reset. This bit will reset the Digital blocks of the PHY and return registers 0x0-0x0F back to default values. Other register will not be affected. 0b = No reset | |
| | | | | 1b = Digital in reset and all MII regs (0x0 - 0xF) reset to default | |
| 14 | xMII Loopback | R/W | Ob | xMII Loopback: 1 = xMII Loopback enabled 0 = Normal Operation When xMII loopback mode is activated, the transmitted data presented on xMII TXD is looped back to xMII RXD internally. There is no LINK indication generated when xMII loopback is enabled. 1b = Enable Loopback from G/MII input to G/MII output | |
| 13 | Manual_speed_MII | R | 1b | Speed Selection: Always 100-Mbps Speed | |
| 12 | Auto-Negotiation Enable | R | 0b | Auto-Negotiation: Not supported on this device 0b = Disable Auto-Negotiation | |
| 11 | Power Down | R/W | Ob | Power Down: The PHY is powered down after this bit is set. Only register access is enabled during this power down condition. The power down mode can be controlled via this bit or via INT_N pin. INT_N pin needs to be configured to operate as power down control. This bit is OR-ed with the input from the INT_N pin. When the active low INT_N is asserted, this bit is set. Ob = Normal Mode 1b = IEEE Power Down | |
| 10 | Isolate | R/W | 0b | Isolate:Isolates the port from the xMII with the exception of the serie management interface 0b = Normal Mode 1b = Enable Isolate Mode | |
| 9 | RESERVED | R | 0b | Reserved | |
| 8 | Duplex Mode | R | 1b | 1 = Full Duplex 0 = Half duplex 0b = Half duplex 1b = Full Duplex | |
| 7 | RESERVED | R/W | 0b | Reserved | |
| 6-0 | RESERVED | R | 0b | Reserved | |

8.6.2.2 BMSR Register (Address = 1h) [Reset = 0061h]

BMSR is shown in BMSR Register and described in BMSR Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-17. BMSR Register | | | | | | | |
|----------------------------|----------------------------|----------------------------------|------------------------|---------------------------------|-------------|---------------|------------------------|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| 100Base-T4 | 100Base-X Full Duplex | 100Base-X Half Duplex | 10 Mbps Full Duplex | 10 Mbps Half Duplex | | RESERVED | |
| R-0b | R-0b | R-0b | R-0b | R-0b | | R-0b | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| RESERVED | MF Preamble Suppression | Auto- Negotiation Complete | Remote fault | Auto- Negotiation Ability | Link status | jabber detect | Extended Capability |
| R-0b | R-1b | R-1b | H-0b | R-0b | 0b | H-0b | R-1b |

Table 8-28. BMSR Register Field Descriptions

| Bit | Field | Туре | Reset | Description | |
|------|------------------------------|------|-------|--|--|
| 15 | 100Base-T4 | R | 0b | Always 0 - PHY not able to perform 100Base-T4 | |
| 14 | 100Base-X Full Duplex | R | ОЬ | 1 = PHY able to perform full duplex 100Base-X 0 = PHY not able to perform full duplex 100Base-X 0b = PHY not able to perform full duplex 100Base-X 1b = PHY able to perform full duplex 100Base-X | |
| 13 | 100Base-X Half Duplex | R | ОЬ | 1 = PHY able to perform half duplex 100Base-X 0 = PHY not able to perform half duplex 100Base-X 0b = PHY not able to perform half duplex 100Base-X 1b = PHY able to perform half duplex 100Base-X | |
| 12 | 10 Mbps Full Duplex | R | ОЬ | 1 = PHY able to operate at 10Mbps in full duplex 0 = PHY not able to operate at 10Mbps in full duplex 0b = PHY not able to operate at 10Mbps in full duplex 1b = PHY able to operate at 10Mbps in full duplex | |
| 11 | 10 Mbps Half Duplex | R | ОЬ | 1 = PHY able to operate at 10Mbps in half duplex 0 = PHY not able to operate at 10Mbps in half duplex 0b = PHY not able to operate at 10Mbps in half duplex 1b = PHY able to operate at 10Mbps in half duplex | |
| 10-7 | RESERVED | R | 0b | Reserved | |
| 6 | MF Preamble Suppression | R | 1b | 1 = PHY will accept management frames with preamble suppressed 0 = PHY will not accept management frames with preamble suppressed 0b = PHY will not accept management frames with preamble suppressed 1b = PHY will accept management frames with preamble suppressed | |
| 5 | Auto-Negotiation Complete | R | 1b | 1 = Auto-Negotiation process completed 0 = Auto Negotiation process not completed (either still in process, disabled or reset) 0b = Auto Negotiation process not completed (either still in process disabled or reset) 1b = Auto-Negotiation process completed | |
| 4 | Remote fault | H | ОЬ | 1 = Remote fault condition detected 0 = No remote fault condition detected 0b = No remote fault condition detected 1b = Remote fault condition detected | |
| 3 | Auto-Negotiation Ability | R | ОЬ | 1 = PHY is able to perform Auto-Negotiation 0 = PHY is not able to perform Auto-Negotiation 0b = PHY is not able to perform Auto-Negotiation 1b = PHY is able to perform Auto-Negotiation | |

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Table 8-28. BMSR Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|---------------------|------|-------|---|
| 2 | Link status | | 0b | Link Status bit 0b = Link is down 1b = Link is up |
| 1 | jabber detect | Н | 0b | 1= jabber condition detected 0 = No jabber condition detected 0b = No jabber condition detected 1b = jabber condition detected |
| 0 | Extended Capability | R | 1b | 1 = Extended register capabilities 0 = Basic register set capabilities only 0b = Basic register set capabilities only 1b = Extended register capabilities |

8.6.2.3 PHYIDR1 Register (Address = 2h) [Reset = 2000h]

PHYIDR1 is shown in PHYIDR1 Register and described in PHYIDR1 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-18. PHYIDR1 Register

Table 8-29. PHYIDR1 Register Field Descriptions

| Bit Field Type | | Туре | Reset | Description |
|----------------|---|------|---------------------|---|
| 15-0 | Organizationally Unique Identifier Bits 21:6 | R | 1000000000 0000b | Organizationally Unique Identification Number |



8.6.2.4 PHYIDR2 Register (Address = 3h) [Reset = A261h]

PHYIDR2 is shown in PHYIDR2 Register and described in PHYIDR2 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-19. PHYIDR2 Register | | | | | | | | | | |
|--|-------|--------|----|-----------------|----|---|---|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| Organizationally Unique Identifier Bits 5:0 Model Number | | | | | | | | | | |
| | | R-10 | | R-100110b | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| | Model | Number | | Revision Number | | | | | | |
| | R-10 | 0110b | | R-1b | | | | | | |
| | | | | | | | | | | |

Table 8-30. PHYIDR2 Register Field Descriptions

| ······································ | | | | | | | | | |
|--|--|------|---------|--|--|--|--|--|--|
| Bit | Field | Туре | Reset | Description | | | | | |
| 15-10 | 0 Organizationally Unique R Identifier Bits 5:0 | | 101000b | Organizationally Unique Identification Number | | | | | |
| 9-4 | Model Number | R | 100110b | Vendor Model Number: The six bits of vendor model number are mapped from bits 9 to 4 | | | | | |
| 3-0 | Revision Number | R | 1b | Device Revision Number 0b = Silicon Rev 1.0 1b = Silicon Rev 2.0 | | | | | |



8.6.2.5 PHYSTS Register (Address = 10h) [Reset = 0004h]

PHYSTS is shown in PHYSTS Register and described in PHYSTS Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-20. PHYSTS Register | | | | | | | | | | |
|------------------------------|----------|-------------------------|----------|-----------------|---------------|----------------------|-------------|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| RESERVED | RESERVED | receive_error_la tch | RESERVED | RESERVED | signal_detect | descrambler_lo ck | RESERVED | | | |
| R-0b | R-0b | H-0b | H-0b | H-0b | R/W0S-0b | R/W0S-0b | R-0b | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| mii_interrupt | RESERVED | jabber_dtct | RESERVED | loopback_status | duplex_status | RESERVED | link_status | | | |
| H-0b | R-0b | R-0b | H-0b | R-0b | R-1b | R-0b | R-0b | | | |

Table 8-31. PHYSTS Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|---------------------|-------|-------|---|
| 15 | RESERVED | R | 0b | Reserved |
| 14 | RESERVED | R | 0b | Reserved |
| 13 | receive_error_latch | Н | 0b | RxerrCnt0 since last read.clear on read |
| 12 | RESERVED | Н | 0b | Reserved |
| 11 | RESERVED | Н | 0b | Reserved |
| 10 | signal_detect | R/W0S | Ob | Channel ok latch low 0b = Channel ok had been reset 1b = Channel ok is set |
| 9 | descrambler_lock | R/W0S | Ob | Descrambler lock latch low 0b = Descrmabler had been locked 1b = Descrambler is locked |
| 8 | RESERVED | R | 0b | Reserved |
| 7 | mii_interrupt | н | 0b | Interrupts pin status, cleared on reading 0x12 1b0 = Interrupts pin not set 1b1 = Interrupt pin had been set |
| 6 | RESERVED | R | 0b | Reserved |
| 5 | jabber_dtct | R | 0b | duplicate from reg.0x1.1 |
| 4 | RESERVED | Н | 0b | Reserved |
| 3 | loopback_status | R | Ob | MII loopback status 0b = No MII loopback 1b = MII loopback |
| 2 | duplex_status | R | 1b | Duplex mode status 0b = Half duplex 1b = Full duplex |
| 1 | RESERVED | R | 0b | Reserved |
| 0 | link_status | R | Ob | duplication of reg.0x1.2 - link_status_bit 0b = Link is down 1b = Link is up |



8.6.2.6 PHYSCR Register (Address = 11h) [Reset = 010Bh]

PHYSCR is shown in PHYSCR Register and described in PHYSCR Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-21. PHYSCR Register | | | | | | | | | | |
|------------------------------|----------------------|---------------|--------|----------------------|---------------------------|---------------|--------|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| dis_clk_125 | pwr_save_mod e_en | pwr_save_mode | | sgmii_soft_rese t | use_PHYAD0_a s_Isolate | tx_fifo_depth | | | | |
| R/W-0b | R/W-0b | R/V | R/W-0b | | R/W-0b | R/W-1b | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| RESERVED | RESERVED | | | int_pol | force_interrupt | INTEN | INT_OE | | | |
| R/W-0b | R-0b | | | R/W-1b | R/W-0b | R/W-1b | R/W-1b | | | |

Table 8-32. PHYSCR Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-----------------------|-------|-------|--|
| 15 | dis_clk_125 | R/W | 0b | 1 = Disable CLK125 (Sourced by the CLK125 port) 1b = Disable CLK125 (Sourced by the CLK125 port) |
| 14 | pwr_save_mode_en | R/W | 0b | Enable power save mode config from reg |
| 13-12 | pwr_save_mode | R/W | 0b | Power Save Mode 0b = Normal mode 1b = IEEE mode: power down all digital and analog blocks, if bit [11] set to zero, PLL is also powered down 10 = Reserved 11 = Reserved |
| 11 | sgmii_soft_reset | R/WSC | 0b | Reset SGMII |
| 10 | use_PHYAD0_as_Isolate | R/W | 0b | 1- when phy_addr == 0, isolate MAC Interface 0- do not Isolate for PHYAD == 0. 0b = do not Isolate for PHYAD is 0. 1b = when phy_addr is 0, isolate MAC Interface |
| 9-8 | tx_fifo_depth | R/W | 1b | RMII TX fifo depth 0b = 4 nibbles 1b = 5 nibbles 1010b = 6 nibbles 1011b = 8 nibbles |
| 7 | RESERVED | R/W | 0b | Reserved |
| 6-4 | RESERVED | R | 0b | Reserved |
| 3 | int_pol | R/W | 1b | Interrupt Polarity 0b = Steady state (normal operation) without an interrupt is logical 0; during interrupt, pin is logical 1 1b = Steady state (normal operation) without an interrupt is logical 1; during interrupt, pin is logical 0 |
| 2 | force_interrupt | R/W | Ob | Force interrupt pin 0b = Do not force interrupt pin 1b = Force interrupt pin |
| 1 | INTEN | R/W | 1b | Enable interrupts 0b = Disable interrupts 1b = Enable interrupts |
| 0 | INT_OE | R/W | 1b | Interrupt/Power down pin configuration 0b = PIN is a power down PIN (input) 1b = PIN is an interrupt pin (output) |



8.6.2.7 MISR1 Register (Address = 12h) [Reset = 0000h]

MISR1 is shown in MISR1 Register and described in MISR1 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-22. MISR1 Register | | | | | | | | | | |
|-----------------------------|-----------------------|-------------|------------|------------|--------------------------|------------|------------|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| link_qual_int | energy_det_int | link_int | wol_int | esd_int | ms_train_done_ int | fhf_int | rhf_int | | | |
| H-0b | H-0b | H-0b | H-0b | H-0b | H-0b | H-0b | H-0b | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| link_qual_int_en | energy_det_int_ en | link_int_en | wol_int_en | esd_int_en | ms_train_done_ int_en | fhf_int_en | rhf_int_en | | | |
| R/W-0b | R/W-0b | R/W-0b | R/W-0b | R/W-0b | R/W-0b | R/W-0b | R/W-0b | | | |

| Table 8-33, MISR1 | Register Field Descriptions | |
|-------------------|------------------------------------|--|
| | | |

| Bit | Field | Туре | Reset | Description |
|-----|----------------------|------|-------|---|
| 15 | link_qual_int | н | 0b | Link quality(Not good) interrupt 0b = Link qual is Good 1b = Link qual is Not Good when link is ON. |
| 14 | energy_det_int | Н | Ob | This INT can be asserted upon Rising edge only of energy_det signal using reg0x101 bit [0] : cfg_energy_det_int_le_only. status output of energy_det_hist signal on reg0x19 bit[10]. 0b = No Change of energy detected 1b = Change of energy_detected (both rising and falling edges) |
| 13 | link_int | Н | Ob | Link status change interrupt 0b = No change of link status interrupt pending. 1b = Change of link status interrupt is pending and is cleared by the current read. |
| 12 | wol_int | H | ОЬ | Interrupt bit indicating that WOL packet is received 0b = No WoL interrupt pending. 1b = WoL packet received interrupt is pending and is cleared by the current read. |
| 11 | esd_int | Н | 0b | 1 = ESD detected interrupt is pending and is cleared by the current read. 0 = No ESD interrupt pending. |
| 10 | ms_train_done_int | Н | Ob | 1 = M/S Link Training Completed interrupt is pending and is cleared by the current read. 0 = No M/S Link Training Completed interrupt pending. |
| 9 | fhf_int | Н | Ob | 1 = False carrier counter half-full interrupt is pending and is cleared by the current read. 0 = No false carrier counter half-full interrupt pending. |
| 8 | rhf_int | Н | Ob | 1 = Receive error counter half-full interrupt is pending and is cleared by the current read. 0 = No receive error carrier counter half-full interrupt pending. |
| 7 | link_qual_int_en | R/W | 0b | Enable Interrupt on Link Quality status. |
| 6 | energy_det_int_en | R/W | 0b | Enable Interrupt on change of Energy Detect histr. Status |
| 5 | link_int_en | R/W | 0b | Enable Interrupt on change of link status |
| 4 | wol_int_en | R/W | 0b | Enable Interrupt on WoL detection |
| 3 | esd_int_en | R/W | 0b | Enable Interrupt on ESD detect event |
| 2 | ms_train_done_int_en | R/W | 0b | Enable Interrupt on M/S Link Training Completed event |
| 1 | fhf_int_en | R/W | 0b | Enable Interrupt on False Carrier Counter Register half-full event |
| 0 | rhf_int_en | R/W | 0b | Enable Interrupt on Receive Error Counter Register half-full event |



8.6.2.8 MISR2 Register (Address = 13h) [Reset = 0000h]

MISR2 is shown in MISR2 Register and described in MISR2 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-23. MISR2 Register | | | | | | | | | | |
|-----------------------------|----------------------|----------------------|-------------|----------|--------------|------------|---------------|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| under_volt_int | over_volt_int | RESERVED | RESERVED | RESERVED | sleep_int | pol_int | jabber_int | | | |
| H-0b | H-0b | H-0b | H-0b | H-0b | H-0b | H-0b | H-0b | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| under_volt_int_ en | over_volt_int_e n | page_rcvd_int_ en | Fifo_int_en | RESERVED | sleep_int_en | pol_int_en | jabber_int_en | | | |
| R/W-0b | R/W-0b | R/W-0b | R/W-0b | R/W-0b | R/W-0b | R/W-0b | R/W-0b | | | |

Table 8-34. MISR2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description | | |
|-----|-------------------|------|-------|---|--|--|
| 15 | under_volt_int | Н | Ob | 1 = Under Voltage has been detected 0 =Under Voltage has not been detected 0b = Under Voltage has not been detected 1b = Under Voltage has been detected | | |
| 14 | over_volt_int | Н | Ob | 1 = Over Voltage has been detected 0 = Over Voltage has not been detected 0b = Over Voltage has not been detected 1b = Over Voltage has been detected | | |
| 13 | RESERVED | Н | 0b | Reserved | | |
| 12 | RESERVED | Н | 0b | Reserved | | |
| 11 | RESERVED | Н | 0b | Reserved | | |
| 10 | sleep_int | Н | Ob | 1 = Sleep mode has changed 0 = Sleep mode has not changed 0b = Sleep mode has not changed 1b = Sleep mode has changed | | |
| 9 | pol_int | Н | Ob | The device has auto-polarity correction when operating in slave mode. This bit will reflect if polarity was automatically swapped or not. 0b = Data polarity has not changed 1b = Data polarity has changed | | |
| 8 | jabber_int | н | 0b | 1 = Jabber detected 0 = Jabber not detected 0b = Jabber not detected 1b = Jabber detected | | |
| 7 | under_volt_int_en | R/W | 0b | 0 = Disable interrupt 0b = Disable interrupt | | |
| 6 | over_volt_int_en | R/W | 0b | 0 = Disable interrupt 0b = Disable interrupt | | |
| 5 | page_rcvd_int_en | R/W | 0b | 1 = Enable interrupt 1b = Enable interrupt | | |
| 4 | Fifo_int_en | R/W | 0b | 1 = Enable interrupt 1b = Enable interrupt | | |
| 3 | RESERVED | R/W | 0b | Reserved | | |
| 2 | sleep_int_en | R/W | 0b | 1 = Enable interrupt 1b = Enable interrupt | | |
| 1 | pol_int_en | R/W | Ob | 1 = Enable interrupt 1b = Enable interrupt | | |





Table 8-34. MISR2 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|---------------|------|-------|-----------------------|
| 0 | jabber_int_en | R/W | 0b | 1 = Enable interrupt |
| | | | | 1b = Enable interrupt |



8.6.2.9 RECR Register (Address = 15h) [Reset = 0000h]

RECR is shown in RECR Register and described in RECR Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-24. RECR Register | | | | | | | | |
|----------------------------|----|----|----|----|----|---|---|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| rx_err_cnt | | | | | | | | |
| Ob | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| rx_err_cnt | | | | | | | | |
| Ob | | | | | | | | |
| | | | | | | | | |

Table 8-35. RECR Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|------------|------|-------|---|
| 15-0 | rx_err_cnt | | Ob | RX_ER Counter: When a valid carrier is presented (only while RX_DV is set), and there is at least one occurrence of an invalid data symbol, this 16-bit counter increments for each receive error detected. The RX_ER counter does not count in xMII loopback mode. The counter stops when it reaches its maximum count (0xFFFF). When the counter exceeds half-full (0x7FFF), an interrupt is generated. This register is cleared on read. |



8.6.2.10 BISCR Register (Address = 16h) [Reset = 0100h]

BISCR is shown in BISCR Register and described in BISCR Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-25. BISCR Register | | | | | | | |
|-----------------------------|-------------|----------------------------------|----------------|----------|---------------|----------|---|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| | | RESERVED | prbs_sync_loss | RESERVED | core_pwr_mode | | |
| | | R-0b | H-0b | R-0b | R-1b | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| RESERVED | tx_mii_lpbk | loopback_mode pcs_lpbck RESERVED | | | | RESERVED | |
| R-0b | R/W-0b | R/W-0b R/W-0b R/W-0b | | | | R/W-0b | |

Table 8-36. BISCR Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|----------------|------|-------|---|
| 15-11 | RESERVED | R | 0b | Reserved |
| 10 | prbs_sync_loss | н | Ob | Prbs lock lost latch status 0b = Prbs lock never lost 1b = Prbs lock had been lost |
| 9 | RESERVED | R | 0b | Reserved |
| 8 | core_pwr_mode | R | 1b | 1b0 = Core is in power down or sleep mode 1b1 = Core is is normal power mode 0b = Core is in power down or sleep mode 1b = Core is is normal power mode |
| 7 | RESERVED | R | 0b | Reserved |
| 6 | tx_mii_lpbk | R/W | Ob | Transmit data control during xMII Loopback 0b = Suppress data during xMII loopback 1b = Transmit data on MDI during xMII loopback |
| 5-2 | loopback_mode | R/W | Ob | Loopback Modes (Bit [1:0] should be 0) 1b = Digital Loopback 10b = Analog Loopback 100b = Reverse Loopback 1000b = External Loopback |
| 1 | pcs_lpbck | R/W | 0b | PCS loopback after PAM3 0b = Disable PCS Loopback 1b = Enable PCS Loopback |
| 0 | RESERVED | R/W | 0b | Reserved |



8.6.2.11 MISR3 Register (Address = 18h) [Reset = X]

MISR3 is shown in MISR3 Register and described in MISR3 Register Field Descriptions.

Return to the DP83TC814 Registers.

| | | F | Figure 8-26. M | IISR3 Registe | r | | |
|----------|----------------|----------|---------------------|---------------------|----------|----------|----------|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| RESERVED | no_link_int | RESERVED | POR_done_int | no_frame_int | RESERVED | RESERVED | RESERVED |
| H-0b | H-0b | H-0b | H-0b | H-0b | H-0b | H-0b | H-0b |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| RESERVED | no_link_int_en | RESERVED | POR_done_int_ en | no_frame_int_e n | RESERVED | RESERVED | RESERVED |
| R/W-X | R/W-0b | R/W-1b | R/W-0b | R/W-0b | R/W-1b | R/W-0b | R/W-1b |

Table 8-37. MISR3 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|-----------------|------|-------|---|
| 15 | RESERVED | Н | 0b | Reserved |
| 14 | no_link_int | H | 0b | 1= Link has not been observed within time programmed in 0x562 once training has started. 0= Link up is still in progress or Link has already formed 0b = Link up is still in progress or Link has already formed 1b = Link has not been observed within time programmed in 0x562 once training has started. |
| 13 | RESERVED | Н | 0b | Reserved |
| 12 | POR_done_int | H | Ob | 0b = POR not completed yet 1b = POR completed (required for re-initialization of registers when we come out of sleep) |
| 11 | no_frame_int | Н | 0b | 0b = Frame was detected 1b = No Frame detected for transmission or reception in given time |
| 10 | RESERVED | Н | 0b | Reserved |
| 9 | RESERVED | Н | 0b | Reserved |
| 8 | RESERVED | Н | 0b | Reserved |
| 7 | RESERVED | R/W | X | Reserved |
| 6 | no_link_int_en | R/W | 0b | 0b = Disable interrupt 1b = Enable interrupt |
| 5 | RESERVED | R/W | 1b | Reserved |
| 4 | POR_done_int_en | R/W | 0b | 0b = Disable interrupt 1b = Enable interrupt |
| 3 | no_frame_int_en | R/W | 0b | 0b = Disable interrupt 1b = Enable interrupt |
| 2 | RESERVED | R/W | 1b | Reserved |
| 1 | RESERVED | R/W | 0b | Reserved |
| 0 | RESERVED | R/W | 1b | Reserved |



8.6.2.12 REG_19 Register (Address = 19h) [Reset = 0800h]

REG_19 is shown in REG_19 Register and described in REG_19 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-27. REG_19 Register | | | | | | | | | |
|------------------------------|------|----------|----------|----------|-----------------------|------|-------|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
| RESE | RVED | RESERVED | RESERVED | RESERVED | dsp_energy_det ect | RESE | ERVED | | |
| R | -0b | R-0b | R-0b | R-1b | R-0b | R | -0b | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| RESERVED | | | PHY_ADDR | | | | | | |
| | R-0b | | | | R-0b | | | | |

Table 8-38. REG_19 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-------------------|------|-------|--------------------------------|
| 15-14 | RESERVED | R | 0b | Reserved |
| 13 | RESERVED | R | 0b | Reserved |
| 12 | RESERVED | R | 0b | Reserved |
| 11 | RESERVED | R | 1b | Reserved |
| 10 | dsp_energy_detect | R | 0b | DSP energy detected status |
| 9-5 | RESERVED | R | 0b | Reserved |
| 4-0 | PHY_ADDR | R | 0b | PHY address decode from straps |



8.6.2.13 CDCR Register (Address = 1Eh) [Reset = 0000h]

CDCR is shown in CDCR Register and described in CDCR Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-28. CDCR Register | | | | | | | | | |
|----------------------------|----------------------|------|------|------|------|----------|----------|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
| tdr_start | cfg_tdr_auto_ru n | | | RESE | RVED | | | | |
| RH/W1S-0b | R/W-0b | | | R-0 | Ob | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | | RESE | RVED | | | tdr_done | tdr_fail | | |
| | | R- | R-0b | | | | | | |

Table 8-39. CDCR Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|------------------|--------|-------|--|
| 15 | tdr_start | RH/W1S | 0b | clr by tdr done Start TDR manually 0b = No TDR 1b = TDR start |
| 14 | cfg_tdr_auto_run | R/W | 0b | Enable TDR auto run on link down 0b = TDR start manually 1b = TDR start automatically on link down |
| 13-2 | RESERVED | R | 0b | Reserved |
| 1 | tdr_done | R | 0b | TDR done status 0b = TDR still not done 1b = TDR done |
| 0 | tdr_fail | R | 0b | TDR fail status |

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8.6.2.14 PHYRCR Register (Address = 1Fh) [Reset = 0000h]

PHYRCR is shown in PHYRCR Register and described in PHYRCR Register Field Descriptions.

Return to the DP83TC814 Registers.

| | Figure 8-29. PHYRCR Register | | | | | | | | | |
|--------------------------|------------------------------|----------|----|----|----------|---|---|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| Software Global Reset | Digital reset | RESERVED | | | RESERVED | | | | | |
| RH/W1S-0b | RH/W1S-0b | R/W-0b | | | R/W-0b | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| Standby_mode | RESERVED | RESERVED | | | RESERVED | | | | | |
| R/W-0b | R/W-0b | R-0b | | | R/W-0b | | | | | |

Table 8-40. PHYRCR Register Field Descriptions

| Bit | Field | Туре | Reset | Description | | | | | | |
|------|-----------------------|--------|-------|---|--|--|--|--|--|--|
| 15 | Software Global Reset | RH/W1S | 0b | Hardware Reset(Reset digital + register file) | | | | | | |
| | | | | 0b = Normal Operation | | | | | | |
| | | | | 1b = Reset PHY. This bit is self cleared and has the same effect as | | | | | | |
| | | | | the RESET pin. | | | | | | |
| 14 | Digital reset | RH/W1S | 0b | Software Restart | | | | | | |
| | | | | 0b = Normal Operation | | | | | | |
| | | | | 1b = Restart PHY. This bit is self cleared and resets all PHY circuitry | | | | | | |
| | | | | except registers. | | | | | | |
| 13 | RESERVED | R/W | 0b | Reserved | | | | | | |
| 12-8 | RESERVED | R/W | 0b | Reserved | | | | | | |
| 7 | Standby_mode | R/W | 0b | Standby Mode | | | | | | |
| | | | | 0b = Normal operation | | | | | | |
| | | | | 1b = Standby mode enabled | | | | | | |
| 6 | RESERVED | R/W | 0b | Reserved | | | | | | |
| 5 | RESERVED | R | 0b | Reserved | | | | | | |
| 4-0 | RESERVED | R/W | 0b | Reserved | | | | | | |
| | | | | | | | | | | |



8.6.2.15 Register_41 Register (Address = 41h) [Reset = 88F7h]

Register_41 is shown in Register_41 Register and described in Register_41 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-30. Register_41 Register

| 15 14 13 12 11 10 9 8 | | | | | | | | | |
|------------------------|--|--|--|--|--|--|--|--|--|
| 13 14 13 12 11 10 9 0 | | | | | | | | | |
| cfg_ether_type_pattern | | | | | | | | | |
| R/W-1000100011110111b | | | | | | | | | |
| 7 6 5 4 3 2 1 0 | | | | | | | | | |
| cfg_ether_type_pattern | | | | | | | | | |
| R/W-1000100011110111b | | | | | | | | | |

Table 8-41. Register_41 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|------------------------|------|-----------------------|--|
| 15-0 | cfg_ether_type_pattern | R/W | 1000100011 110111b | Ethertype pattern to be detected when 0x40[0] is enabled |

8.6.2.16 Register_133 Register (Address = 133h) [Reset = 0000h]

Register_133 is shown in Register_133 Register and described in Register_133 Register Field Descriptions.

Return to the DP83TC814 Registers.

| | | Figu | re 8-31. Regi | ster_133 Regi | ister | | |
|----------|---------------------|----------------|---------------|---------------|------------|-----------------|-----------------|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| RESERVED | link_up_c_and_ s | link_status_pc | link_status | | RESE | RVED | |
| R-0b | R-0b | R-0b | R-0b | | R- | 0b | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| RESERVED | RESERVED | RESERVED | RESERVED | RESERVED | descr_sync | loc_rcvr_status | rem_rcvr_status |
| R-0b | R-0b | R-0b | R-0b | R-0b | R-0b | R-0b | R-0b |

| Table 8-42. Register_133 Register Field Description | S |
|---|---|
|---|---|

| Bit Field Type Reset Description | | | | | | | |
|----------------------------------|-----------------|------|-------|--|--|--|--|
| Bit | Field | Туре | Reset | Description | | | |
| 15 | RESERVED | R | 0b | Reserved | | | |
| 14 | link_up_c_and_s | R | 0b | link up for C & S | | | |
| 13 | link_status_pc | R | 0b | PHY control in SEND_DATA state | | | |
| 12 | link_status | R | 0b | link status set by link monitor | | | |
| 11-8 | RESERVED | R | 0b | Reserved | | | |
| 7 | RESERVED | R | 0b | Reserved | | | |
| 6 | RESERVED | R | 0b | Reserved | | | |
| 5 | RESERVED | R | 0b | Reserved | | | |
| 4 | RESERVED | R | 0b | Reserved | | | |
| 3 | RESERVED | R | 0b | Reserved | | | |
| 2 | descr_sync | R | Ob | Status of descrambler 0b = Scrambler Not Locked 1b = Scrambler Locked | | | |
| 1 | loc_rcvr_status | R | Ob | Local receiver status 0b = Local PHY received link invalid 1b = Local PHY received link valid | | | |
| 0 | rem_rcvr_status | R | Ob | Remote receiver status 0b = Remote PHY received link invalid 1b = Remote PHY received link valid | | | |



8.6.2.17 LPS_CFG3 Register (Address = 18Ch) [Reset = 0000h]

LPS_CFG3 is shown in LPS_CFG3 Register and described in LPS_CFG3 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-32. LPS_CFG3 Register 14 10 15 13 11 9 8 12 RESERVED cfg_lps_pwr_m ode RH/W1S-0b R-0b 2 0 7 5 4 3 1 6 cfg_lps_pwr_mode RH/W1S-0b

Table 8-43. LPS_CFG3 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|------------------|--------|-------|--------------------------|
| 15-9 | RESERVED | R | 0b | Reserved |
| 8-0 | cfg_lps_pwr_mode | RH/W1S | 0b | 1b = Normal command |
| | | | | 10000b = Standby command |

8.6.2.18 LPS_STATUS Register (Address = 18Eh) [Reset = 0000h]

LPS_STATUS is shown in LPS_STATUS Register and described in LPS_STATUS Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-33. LPS_STATUS Register | | | | | | | | |
|----------------------------------|---------------|----|----|----|----|---|---|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| | RESERVED | | | | | | | |
| | R-0b | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| RESERVED | status_lps_st | | | | | | | |
| R-0b | R-0b | | | | | | | |

Table 8-44. LPS_STATUS Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------|------|-------|--|
| 15-7 | RESERVED | R | 0b | Reserved |
| 6-0 | status_lps_st | R | Ob | LPS SM state 1b = SLEEP 10b = STANDBY 100b = NORMAL |



8.6.2.19 TDR_TX_CFG Register (Address = 300h) [Reset = 2710h]

TDR_TX_CFG is shown in TDR_TX_CFG Register and described in TDR_TX_CFG Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-34. TDR_TX_CFG Register

| | | 0 | | | | | |
|----|----|----|-----------|------------|----|---|---|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| | | | cfg_tdr_t | x_duration | | | |
| | | | R/W-10011 | 100010000b | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | cfg_tdr_t | x_duration | | | |
| | | | R/W-10011 | 100010000b | | | |
| | | | | | | | |

Table 8-45. TDR_TX_CFG Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------|------|---------------------|--|
| 15-0 | cfg_tdr_tx_duration | R/W | 1001110001 0000b | TDR transmit duration in usec, Default : 10000usec |



8.6.2.20 TAP_PROCESS_CFG Register (Address = 301h) [Reset = 1703h]

TAP_PROCESS_CFG is shown in TAP_PROCESS_CFG Register and described in TAP_PROCESS_CFG **Register Field Descriptions.**

Return to the DP83TC814 Registers.

| | Figure 8-35. TAP_PROCESS_CFG Register | | | | | | | | |
|--------------|---------------------------------------|----|----|----|--------------------|---|---|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
| | RESERVED | | | (| cfg_end_tap_index | | | | |
| | R-0b | | | | R/W-10111b | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | RESERVED | | | С | fg_start_tap_index | (| | | |
| R-0b R/W-11b | | | | | | | | | |

Table 8-46. TAP_PROCESS_CFG Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|---------------------|------|--------|--|
| 15-13 | RESERVED | R | 0b | Reserved |
| 12-8 | cfg_end_tap_index | R/W | 10111b | End echo coefficient index for peak detect sweep during TDR |
| 7-5 | RESERVED | R | 0b | Reserved |
| 4-0 | cfg_start_tap_index | R/W | 11b | Starting echo coefficient index for peak detect sweep during TDR |



8.6.2.21 TDR_CFG1 Register (Address = 302h) [Reset = 0045h]

TDR_CFG1 is shown in TDR_CFG1 Register and described in TDR_CFG1 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-36. TDR_CFG1 Register | | | | | | | | |
|--------------------------------|------------|----------|----|------------|-------------|------------|------------|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| RESERVED | | | | | | | | |
| | | | R | -0b | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | cfg_forwar | d_shadow | | cfg_post_s | ilence_time | cfg_pre_si | lence_time | |
| | R/W- | 100b | | R/V | V-1b | R/W | V-1b | |
| | | | | | | | | |

Table 8-47. TDR_CFG1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------------|------|-------|---|
| 15-8 | RESERVED | R | 0b | Reserved |
| 7-4 | cfg_forward_shadow | R/W | 100b | Num of neighboring echo coeff taps to be considered for calculating local maximum |
| 3-2 | cfg_post_silence_time | R/W | 1b | Post-Silence state timer in ms 0x00 : 0ms 0x01 : 10ms 0x10 : 100ms 0x11 : 1000ms |
| 1-0 | cfg_pre_silence_time | R/W | 1b | Pre-Silence state timer in ms 0x00 : 0ms 0x01 : 10ms 0x10 : 100ms 0x11 : 1000ms |



8.6.2.22 TDR_CFG2 Register (Address = 303h) [Reset = 0419h]

TDR_CFG2 is shown in TDR_CFG2 Register and described in TDR_CFG2 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-37. TDR_CFG2 Register | | | | | | | | |
|--------------------------------|---------------|----|----------|------------|-----------------------|----|---|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| | RESERVED | | | c | fg_tdr_filt_loc_offse | et | | |
| | R-0b R/W-100b | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | | | cfg_tdr_ | _filt_init | | | | |
| | R/W-11001b | | | | | | | |
| | | | | | | | | |

Table 8-48. TDR_CFG2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-------------------------|------|--------|--|
| 15-13 | RESERVED | R | 0b | Reserved |
| 12-8 | cfg_tdr_filt_loc_offset | R/W | 100b | tap index offset of dyamic peak equation, cfg_start_tap_index + 1'b1 |
| 7-0 | cfg_tdr_filt_init | R/W | 11001b | Value of peak_th at x=start_tap_index of dynamic peak threshold equation |



8.6.2.23 TDR_CFG3 Register (Address = 304h) [Reset = 0030h]

TDR_CFG3 is shown in TDR_CFG3 Register and described in TDR_CFG3 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-38. TDR_CFG3 Register 15 14 13 10 8 12 9 11 RESERVED R-0b 3 0 7 6 5 4 2 1 cfg_tdr_filt_slope R/W-110000b

Table 8-49. TDR_CFG3 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|--------------------|------|---------|--|
| 15-8 | RESERVED | R | 0b | Reserved |
| 7-0 | cfg_tdr_filt_slope | R/W | 110000b | Slope of dynamic peak threshold equation (0.4) |



8.6.2.24 TDR_CFG4 Register (Address = 305h) [Reset = 0004h]

TDR_CFG4 is shown in TDR_CFG4 Register and described in TDR_CFG4 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-39. TDR_CFG4 Register 14 13 10 9 8 15 12 11 RESERVED RESERVED RESERVED R-0b R/W-0b R/W-0b 7 6 5 4 3 2 1 0 RESERVED RESERVED hpf_gain_tdr pga_gain_tdr R/W-0b R/W-0b R/W-0b R/W-100b

Table 8-50. TDR_CFG4 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|--------------|------|-------------|--------------------------|
| 15-10 | RESERVED | R | 0b | Reserved |
| 9 | RESERVED | R/W | 0b | Reserved |
| 8-7 | RESERVED | R/W | 0b | Reserved |
| 6 | RESERVED | R/W | 0b Reserved | |
| 5-4 | hpf_gain_tdr | R/W | 0b | HPF gain code during TDR |
| 3-0 | pga_gain_tdr | R/W | 100b | PGA gain code during TDR |



8.6.2.25 TDR_CFG5 Register (Address = 306h) [Reset = 000Ah]

TDR_CFG5 is shown in TDR_CFG5 Register and described in TDR_CFG5 Register Field Descriptions.

Return to the DP83TC814 Registers.

| | | Fiç | gure 8-40. TDR_ | CFG5 Regis | ster | | | | |
|----------|----------|-----|--------------------------|---------------------|------|---|---|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
| RESERVED | | | | | | | | | |
| | R-0b | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | RESERVED | | cfg_half_open_ det_en | cfg_cable_delay_num | | | | | |
| | R-0b | | R/W-0b | R/W-1010b | | | | | |

Table 8-51. TDR_CFG5 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------------|------|-------|--|
| 15-5 | RESERVED | R | 0b | Reserved |
| 4 | cfg_half_open_det_en | R/W | 0b | enables detection of half cable 0b = Disables half open detection 1b = Enbales half open detection |
| 3-0 | cfg_cable_delay_num | R/W | 1010b | Configure the propagation delay per meter of the cable in nanoseconds. This is used for the fault location estimation Valid values : 4 'd0 to 4 'd11 - [4.5:0.1:5.6]ns Default : 4 'd10 (5.5 ns) |

8.6.2.26 TDR_TC1 Register (Address = 310h) [Reset = 0000h]

TDR_TC1 is shown in TDR_TC1 Register and described in TDR_TC1 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-41. TDR_TC1 Register 14 10 15 13 12 11 9 8 RESERVED half_open_dete ct R-0b R-0b 2 0 7 5 4 3 1 6 peak_detect peak_sign peak_loc_in_meters R-0b R-0b R-0b

Table 8-52. TDR_TC1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|--------------------|------|-------|--|
| 15-9 | RESERVED | R | 0b | Reserved |
| 8 | half_open_detect | R | Ob | Half wire open detect value 0b = Half wire open not detected 1b = Half wire open detected |
| 7 | peak_detect | R | Ob | Set if fault is detected in cable 0b = Fault not detected in cable 1b = Fault detected in cable |
| 6 | peak_sign | R | Ob | Nature of discontinuity. Valid only if peak_detect is set 0b = Short to GND, supply, or between MDI pins 1b = Open. Applicable to both 1-wire and 2-wire open faults |
| 5-0 | peak_loc_in_meters | R | 0b | Fault location in meters (Valid only if peak_detect is set) |



8.6.2.27 A2D_REG_48 Register (Address = 430h) [Reset = 0770h]

A2D_REG_48 is shown in A2D_REG_48 Register and described in A2D_REG_48 Register Field Descriptions.

Return to the DP83TC814 Registers.

| | | Fig | ure 8-42. A2D_ | REG_48 Reg | ister | | |
|----|----------------|---------------|----------------|------------|---------------|----------------|---|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| | RESERVED | | RESERVED | | dll_tx_delay_ | _ctrl_rgmii_sl | |
| | R-0b | | R/W-0b | | R/W- | ·111b | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | dll_rx_delay_o | ctrl_rgmii_sl | | | RESE | RVED | |
| | R/W-1 | l11b | | | R/W | /-0b | |
| | | | | | | | |

Table 8-53. A2D_REG_48 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|----------------------------|------|-------|--|
| 15-13 | RESERVED | R | 0b | Reserved |
| 12 | RESERVED | R/W | 0b | Reserved |
| 11-8 | dll_tx_delay_ctrl_rgmii_sl | R/W | 111b | controls TX DLL in RGMII mode inSteps of 312.5ps, affects the CLK_90 output. Delay = ((Bit[11:8] in decimal) + 1)*312.5 ps |
| 7-4 | dll_rx_delay_ctrl_rgmii_sl | R/W | 111b | Controls RX DLL in RGMII mode in Steps of 312.5ps, affects the CLK_90 output. Delay = ((Bit[7:4] in decimal) + 1)*312.5 ps |
| 3-0 | RESERVED | R/W | 0b | Reserved |

8.6.2.28 LEDS_CFG_1 Register (Address = 450h) [Reset = 2610h]

LEDS_CFG_1 is shown in LEDS_CFG_1 Register and described in LEDS_CFG_1 Register Field Descriptions.

Return to the DP83TC814 Registers.

| | | Figu | ure 8-43. LEDS | 6_CFG_1 Reg | ister | | | |
|--------------|----------------------------|-----------------|----------------|--------------|-------|-----|---|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| RESERVED | leds_bypass_str etching | leds_blink_rate | | led_2_option | | | | |
| R-0b | R/W-0b | R/W-10b | | R/W-110b | | | | |
| 7 | 6 | 5 | 5 4 | | 2 | 1 | 0 | |
| led_1_option | | | | led_0_option | | | | |
| | R/W-1b | | | | R/W- | -0b | | |

| Bit | Field | Туре | Reset | Description |
|-------|------------------------|------|-------|--|
| 15 | RESERVED | R | 0b | Reserved |
| 14 | leds_bypass_stretching | R/W | 0b | 0 - Noraml Operation 1 - Bypass LEDs stretching 0b = Noraml Operation 1b = Bypass LEDs stretching |
| 13-12 | leds_blink_rate | R/W | 10b | 0b = 20Hz (50mSec) 1b = 10Hz (100mSec) 1010b = 5Hz (200mSec) 1011b = 2Hz (500mSec) |
| 11-8 | led_2_option | R/W | 110b | Controlls LED_2 sources (same as bits 3:0) |
| 7-4 | led_1_option | R/W | 1b | Controlls LED_1 sources (same as bits 3:0) |
| 3-0 | led_0_option | R/W | Ob | Controlls LED_0 source: 0b = link OK 1b = link OK + blink on TX/RX activity 10b = link OK + blink on TX activity 11b = link OK + blink on RX activity 100b = link OK + 100Base-T1 Master 101b = link OK + 100Base-T1 Slave 110b = TX/RX activity with stretch option 111b = Reserved 1000b = Reserved 1001b = Link lost (remains on until register 0x1 is read) 1010b = PRBS error (toggles on error) 1011b = XMII TX/RX Error with stretch option |



8.6.2.29 LEDS_CFG_2 Register (Address = 451h) [Reset = 0049h]

LEDS_CFG_2 is shown in LEDS_CFG_2 Register and described in LEDS_CFG_2 Register Field Descriptions.

Return to the DP83TC814 Registers.

| | Figure 8-44. LEDS_CFG_2 Register | | | | | | | |
|-----------------------|----------------------------------|-----------------------|---------------|----------------|--------------|---------------|----------------|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| clk_o_gpio_ctrl_ 3 | led_1_gpio_ctrl _3 | led_0_gpio_ctrl _3 | | RESE | RVED | | led_2_drv_en | |
| R/W-0b | R/W-0b | R/W-0b | R-0b R/ | | | | R/W-0b | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| led_2_drv_val | led_2_polarity | led_1_drv_en | led_1_drv_val | led_1_polarity | led_0_drv_en | led_0_drv_val | led_0_polarity | |
| R/W-0b | R/W-1b | R/W-0b | R/W-0b | R/W-1b | R/W-0b | R/W-0b | R/W-1b | |

Table 8-55. LEDS_CFG_2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|-------------------|------|-------|--|
| 15 | clk_o_gpio_ctrl_3 | R/W | Ob | MSB of CLKOUT gpio control. This bit provides additional options for configuring CLKOUT If set to 1, it changes the effect ofclk_o_gpio_ctrl bits of 0x453 Reg 0x453[2:0] will control CLKOUT as follows 0b = pwr_seq_done 1b = loc_wake_req from analog 10b = loc_wake_req to PHY control 11b = tx_lps_done 100b = tx_lps_done 100b = tx_lps_done_64 101b = tx_lps 110b = pcs rx sm - receiving 111b = pcs tx sm - tx_onable |
| 14 | led_1_gpio_ctrl_3 | R/W | Ob | 111b = pcs tx sm - tx_enable MSB of LED_1 gpio control. This bit provides additional options for configuring LED_0 If set to 1, it changes the effect of led_1_gpio_ctrl bits of 0x452 Reg 0x452[10:8] will control LED_1 as follows 0b = pwr_seq_done 1b = loc_wake_req from analog 10b = loc_wake_req to PHY control 11b = tx_lps_done 100b = tx_lps_done_64 101b = tx_lps 110b = pcs rx sm - receiving 111b = pcs tx sm - tx_enable |
| 13 | led_0_gpio_ctrl_3 | R/W | 0b | MSB of LED_0 gpio control. This bit provides additional options for configuring LED_0 If set to 1, it changes the effect of led_0_gpio_ctrl bits of 0x452 Reg 0x452[2:0] will control LED_0 as follows 0b = pwr_seq_done 1b = loc_wake_req from analog 10b = loc_wake_req to PHY control 11b = tx_lps_done 100b = tx_lps_done_64 101b = tx_lps |
| | | | | 110b = pcs rx sm - receiving 111b = pcs tx sm - tx_enable |



Table 8-55. LEDS_CFG_2 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|----------------|------|-------|---|
| 8 | led_2_drv_en | R/W | 0b | 0 - LED_2 is in normal operation mode 1 - Drive the value of LED_2 (driven value is bit 9) 0b = LED_2 is in normal operation mode 1b = Drive the value of LED_2 (driven value is bit 9) |
| 7 | led_2_drv_val | R/W | 0b | If bit #8 is set, this is the value of LED_2 |
| 6 | led_2_polarity | R/W | 1b | LED_2 polarity 0b = Active low 1b = Active high |
| 5 | led_1_drv_en | R/W | Ob | 0 - LED_1 is in normal operation mode 1 - Drive the value of LED_1 (driven value is bit #5) 0b = LED_1 is in normal operation mode 1b = Drive the value of LED_1 (driven value is bit #5) |
| 4 | led_1_drv_val | R/W | 0b | If bit #4 is set, this is the value of LED_1 |
| 3 | led_1_polarity | R/W | 1b | LED_1 polarity: if(RX_D3_strap == 1) reset_val = ~CLKOUT_strap else reset_val = ~LED_1_strap 0b = Active low 1b = Active high |
| 2 | led_0_drv_en | R/W | Ob | 0 - LED_0 is in normal operation mode 1 - Drive the value of LED_0 (driven value is bit #1) |
| 1 | led_0_drv_val | R/W | 0b | If bit #1 is set, this is the value of LED_1 |
| 0 | led_0_polarity | R/W | 1b | LED_0 polarity: reset_val = ~LED_0_strap 0b = Active low 1b = Active high |



8.6.2.30 IO_MUX_CFG_1 Register (Address = 452h) [Reset = 0000h]

IO_MUX_CFG_1 is shown in IO_MUX_CFG_1 Register and described in IO_MUX_CFG_1 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-45. IO_MUX_CFG_1 Register

| | | U | | \ | | | |
|------------------------|-----------------------|------------------|----|----------------------|-----------------|-----------------|---|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| led_1_clk_div_2 _en | | led_1_clk_source | | led_1_clk_inv_e n | | led_1_gpio_ctrl | |
| R/W-0b | | R/W-0b | | R/W-0b | | R/W-0b | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| led_0_clk_div_2 _en | iv_2 led_0_clk_source | | | led_0_clk_inv_e n | led_0_gpio_ctrl | | |
| R/W-0b | | R/W-0b | | R/W-0b | | R/W-0b | |

Table 8-56. IO_MUX_CFG_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|--------------------|------|-------|--|
| 15 | led_1_clk_div_2_en | R/W | Ob | If led_1_gpio is configured to led_1_clk_source, Selects divide by 2 of clock at led_1_clk_source |
| 14-12 | led_1_clk_source | R/W | Ob | In case clk_out is MUXed to LED_1 IO, this field controls clk_out source: 000b - XI clock 001b - 200M pll clock 010b - 67 MHz ADC clock (recovered) 011b - Free 200MHz clock 100b - 25M MII clock derived from 200M LD clock 101b - 25MHz clock to PLL (XI or XI/2) or POR clock 110b - Core 100 MHz clock 111b - 67 MHz DSP clock (recovered, 1/3 duty cycle) |
| 11 | led_1_clk_inv_en | R/W | 0b | If led_1_gpio is configured to led_1_clk_source, Selects inversion of clock at led_1_clk_source |
| 10-8 | led_1_gpio_ctrl | R/W | Ob | controls the output of LED_1 IO: 000b - LED_1 (default: LINK + ACT) 001b - LED_1 Clock mux out 010b - WoL 011b - Under-Voltage indication 100b - 1588 TX 101b - 1588 RX 110b - ESD 111b - interrupt if(RX_D3_strap ==1) reset_val = 3'b001 else reset_val = 3'b000 |
| 7 | led_0_clk_div_2_en | R/W | 0b | If led_0_gpio is configured to led_0_clk_source, Selects divide by 2 of clock at led_0_clk_source |
| 6-4 | led_0_clk_source | R/W | Ob | In case clk_out is MUXed to LED_0 IO, this field controls clk_out source: 0b = XI clock 1b = 200M pll clock 10b = 67 MHz ADC clock (recovered) 11b = Free 200MHz clock 100b = 25M MII clock derived from 200M LD clock 101b = 25MHz clock to PLL (XI or XI/2) or POR clock 110b = Core 100 MHz clock 110b = Core 100 MHz clock 111b = 67 MHz DSP clock (recovered, 1/3 duty cycle) |



Table 8-56. IO_MUX_CFG_1 Register Field Descriptions (continued)

| Bit | Field | Туре | Reset | Description |
|-----|------------------|------|-------|---|
| 3 | led_0_clk_inv_en | R/W | 0b | If led_0_gpio is configured to led_0_clk_source, Selects inversion of clock at led_0_clk_source |
| 2-0 | led_0_gpio_ctrl | R/W | | controls the output of LED_0 IO: 0b = LED_0 (default: LINK) 001b =LED_0 Clock mux out 010b = WoL 011b = Under-Voltage indication 100b = 1588 TX 101b = 1588 RX 110b = ESD 111b = interrupt |



8.6.2.31 IO_MUX_CFG_2 Register (Address = 453h) [Reset = 0001h]

IO_MUX_CFG_2 is shown in IO_MUX_CFG_2 Register and described in IO_MUX_CFG_2 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-46. IO_MUX_CFG_2 Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
|-----------------------|-----------|----------|------|----------------------|----|-----------------|------------------------|
| cfg_tx_er_on_le d1 | | | RESE | RVED | | | clk_o_clk_div_2 _en |
| R/W-0b | | | R- | 0b | | | R/W-0b |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | clk_o_clk | <_source | | clk_o_clk_inv_e n | | clk_o_gpio_ctrl | |
| | R/W | /-0b | | R/W-0b | | R/W-1b | |

Table 8-57. IO_MUX_CFG_2 Register Field Descriptions

| Bit | Field | Туре | Reset | _2 Register Field Descriptions Description |
|------|--------------------|------|-------|--|
| 15 | cfg_tx_er_on_led1 | R/W | Ob | configures led_1 pin to tx_er pin and LED_1 pin is made input |
| 14-9 | RESERVED | R | 0b | Reserved |
| 8 | clk_o_clk_div_2_en | R/W | 0b | If clk_out is configured to output clk_o_clk_source, Selects divide by 2 of clock at clk_o_clk_source |
| 7-4 | clk_o_clk_source | R/W | Ob | In case clk_out is MUXed to CLK_O IO, this field controls clk_out source: 0000b - XI clock 0001b - 200M pll clock 0010b - 67 MHz ADC clock (recovered) 0011b - Free 200MHz clock 0100b - 25M MII clock derived from 200M LD clock 0101b - 25MHz clock to PLL (XI or XI/2) or POR clock 0110b - Core 100 MHz clock 0110b - Core 100 MHz clock 0111b - 67 MHz DSP clock (recovered, 1/3 duty cycle) 1000b - CLK25_50 (50 MHz in RMII, 25 MHz in others) 1001b - 50M RMII RX clk 1010b - SGMII serlz clk 1011b - SGMII deserlz clk 1100b - 30ns tick 1101b - 40ns tick 1110b - DLL TX CLK |
| 3 | clk_o_clk_inv_en | R/W | 0b | If clk_out is configured to output clk_o_clk_source, Selects inversion of clock at clk_o_clk_source |
| 2-0 | clk_o_gpio_ctrl | R/W | 1b | controls the output of CLK_O IO: 000b - LED_1 001b - CLKOUT Clock mux out 010b - WoL 011b - Under-Voltage indication 100b - 1588 TX 101b - 1588 RX 110b - ESD 111b - interrupt Automatically gets configured to 3 'h0 if pin6(LED_1) is strapped As daisy chain CLKOUT if(RX_D3_strap ==1) reset_val = 3'b000 else reset_val = 3'b001 |

8.6.2.32 IO_MUX_CFG Register (Address = 456h) [Reset = 0000h]

IO_MUX_CFG is shown in IO_MUX_CFG Register and described in IO_MUX_CFG Register Field Descriptions.

Return to the DP83TC814 Registers.

| | | Figure | 8-47. IO_N | IUX_CFG R | egister | | | | |
|-----------|-----------------------|--------------------------------|------------|-----------------------|--------------------------------|------------|--------------|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
| rx_pins_p | upd_value | rx_pins_pupd_f orce_control | tx_pins_p | oupd_value | tx_pins_pupd_f orce_control | mac_rx_imp | pedance_ctrl | | |
| R/V | V-0b | R/W-0b | R/V | V-0b | R/W-0b | R/V | V-0b | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| ma | mac_rx_impedance_ctrl | | | mac_tx_impedance_ctrl | | | | | |
| | R/W-0b | · | | | R/W-0b | | | | |

Table 8-58. IO_MUX_CFG Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|----------------------------|------|-------|--|
| - | | | | |
| 15-14 | rx_pins_pupd_value | R/W | 0b | when RX pins PUPD force control is enabled, PUPD is contolled by |
| | | | | this register |
| | | | | 0b = No pull |
| | | | | 1b = Pull up |
| | | | | 10b = Pull down |
| | | | | 11b = Reserved |
| 13 | rx_pins_pupd_force_contr | R/W | 0b | enables PUPD force control on RX MAC pins |
| | ol | | | 0b = No force control |
| | | | | 1b = enables force control |
| 12-11 | tx pins pupd value | R/W | 0b | when TX pins PUPD force control is enabled, PUPD is contolled by |
| | | | | this register |
| | | | | 0b = No pull |
| | | | | 1b = Pull up |
| | | | | 10b = Pull down |
| | | | | 11b = Reserved |
| 10 | the mine mound frame route | DAA | 0. | |
| 10 | tx_pins_pupd_force_contr | R/W | 0b | enables PUPD force control on TX MAC pins |
| | OI | | | 0b = No force control |
| | | | | 1b = enables force control |
| 9-5 | mac_rx_impedance_ctrl | R/W | 0b | RX MAC interface PAD impedance control |
| 4-0 | mac_tx_impedance_ctrl | R/W | 0b | TX MAC interface PAD impedance control |



8.6.2.33 IO_STATUS_1 Register (Address = 457h) [Reset = 0000h]

IO_STATUS_1 is shown in IO_STATUS_1 Register and described in IO_STATUS_1 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-48. IO_STATUS_1 Register | | | | | | | | | | |
|-----------------------------------|-------------|----|--------|-------|----|---|---|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| | | | io_sta | tus_1 | | | | | | |
| | R-0b | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| | io_status_1 | | | | | | | | | |
| | R-0b | | | | | | | | | |
| | | | | | | | | | | |

Table 8-59. IO_STATUS_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|--------------------|----------------------|-----------|-------------|---|
| Bit 15-0 | Field io_status_1 | Type R | Reset 0b | If IO direction is controlled via register IO_MUX_CFG & amp; amp; IO_INPUT_MODE_1, and direction is INPUT (i.e. io_oe_n_force_ctrl=1, io_input_mode[*]=1) - shows the current value of the following IOs: bit 0 - RX_D3 bit 1 - TX_CLK bit 2 - TX_EN bit 3 - TX_D0 bit 4 - TX_D1 bit 5 - TX_D2 bit 6 - TX_D3 bit 7 - INT_N |
| | | | | bit 8 - CLKOUT bit 9 - LED_0 |
| | | | | bit 10 - RX_CLK bit 11 - RX_DV bit 12 - 0 |
| | | | | bit 13 - RX_ERR bit 14 - LED_1 bit 15 - RX_D0 |



8.6.2.34 IO_STATUS_2 Register (Address = 458h) [Reset = 0000h]

IO_STATUS_2 is shown in IO_STATUS_2 Register and described in IO_STATUS_2 Register Field Descriptions.

Return to the DP83TC814 Registers.

| | Figure 8-49. IO_STATUS_2 Register | | | | | | | | | |
|-----------|-----------------------------------|----|----|----|----|----|---|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| | RESERVED | | | | | | | | | |
| | R-0b | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| | RESERVED io_status_2 | | | | | | | | | |
| R-0b R-0b | | | | | | 0b | | | | |
| | | | | | | | | | | |

Table 8-60. IO_STATUS_2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------|------|-------|---|
| 15-2 | RESERVED | R | 0b | Reserved |
| 1-0 | io_status_2 | R | | "If IO direction is controlled via register IO_MUX_CFG & IO_INPUT_MODE_2, and direction is INPUT (i.e. io_oe_n_force_ctrl=1, io_input_mode[*]=1) - shows the current value of the following IOs: bit 0 - RX_D1 bit 1 - RX_D2 " |



8.6.2.35 CHIP_SOR_1 Register (Address = 45Dh) [Reset = 0000h]

CHIP_SOR_1 is shown in CHIP_SOR_1 Register and described in CHIP_SOR_1 Register Field Descriptions. Return to the DP83TC814 Registers.

| | Figure 8-50. CHIP_SOR_1 Register | | | | | | |
|------------|----------------------------------|------------|-------------|----------|----------|------------|------------|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| RESERVED | RESERVED | LED1_POR | RX_D3_POR | RESERVED | RESERVED | LED0_STRAP | RXD3_STRAP |
| R-0b | R-0b | R-0b | R-0b | R-0b | R-0b | R-0b | R-0b |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| RXD2_STRAP | RXD1_STRAP | RXD0_STRAP | RXCLK_STRAP | RXER_ | STRAP | RXDV_ | STRAP |
| R-0b | R-0b | R-0b | R-0b | R- | 0b | R- | 0b |

Table 8-61. CHIP_SOR_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-----|-------------|------|-------|---|
| 15 | RESERVED | R | 0b | |
| 14 | RESERVED | R | 0b | Reserved |
| 13 | LED1_POR | R | 0b | LED_1 strap sampled at power up |
| 12 | RX_D3_POR | R | 0b | RX_D3 strap sampled at power up |
| 11 | RESERVED | R | 0b | Reserved |
| 10 | RESERVED | R | 0b | Reserved |
| 9 | LED0_STRAP | R | 0b | LED_0 strap sampled at power up or reset |
| 8 | RXD3_STRAP | R | 0b | RX_D3 strap sampled at reset |
| 7 | RXD2_STRAP | R | 0b | RX_D2 strap sampled at power up or reset |
| 6 | RXD1_STRAP | R | 0b | RX_D1 strap sampled at power up or reset |
| 5 | RXD0_STRAP | R | 0b | RX_D0 strap sampled at power up or reset |
| 4 | RXCLK_STRAP | R | 0b | RX_CLK strap sampled at power up or reset |
| 3-2 | RXER_STRAP | R | 0b | RX_ER strap sampled at power up or reset |
| 1-0 | RXDV_STRAP | R | 0b | RX_DV strap sampled at power up or reset |

8.6.2.36 LED1_CLKOUT_ANA_CTRL Register (Address = 45Fh) [Reset = 000Ch]

LED1_CLKOUT_ANA_CTRL is shown in LED1_CLKOUT_ANA_CTRL Register and described in LED1_CLKOUT_ANA_CTRL Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-51. LED1_CLKOUT_ANA_CTRL Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
|----------|----------|----|----------------------------|----------|-------------|------------|-----------|--|
| RESERVED | RESERVED | | RESERVED | | | | | |
| R/W-0b | R/W-0b | | R-0b | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | RESERVED | | clkout_ana_sel_ 1p0v_sl | led_1_ar | na_mux_ctrl | clkout_ana | _mux_ctrl | |
| | R-0b | | R/W-0b | R/\ | N-11b | R/W | /-0b | |

Table 8-62. LED1_CLKOUT_ANA_CTRL Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|------------------------|------|-------|---|
| 15 | RESERVED | R/W | 0b | Reserved |
| 14 | RESERVED | R/W | 0b | Reserved |
| 13-5 | RESERVED | R | 0b | Reserved |
| 4 | clkout_ana_sel_1p0v_sl | R/W | 0b | For selecting test line b/w analog test clocks |
| 3-2 | led_1_ana_mux_ctrl | R/W | 11b | Selects the signal to be sent out on LED_1 pin Automatically selects output from digital if Pin6(LED_1) is strapped As daisy chain CLKOUT if(RX_D3_strap == 1) reset_val = 2'b00 else reset_val = 2'b11 0b = Daisy chain clock 1b = TX_TCLK for test modes 10b = ANA Test clock 11b = clkout_out_1p0v_sl from digital |
| 1-0 | clkout_ana_mux_ctrl | R/W | Ob | Selects the signal to be sent out on CLKOUT pin Automatically selects output from digital if Pin6(LED_1) is strapped As daisy chain CLKOUT if(RX_D3_strap == 1) reset_val = 2'b11 else reset_val = 2'b00 0b = Daisy chain clock 1b = TX_TCLK for test modes 10b = ANA Test clock 11b = clkout_out_1p0v_sl from digital |



8.6.2.37 PCS_CTRL_1 Register (Address = 485h) [Reset = 1078h]

PCS_CTRL_1 is shown in PCS_CTRL_1 Register and described in PCS_CTRL_1 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-52. PCS_CTRL_1 Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
|----------|---------------------------------|--------------------------------|------------------|---------------|----------|---|-------------------------------|
| RESERVED | cfg_force_slave _phase1_done | cfg_dis_ipg_scr _lock_check | cfg_link_control | | RESERVED | | cfg_desc_first_l ock_count |
| R-0b | R/W-0b | R/W-0b | R/W-1b | | R-0b | | R/W-1111000b |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | cfg_desc_firs | st_lock_count | | | |
| | | | R/W-11 | 11000b | | | |
| | | | | | | | |

Table 8-63. PCS_CTRL_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------------------|------|----------|--|
| 15 | RESERVED | R | 0b | Reserved |
| 14 | cfg_force_slave_phase1_ done | R/W | 0b | Force to say phase1 of DSP slave training done |
| 13 | cfg_dis_ipg_scr_lock_che ck | R/W | 0b | Disable scrambler lock check during IPG |
| 12 | cfg_link_control | R/W | 1b | Enable for the entire training/linkup to start |
| 11-9 | RESERVED | R | 0b | Reserved |
| 8-0 | cfg_desc_first_lock_count | R/W | 1111000b | Number of idle symbols to decide on scrambler lock |

8.6.2.38 PCS_CTRL_2 Register (Address = 486h) [Reset = 0A05h]

PCS_CTRL_2 is shown in PCS_CTRL_2 Register and described in PCS_CTRL_2 Register Field Descriptions.

Return to the DP83TC814 Registers.

| | Figure 8-53. PCS_CTRL_2 Register | | | | | | | |
|-------------------------------------|----------------------------------|----|----|----|----------|---|---|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| cfg_desc_error_count | | | | | | | | |
| R/W-1010b | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| RESERVED cfg_rem_rcvr_sts_error_cnt | | | | | | | | |
| | R-0b | | | | R/W-101b | | | |
| | | | | | | | | |

Table 8-64. PCS_CTRL_2 Register Field Descriptions

| | | | | <u> </u> |
|------|--------------------------------|------|-------|---|
| Bit | Field | Туре | Reset | Description |
| 15-8 | cfg_desc_error_count | R/W | 1010b | Number of non-idle ymbols to look for to say scrambler unlocked |
| 7-5 | RESERVED | R | 0b | Reserved |
| 4-0 | cfg_rem_rcvr_sts_error_c nt | R/W | 101b | No of error symbols to rem rcvr status to go low |



8.6.2.39 TX_INTER_CFG Register (Address = 489h) [Reset = 0001h]

TX_INTER_CFG is shown in TX_INTER_CFG Register and described in TX_INTER_CFG Register Field Descriptions.

Return to the DP83TC814 Registers.

| | Figure 8-54. TX_INTER_CFG Register | | | | | | | |
|---|------------------------------------|------|----|----|--------|---------------------------|--------|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| | RESERVED | | | | | | | |
| R-0b | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| RESERVED cfg_force_tx_int erleave cfg_tx_interleav e_en cfg_interlear det_en | | | | | | cfg_interleave_ det_en | | |
| | | R-0b | | | R/W-0b | R/W-0b | R/W-1b | |

| Bit | Field | Туре | Reset | Description |
|------|-------------------------|------|-------|---|
| 15-3 | RESERVED | R | 0b | Reserved |
| 2 | cfg_force_tx_interleave | R/W | 0b | Force interleave on Tx |
| 1 | cfg_tx_interleave_en | R/W | 0b | Enable interleave on tx, if interleave detected on the Rx 0b = Interleave on Tx disabled 1b = Interleave on Tx enabled if interleave detected on Rx |
| 0 | cfg_interleave_det_en | R/W | 1b | Enable interleave detection 0b = Disable Interleave Detection 1b = Enable Interleave Detection |

Table 8-65. TX_INTER_CFG Register Field Descriptions



8.6.2.40 JABBER_CFG Register (Address = 496h) [Reset = 044Ch]

JABBER_CFG is shown in JABBER_CFG Register and described in JABBER_CFG Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-55. JABBER_CFG Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
|----|-----------------------|----------|----|--------------------------------|-----------------|---|---|
| | | RESERVED | C | ^f g_rcv_jab_timer_v | /al | | |
| | | R-0b | | I | R/W-10001001100 | b | |
| 7 | 6 5 4 3 | | | | 2 | 1 | 0 |
| | cfg_rcv_jab_timer_val | | | | | | |
| | R/W-10001001100b | | | | | | |

Table 8-66. JABBER_CFG Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-----------------------|------|------------------|------------------------------|
| 15-11 | RESERVED | R | 0b | Reserved |
| 10-0 | cfg_rcv_jab_timer_val | R/W | 1000100110 0b | Jabber timeout count in usec |



8.6.2.41 TEST_MODE_CTRL Register (Address = 497h) [Reset = 01C0h]

TEST_MODE_CTRL is shown in TEST_MODE_CTRL Register and described in TEST_MODE_CTRL Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-56. TEST_MODE_CTRL Register | | | | | | | | | |
|--------------------------------------|---------------|---------------|------|----|------|---------------|---------------|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
| | | RESE | RVED | | | cfg_test_mode | e1_symbol_cnt | | |
| | | R- | 0b | | | R/W-1 | 1100b | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | cfg_test_mode | e1_symbol_cnt | | | RESE | RVED | | | |
| | R/W-1 | 1100b | · | | R-0 |)b | | | |

Table 8-67. TEST_MODE_CTRL Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-------------------------------|------|-------|---|
| 15-10 | RESERVED | R | 0b | Reserved |
| 9-4 | cfg_test_mode1_symbol_c nt | R/W | | number of +1/-1 symbols to send in test_mode_1 N= 2 + 2* CFG_TEST_MODE1_SYMBOL_CNT |
| 3-0 | RESERVED | R | 0b | Reserved |

8.6.2.42 RXF_CFG Register (Address = 4A0h) [Reset = 1000h]

RXF_CFG is shown in RXF_CFG Register and described in RXF_CFG Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-57. RXF_CFG Register | | | | | | | | |
|-------------------------------|----------|----------|----------|----------|----------|----------|----------|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| bits_nibbles_swap | | sfd_byte | RESERVED | RESERVED | RESERVED | | RESERVED | |
| R/W-0b | | R/W-0b | R/W-1b | R/W-0b | R/W-0b | | R/W-0b | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| enhanced_mac _support | RESERVED | |
| R/W-0b | R/W-0b | R/W-0b | R/W-0b | R/W-0b | R/W-0b | R-0b | R/W-0b | |

Table 8-68. RXF_CFG Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|----------------------|------|-------|--|
| 15-14 | bits_nibbles_swap | R/W | 0b | Option to swap bits / nibbles inside every RX data byte 0b = regular order, no swaps - RXD[3-0] |
| | | | | 1b = swap bits order - RXD[0-3] |
| | | | | 1010b = swap nibbles order - { RXD[3-0] , RXD[7-4] } |
| | | | | 1011b = swap bits order in each nibble - { RXD[4-7] , RXD[0-3] } |
| 13 | sfd_byte | R/W | 0b | 0 - SFD is 0xD5 (i.e. RXF module searchs 0xD5) 1 - SFD is 0x5D (i.e. RXF module searchs 0x5D) |
| | | | | 0b = SFD is 0xD5 (i.e. RXF module searchs 0xD5) |
| | | | | 1b = SFD is 0x5D (i.e. RXF module searchs 0x5D) |
| 12 | RESERVED | R/W | 1b | Reserved |
| 11 | RESERVED | R/W | 0b | Reserved |
| 10-9 | RESERVED | R/W | 0b | Reserved |
| 8 | RESERVED | R/W | 0b | Reserved |
| 7 | enhanced_mac_support | R/W | 0b | Enables enhanced RX features. This bit shall be set when using wakeup abilities, CRC check or RX 1588 indication |
| 6 | RESERVED | R/W | 0b | Reserved |
| 5 | RESERVED | R/W | 0b | Reserved |
| 4 | RESERVED | R/W | 0b | Reserved |
| 3 | RESERVED | R/W | 0b | Reserved |
| 2 | RESERVED | R/W | 0b | Reserved |
| 1 | RESERVED | R | 0b | Reserved |
| 0 | RESERVED | R/W | 0b | Reserved |



8.6.2.43 PG_REG_4 Register (Address = 553h) [Reset = 0000h]

PG_REG_4 is shown in PG_REG_4 Register and described in PG_REG_4 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-58. PG_REG_4 Register | | | | | | | | |
|--------------------------------|----------|----|---------------|----|------|------|---|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| RESE | RESERVED | | force_pol_val | | RESE | RVED | | |
| R/W | R/W-0b | | R/W-0b | | R/W | /-0b | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | RESERVED | | | | | | | |
| | R/W-0b | | | | | | | |

Table 8-69. PG_REG_4 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|---------------|------|-------|--|
| 15-14 | RESERVED | R/W | 0b | Reserved |
| 13 | force_pol_en | R/W | 0b | Enable force on polarity 0b = Auto-polarity on MDI 1b = Force polarity on MDI |
| 12 | force_pol_val | R/W | 0b | Polarity force value. Only valid if bit [13] is 1. 0b = Forced Normal polarity 1b = Forced Inverted polarity |
| 11-0 | RESERVED | R/W | 0b | Reserved |



8.6.2.44 TC1_CFG_RW Register (Address = 560h) [Reset = 07E4h]

TC1_CFG_RW is shown in TC1_CFG_RW Register and described in TC1_CFG_RW Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-59. TC1_CFG_RW Register

| | | • | | | | | | |
|----|---------------------------|----------|------------------------|-------------|---------------------------|---|---|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| | RESERVED | RESERVED | cfg_link_status_metric | | cfg_link_failure_multihot | | | |
| | R-0b R/W-0b R/W-0b | | /-0b | R/W-111111b | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | cfg_link_failure_multihot | | | _timer_thrs | cfg_bad_sqi_thrs | | | |
| | R/W-111111b | R/W | /-0b | | R/W-100b | | | |
| | | | | | | | | |

Table 8-70. TC1_CFG_RW Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|---------------------------|------|---------|--|
| 15-14 | RESERVED | R | 0b | Reserved |
| 13 | RESERVED | R/W | 0b | Reserved |
| 12-11 | cfg_link_status_metric | R/W | 0Ь | selects following link up signals as defined by C&S 0b = link_up_c_and_s 1b = link_montor_status 10b = (phy_control = SEND_DATA) 11b = comm_ready from TC1 spec |
| 10-5 | cfg_link_failure_multihot | R/W | 111111Ь | each bit enables logging of link failure in the given scenario: bit[5] - SQI greater than configured thershold in register cfg_bad_sqi_thrs bit[6] - RCV_JABBER_DET5 - BAD_SSD bit[7] - LINK_FAILED bit[8] - RX_ERROR bit[9] - BAD_END bit[10] - RESERVED |
| 4-3 | cfg_comm_timer_thrs | R/W | Ob | selects the hysteresis timer value for TC1 comm ready 0b = 2ms 1b = 500us 10b = 1ms 11b = 4ms |
| 2-0 | cfg_bad_sqi_thrs | R/W | 100b | SQI threshold used to increment Link Failure Count defined by TC1. Whenever SQI becomes worse than the threshold, link failure count (Register 0x0561 bit[9:0]) as defined by TC1 is incremented |



8.6.2.45 TC1_LINK_FAIL_LOSS Register (Address = 561h) [Reset = 0000h]

TC1_LINK_FAIL_LOSS is shown in TC1_LINK_FAIL_LOSS Register and described in TC1_LINK_FAIL_LOSS Register Field Descriptions.

Return to the DP83TC814 Registers.

| | | Figure 8- | 60. TC1_LIN | <pre><_FAIL_LOSS</pre> | Register | | | |
|-----------|---------------------------|--------------------|-------------|---------------------------|----------|---|----|--|
| 15 | 14 | 14 13 12 11 10 9 8 | | | | | | |
| | link_losses link_failures | | | | | | | |
| R-0b R-0b | | | | | | | 0b | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | link_failures | | | | | | | |
| | R-0b | | | | | | | |
| | | | | | | | | |

Table 8-71. TC1_LINK_FAIL_LOSS Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|---------------|------|-------|---|
| 15-10 | link_losses | R | Ob | Number of Link Losses occurred since last power cycle (as per TC1 specification) |
| 9-0 | link_failures | R | Ob | Number of Link Failures causing NOT a link loss since last power cycle (as per TC1 specification) |



8.6.2.46 TC1_LINK_TRAINING_TIME Register (Address = 562h) [Reset = 0000h]

TC1_LINK_TRAINING_TIME is shown in TC1_LINK_TRAINING_TIME Register and described in TC1_LINK_TRAINING_TIME Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-61. TC1_LINK_TRAINING_TIME Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
|------------|----|----|-----|----------|----|---|---|
| comm_ready | | | | RESERVED | | | |
| R-0b | | | | R-0b | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | lq_ | _ltt | | | |
| | | | R- | 0b | | | |

Table 8-72. TC1_LINK_TRAINING_TIME Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|------------|------|-------|---|
| 15 | comm_ready | R | 0b | TC1 comm ready signal (Optimized link status indication for higher Layers to indicate if communication is possible via link) 0b = Communication Not Possible 1b = Communication Possible |
| 14-8 | RESERVED | R | 0b | Reserved |
| 7-0 | lq_ltt | R | 0b | Link training time of the last link training (as per TC1 specification) |



8.6.2.47 RGMII_CTRL Register (Address = 600h) [Reset = 0030h]

RGMII_CTRL is shown in RGMII_CTRL Register and described in RGMII_CTRL Register Field Descriptions.

Return to the DP83TC814 Registers.

| | | Figu | ire 8-62. RGN | III_CTRL Regi | ster | | |
|----------|-----------------------|-------------------|---------------|---------------|---------------|---------------|-------------------------|
| 15 | 14 | 4 13 12 11 10 9 8 | | | | | |
| RESERVED | | | | | | | |
| R-0b | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| RESERVED | rgmii_tx_half_full_th | | | cfg_rgmii_en | inv_rgmii_txd | inv_rgmii_rxd | sup_tx_err_fd_r gmii |
| R-0b | | R/W-11b | | | R/W-0b | R/W-0b | R/W-0b |

Table 8-73. RGMII_CTRL Register Field Descriptions

| ······································ | | | | | | |
|--|-----------------------|------|-------|---|--|--|
| Bit | Field | Туре | Reset | Description | | |
| 15-7 | RESERVED | R | 0b | Reserved | | |
| 6-4 | rgmii_tx_half_full_th | R/W | 11b | RGMII TX sync FIFO half full threshold in number if nibbles | | |
| 3 | cfg_rgmii_en | R/W | ОЬ | RGMII enable bit Default from strap if(RX_D2_strap == 1) reset_val = 1 else reset_val = 0 0b = RGMII disable 1b = RGMII enable | | |
| 2 | inv_rgmii_txd | R/W | 0b | Invert RGMII Tx wire order - full swap [3:0] [0:3] | | |
| 1 | inv_rgmii_rxd | R/W | 0b | Invert RGMII Rx wire order - full swap [3:0] [0:3] | | |
| 0 | sup_tx_err_fd_rgmii | R/W | 0b | this bit can disable the TX_ERR indication input | | |
| | | | | | | |

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8.6.2.48 RGMII_FIFO_STATUS Register (Address = 601h) [Reset = 0000h]

RGMII_FIFO_STATUS is shown in RGMII_FIFO_STATUS Register and described in RGMII_FIFO_STATUS Register Field Descriptions.

Return to the DP83TC814 Registers.

| | | Figure 8 | -63. RGMII_FI | FO_STATUS | Register | | |
|----|----------|----------|---------------|-----------|----------|------|---------------------------|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| | | | RESE | RVED | | | |
| | | | R- | 0b | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | RESERVED | | | | | | rgmii_tx_af_em pty_err |
| | | | | | | R-0b | R-0b |

Table 8-74. RGMII_FIFO_STATUS Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------------|------|-------|---------------------------|
| 15-2 | RESERVED | R | 0b | Reserved |
| 1 | rgmii_tx_af_full_err | R | 0b | RGMII Tx fifo full error |
| 0 | rgmii_tx_af_empty_err | R | 0b | RGMII Tx fifo empty error |



8.6.2.49 RGMII_CLK_SHIFT_CTRL Register (Address = 602h) [Reset = 0000h]

RGMII_CLK_SHIFT_CTRL is shown in RGMII_CLK_SHIFT_CTRL Register and described in RGMII_CLK_SHIFT_CTRL Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-64. RGMII_CLK_SHIFT_CTRL Register

| | | 0 | _ | | | | |
|----|----------|----|--------------------------------|--------------------------------|----|---|---|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| | RESERVED | | | | | | |
| | | | R-0 | 0b | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | | | cfg_rgmii_rx_clk _shift_sel | cfg_rgmii_tx_clk _shift_sel | | | |
| | | | R/W-0b | R/W-0b | | | |

Table 8-75. RGMII_CLK_SHIFT_CTRL Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------------------|------|-------|--|
| 15-2 | RESERVED | R | 0b | Reserved |
| 1 | cfg_rgmii_rx_clk_shift_sel | R/W | Ob | 0: clock and data are aligned 1: clock on PIN is delayed by 90 degrees relative to RGMII_RX data if({RX_D2_strap, RX_D1_strap} == 2'b11) reset_val = 1 else resett_val = 0 0b = clock and data are aligned 1b = clock on PIN is delayed by 90 degrees relative to RGMII_RX data |
| 0 | cfg_rgmii_tx_clk_shift_sel | R/W | 0Ь | use this mode when RGMII_TX_CLK & RGMII_TXD are aligned if({RX_D2_strap, RX_D1_strap, RX_D0_strap} == 3'b101) reset_val = 1 else if({RX_D2_strap, RX_D1_strap, RX_D0_strap} == 3'b110) reset_val = 1 else reset_val = 0 |

8.6.2.50 RGMII_EEE_CTRL Register (Address = 603h) [Reset = 0000h]

RGMII_EEE_CTRL is shown in RGMII_EEE_CTRL Register and described in RGMII_EEE_CTRL Register Field Descriptions.

Return to the DP83TC814 Registers.

| | | Figure | 8-65. RGMII_ | EEE_CTRL Re | egister | | |
|------|--------------------------------------|--------|--------------|-------------|---------|---|------|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| | RESERVED | | | | | | |
| R-0b | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | RESERVED cfg_rgmii_wake_signaling_er | | | | | | |
| | R-0b | | | | | | V-0b |

Table 8-76. RGMIL_EEE_CTRL Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------------------|------|-------|---|
| 15-2 | RESERVED | R | 0b | Reserved |
| 1-0 | cfg_rgmii_wake_signaling _en | R/W | Ob | RGMII signaling behavior during exit LPI period. Bit[1] - exhibit rx_err on rx_ctrl for lpi_exit, else rx_ctrl is zero for both lpi and exit_lpi periods. Bit[0] - exhibit zeros on rxd for lpi_exit, else rxd=IB_code Note: option 00b is not supported, non-valid coding. |



8.6.2.51 SGMII_CTRL_1 Register (Address = 608h) [Reset = 007Bh]

SGMII_CTRL_1 is shown in SGMII_CTRL_1 Register and described in SGMII_CTRL_1 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-66. SGMII_CTRL_1 Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
|-----------------------------|----------------------------|------------|--------------------------------------|----------------------------|------------|------------|----------------------|--|
| sgmii_tx_err_di s | cfg_align_idx_fo rce_en | | cfg_align_idx_value cfg_sgmii_en cfg | | | | | |
| R/W-0b | R/W-0b | | R/V | V-0b | | R/W-0b | R/W-0b | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| cfg_sgmii_tx_po l_invert | serdes_tx_ | bits_order | serdes_rx_bits_ order | cfg_sgmii_align _pkt_en | sgmii_auto | oneg_timer | sgmii_autoneg_ en | |
| R/W-0b | R/W | -11b | R/W-1b | R/W-1b | R/V | V-1b | R/W-1b | |

Table 8-77. SGMII_CTRL_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|-------------------------|------|-------|---|
| 15 | sgmii_tx_err_dis | R/W | 0b | SGMII TX err disable bit |
| 14 | cfg_align_idx_force_en | R/W | 0b | Force word boundray index selection |
| 13-10 | cfg_align_idx_value | R/W | Ob | when cfg_align_idx_force is set,This value set the iword boundray index |
| 9 | cfg_sgmii_en | R/W | 0b | SGMII enable bit Default from strap if({RX_D2_strap, RX_D1_strap, RX_D0_strap} == 3'b000) reset_val = 1 else reset_val = 0 0b = SGMII MAC i/f disabled 1b = SGMII MAC i/f enabled |
| | | | | |
| 8 | cfg_sgmii_rx_pol_invert | R/W | 0b | SGMII RX bus invert polarity |
| 7 | cfg_sgmii_tx_pol_invert | R/W | 0b | SGMII TX bus invert polarity |
| 6-5 | serdes_tx_bits_order | R/W | 11b | SERDES TX bits order (input to digital core) |
| 4 | serdes_rx_bits_order | R/W | 1b | SERDES RX bits order (output of digital core) : 0 - MSB-first (default) 1 - LSB-first (reversed order) |
| 3 | cfg_sgmii_align_pkt_en | R/W | 1b | For aligning the start of read out TX packet (towards serializer) w/ tx_even pulse. To sync with the Code_Group/OSET FSM code slots. Default is '1', when using '0' we go back to Gemini code |
| 2-1 | sgmii_autoneg_timer | R/W | 1b | Selects duration of SGMII Auto-Negotiation timer 0b = 1.6ms 1b = 2us 10b = 800us 11b = 11ms |
| 0 | sgmii_autoneg_en | R/W | 1b | sgmii auto negotiation enable 0b = SGMII autoneg disabled 1b = SGMII autoneg enabled |



8.6.2.52 SGMII_EEE_CTRL_1 Register (Address = 609h) [Reset = 0000h]

SGMII_EEE_CTRL_1 is shown in SGMII_EEE_CTRL_1 Register and described in SGMII_EEE_CTRL_1 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-67. SGMII_EEE_CTRL_1 Register

| | | 0 | | | <u> </u> | | |
|---------------------------|------|--------------------|------|--------------------|----------|-------------------|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| | cfg_ | sgmii_tx_tr_timer_ | val | | cfg_ | _sgmii_tx_tq_time | r_val |
| | | R/W-0b | | | | R/W-0b | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| cfg_sgmii_tx_tq_timer_val | | | cfg_ | sgmii_tx_ts_timer_ | val | | cfg_support_no n_eee_mac_sg mii_en |
| R/W | /-0b | | | R/W-0b | | | R/W-0b |

Table 8-78. SGMII_EEE_CTRL_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|--------------------------------------|------|-------|--|
| 15-11 | cfg_sgmii_tx_tr_timer_val | R/W | 0b | |
| 10-6 | cfg_sgmii_tx_tq_timer_val | R/W | 0b | |
| 5-1 | cfg_sgmii_tx_ts_timer_val | R/W | 0b | |
| 0 | cfg_support_non_eee_ma c_sgmii_en | R/W | 0b | special mode to support non sgmii eee mac in eee mode in the phy |



8.6.2.53 SGMII_STATUS Register (Address = 60Ah) [Reset = 0000h]

SGMII_STATUS is shown in SGMII_STATUS Register and described in SGMII_STATUS Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-68. SGMII_STATUS Register

| | | J - | | | • | | |
|----|----------|-------|-------------------------|------------------------|----------------------------|--------------|-----------------|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| | RESERVED | | sgmii_page_rec eived | link_status_100 0bx | sgmii_autoneg_ complete | cfg_align_en | cfg_sync_status |
| | R-0b | | R-0b | R-0b | R-0b | R-0b | R-0b |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | cfg_alig | n_idx | | RESERVED | | | |
| | R-0 | b | | | R- | 0b | |

Table 8-79. SGMII_STATUS Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|------------------------|------|-------|--|
| 15-13 | RESERVED | R | 0b | Reserved |
| 12 | sgmii_page_received | R | 0b | Clear on read bit. Indicates that a new auto neg page was received |
| 11 | link_status_1000bx | R | 0b | sgmii link status 0b = SGMII link is down 1b = SGMII link is up |
| 10 | sgmii_autoneg_complete | R | 0b | sgmii autoneg complete indication 0b = SGMII autoneg incomplete 1b = SGMII autoneg completed |
| 9 | cfg_align_en | R | 0b | word boundary FSM - align indication |
| 8 | cfg_sync_status | R | 0b | word boundary FSM - sync status indication |
| 7-4 | cfg_align_idx | R | 0b | word boundary index selection |
| 3-0 | RESERVED | R | 0b | Reserved |



8.6.2.54 SGMIL_EEE_CTRL_2 Register (Address = 60Bh) [Reset = 0005h]

SGMII_EEE_CTRL_2 is shown in SGMII_EEE_CTRL_2 Register and described in SGMII_EEE_CTRL_2 Register Field Descriptions.

Return to the DP83TC814 Registers.

| | Figure 8-69. SGMII_EEE_CTRL_2 Register | | | | | | | | |
|----|--|------|-------|-----|----------------|----------------|---|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
| | | | RESER | VED | | | | | |
| | R-0b | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | RESE | RVED | | | cfg_sgmii_rx_c | uiet_timer_val | | | |
| | R- | 0b | | | R/W- | 101b | | | |
| | | | | | | | | | |

Table 8-80. SGMII_EEE_CTRL_2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------------------------|------|-------|---|
| 15-4 | RESERVED | R | 0b | Reserved |
| 3-0 | cfg_sgmii_rx_quiet_timer_ val | R/W | 101b | Configures the RX Quiet Timer Value. Timer Value = (3100 + code*100)us |



8.6.2.55 SGMII_CTRL_2 Register (Address = 60Ch) [Reset = 0024h]

SGMII_CTRL_2 is shown in SGMII_CTRL_2 Register and described in SGMII_CTRL_2 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-70. SGMII_CTRL_2 Register

| | | • | | ' | | | |
|-------------------------------|-------------------------|----|-----------------|----|----|------------------------------|--------|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| | | | RESERVED | | | sgmii_cdr_lock_ force_val | |
| | | | R-0b | | | | R/W-0b |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| sgmii_cdr_lock_ force_ctrl | sgmii_mr_restar t_an | | tx_half_full_th | | | rx_half_full_th | |
| R/W-0b | RH/W1S-0b | | R/W-100b | | | R/W-100b | |

Table 8-81. SGMII_CTRL_2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------------------|--------|-------|--|
| 15-9 | RESERVED | R | 0b | Reserved |
| 8 | sgmii_cdr_lock_force_val | R/W | 0b | SGMII cdr lock force value |
| 7 | sgmii_cdr_lock_force_ctrl | R/W | 0b | SGMII cdr lock force enable |
| 6 | sgmii_mr_restart_an | RH/W1S | 0b | Restart sgmii autonegotiation |
| 5-3 | tx_half_full_th | R/W | 100b | SGMII TX sync FIFO half full threshold |
| 2-0 | rx_half_full_th | R/W | 100b | SGMII RX sync FIFO half full threshold |



8.6.2.56 SGMII_FIFO_STATUS Register (Address = 60Dh) [Reset = 0000h]

SGMII_FIFO_STATUS is shown in SGMII_FIFO_STATUS Register and described in SGMII_FIFO_STATUS Register Field Descriptions.

Return to the DP83TC814 Registers.

| | Figure 8-71. SGMII_FIFO_STATUS Register | | | | | | | |
|----|---|------|------|--------------------------|---------------------------|--------------------------|---------------------------|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| | | | RESE | RVED | | | | |
| | R-0b | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | RESE | RVED | | sgmii_rx_af_full _err | sgmii_rx_af_em pty_err | sgmii_tx_af_full _err | sgmii_tx_af_em pty_err | |
| | R- | 0b | | H-0b | H-0b | H-0b | H-0b | |

Table 8-82. SGMII_FIFO_STATUS Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------------|------|-------|--|
| 15-4 | RESERVED | R | 0b | Reserved |
| 3 | sgmii_rx_af_full_err | Н | Ob | SGMII RX fifo full error 0b = No error indication 1b = SGMII RX fifo full error has been indicated |
| 2 | sgmii_rx_af_empty_err | Н | Ob | SGMII RX fifo empty error 0b = No error indication 1b = SGMII RX fifo empty error has been indicated |
| 1 | sgmii_tx_af_full_err | Н | Ob | SGMII TX fifo full error 0b = No error indication 1b = SGMII TX fifo full error has been indicated |
| 0 | sgmii_tx_af_empty_err | Н | Ob | SGMII TX fiff empty error 0b = No error indication 1b = SGMII TX fifo empty error has been indicated |



8.6.2.57 PRBS_STATUS_1 Register (Address = 618h) [Reset = 0000h]

PRBS_STATUS_1 is shown in PRBS_STATUS_1 Register and described in PRBS_STATUS_1 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-72. PRBS_STATUS_1 Register | | | | | | | | | | | |
|-------------------------------------|-----------------|----|----|----|----|---|---|--|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
| | RESERVED | | | | | | | | | | |
| R-0b | | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | |
| | prbs_err_ov_cnt | | | | | | | | | | |
| | R-0b | | | | | | | | | | |
| | | | | | | | | | | | |

Table 8-83. PRBS_STATUS_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------|------|-------|--|
| 15-8 | RESERVED | R | 0b | Reserved |
| 7-0 | prbs_err_ov_cnt | R | 0b | Holds number of error counter overflow that received by the PRBS checker. Value in this register is locked when write is done to register 0x001B bit[0] or bit[1]. Counter stops on 0xFF. Note: when PRBS counters work in single mode, overflow counter is not active |



8.6.2.58 PRBS_CTRL_1 Register (Address = 619h) [Reset = 0574h]

PRBS_CTRL_1 is shown in PRBS_CTRL_1 Register and described in PRBS_CTRL_1 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-73. PRBS_CTRL_1 Register

| | | U | | ' | | | | |
|--|------|----------------------|------------|----------|----------------------|---|---|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| RESE | RVED | cfg_pkt_gen_64 | send_pkt | RESERVED | cfg_prbs_chk_sel | | | |
| R- | 0b | R/W-0b | RH/W1S-0b | R-0b | R/W-101b | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| RESERVED cfg_prbs_gen_sel cfg_prbs_cnt_m cfg_prbs_chk_e cfg_pl ode nable | | cfg_pkt_gen_pr bs | pkt_gen_en | | | | | |
| R-0b | | R/W-111b | | R/W-0b | R/W-1b R/W-0b R/W-0b | | | |

| Bit | Bit Field Type Reset Description | | | | | | |
|-------|----------------------------------|--------|------|---|--|--|--|
| 15-14 | RESERVED | R | 0b | Reserved | | | |
| 13 | cfg_pkt_gen_64 | R/W | Ob | 0b = Transmit 1518 byte packets in packet generation mode 1b = Transmit 64 byte packets in packet generation mode | | | |
| 12 | send_pkt | RH/W1S | Ob | Enables generating MAC packet with fix/incremental data w CRC (pkt_gen_en has to be set and cfg_pkt_gen_prbs has to be clear) Cleared automatically when pkt_done is set | | | |
| 11 | RESERVED | R | 0b | Reserved | | | |
| 10-8 | cfg_prbs_chk_sel | R/W | 101b | Reserved 000 : Checker receives from RGMII TX 001 : Checker receives from SGMII TX 010 : Checker receives from RMII RX 011 : Checker receives from RMII 101 : Checker receives from Cu RX 110 : Reserved 111 : Reserved | | | |
| 7 | RESERVED | R | 0b | Reserved | | | |
| 6-4 | cfg_prbs_gen_sel | R/W | 1116 | 000 : PRBS transmits to RGMII RX 001 : PRBS transmits to SGMII RX 010 : PRBS transmits to RMII RX 011 : PRBS transmits to MII RX 101 : PRBS transmits to Cu TX 110 : Reserved 111 : Reserved | | | |
| 3 | cfg_prbs_cnt_mode | R/W | 0b | 0b = Single mode, When one of the PRBS counters reaches max value, PRBS checker stops counting. 1b = Continuous mode, when one of the PRBS counters reaches max value, pulse is generated and counter starts counting from zero again | | | |
| 2 | cfg_prbs_chk_enable | R/W | 1b | Enable PRBS checker | | | |
| 1 | cfg_pkt_gen_prbs | R/W | Ob | If set: (1) When pkt_gen_en is set, PRBS packets are generated continuously (3) When pkt_gen_en is cleared, PRBS RX checker is still enabled If cleared: (1) When pkt_gen_en is set, non - PRBS packet is generated (3) When pkt_gen_en is cleared, PRBS RX checker is disabled as well | | | |
| 0 | pkt_gen_en | R/W | 0b | Enable/disable for prbs/packet generator 0b = Disable for prbs/packet generator 1b = Enable for prbs/packet generator | | | |



8.6.2.59 PRBS_CTRL_2 Register (Address = 61Ah) [Reset = 05DCh]

PRBS_CTRL_2 is shown in PRBS_CTRL_2 Register and described in PRBS_CTRL_2 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-74. PRBS_CTRL_2 Register

| | | 0 | | ' | | | | | | |
|------------------|----|----|----|----|----|---|---|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| cfg_pkt_len_prbs | | | | | | | | | | |
| R/W-10111011100b | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| cfg_pkt_len_prbs | | | | | | | | | | |
| R/W-10111011100b | | | | | | | | | | |
| | | | | | | | | | | |

Table 8-85. PRBS_CTRL_2 Register Field Descriptions

| Bit | | Field | Туре | Reset | Description |
|------|---|------------------|------|------------------|---|
| 15-0 |) | cfg_pkt_len_prbs | R/W | 1011101110 0b | Length (in bytes) of PRBS packets and MAC packets w CRC |



8.6.2.60 PRBS_CTRL_3 Register (Address = 61Bh) [Reset = 007Dh]

PRBS_CTRL_3 is shown in PRBS_CTRL_3 Register and described in PRBS_CTRL_3 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-75. PRBS_CTRL_3 Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
|-------------|-------------|----|----|----|----|---|---|--|--|--|--|
| RESERVED | | | | | | | | | | | |
| R-0b | | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | |
| | cfg_ipg_len | | | | | | | | | | |
| R/W-111101b | | | | | | | | | | | |

Table 8-86. PRBS_CTRL_3 Register Field Descriptions

| Bit | Field | Туре | Reset | Description | | |
|------|-------------|------|----------|---|--|--|
| 15-8 | RESERVED | R | 0b | Reserved | | |
| 7-0 | cfg_ipg_len | R/W | 1111101b | Inter-packet gap (in bytes) between packets | | |



8.6.2.61 PRBS_STATUS_2 Register (Address = 61Ch) [Reset = 0000h]

PRBS_STATUS_2 is shown in PRBS_STATUS_2 Register and described in PRBS_STATUS_2 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-76. PRBS_STATUS_2 Register | | | | | | | | | | | |
|-------------------------------------|---------------|----|----|----|----|---|---|--|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
| | prbs_byte_cnt | | | | | | | | | | |
| R-0b | | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | |
| | prbs_byte_cnt | | | | | | | | | | |
| | R-0b | | | | | | | | | | |
| | | | | | | | | | | | |

Table 8-87. PRBS_STATUS_2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------|------|-------|--|
| 15-0 | prbs_byte_cnt | R | 0b | Holds number of total bytes that received by the PRBS checker. Value in this register is locked when write is done to register 0x001B bit[0] or bit[1]. When PRBS Count Mode set to zero, count stops on 0xFFFF |



8.6.2.62 PRBS_STATUS_3 Register (Address = 61Dh) [Reset = 0000h]

PRBS_STATUS_3 is shown in PRBS_STATUS_3 Register and described in PRBS_STATUS_3 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-77. PRBS_STATUS_3 Register | | | | | | | | | | | |
|-------------------------------------|-------------------|----|----|----|----|---|---|--|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | |
| prbs_pkt_cnt_15_0 | | | | | | | | | | | |
| R-0b | | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | | |
| | prbs_pkt_cnt_15_0 | | | | | | | | | | |
| | R-0b | | | | | | | | | | |

Table 8-88. PRBS_STATUS_3 Register Field Descriptions

| В | Bit | Field | Туре | Reset | Description |
|----|-----|-------------------|------|-------|--|
| 15 | 5-0 | prbs_pkt_cnt_15_0 | R | | Bits [15:0] of number of total packets received by the PRBS checker Value in this register is locked when write is done to register 0x001B bit[15] or bit[14]. When PRBS Count Mode set to zero, count stops on 0xFFFFFFF |



8.6.2.63 PRBS_STATUS_4 Register (Address = 61Eh) [Reset = 0000h]

PRBS_STATUS_4 is shown in PRBS_STATUS_4 Register and described in PRBS_STATUS_4 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-78. PRBS_STATUS_4 Register | | | | | | | | | |
|-------------------------------------|------|----|----|----|----|---|---|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
| prbs_pkt_cnt_31_16 | | | | | | | | | |
| R-0b | | | | | | | | | |
| 7 6 5 4 3 2 1 0 | | | | | | | | | |
| prbs_pkt_cnt_31_16 | | | | | | | | | |
| | R-0b | | | | | | | | |

Table 8-89. PRBS_STATUS_4 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|--------------------|------|-------|--|
| 15-0 | prbs_pkt_cnt_31_16 | R | 0b | Bits [31:16] of number of total packets received by the PRBS checker Value in this register is locked when write is done to register 0x001B bit[15] or bit[14]. When PRBS Count Mode set to zero, count stops on 0xFFFFFFF |



8.6.2.64 PRBS_STATUS_5 Register (Address = 620h) [Reset = 0000h]

PRBS_STATUS_5 is shown in PRBS_STATUS_5 Register and described in PRBS_STATUS_5 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-79. PRBS_STATUS_5 Register | | | | | | | | | | |
|-------------------------------------|--|----|----|----|----|---|---|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| | RESERVED pkt_done pkt_gen_busy prbs_pkt_ov prbs_lock | | | | | | | | | |
| | R-0b R-0b R-0b R-0b R-0b R-0b | | | | | | | | | |
| 7 6 5 4 3 2 1 0 | | | | | | | | | | |
| prbs_err_cnt | | | | | | | | | | |
| | | | R- | 0b | | | | | | |

Table 8-90. PRBS_STATUS_5 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|--------------|--------------------------------|-------|---|
| 15-13 | RESERVED | R | 0b | Reserved |
| 12 | pkt_done | R | 0b | Set when all MAC packets w CRC are transmitted |
| 11 | pkt_gen_busy | jen_busy R 0b status of packet | | status of packet generator |
| 10 | prbs_pkt_ov | R | 0b | If set, packet counter reached overflow Overflow is cleared when PRBS counters are cleared - done by setting bit[15] of 0x001B |
| 9 | prbs_byte_ov | R | 0b | If set, bytes counter reached overflow Overflow is cleared when PRBS counters are cleared - done by setting bit[15] of 0x001B |
| 8 | prbs_lock | R | 0b | prbs lock status |
| 7-0 | prbs_err_cnt | R | 0b | Holds number of errored bytes that received by the PRBS checker Value in this register is locked when write is done to bit[0] or bit[1] When PRBS Count Mode set to zero, count stops on 0xFF Notes: Writing bit 0 generates a lock signal for the PRBS counters. Writing bit 1 generates a lock and clear signal for the PRBS counters |



8.6.2.65 PRBS_STATUS_6 Register (Address = 622h) [Reset = 0000h]

PRBS_STATUS_6 is shown in PRBS_STATUS_6 Register and described in PRBS_STATUS_6 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-80. PRBS_STATUS_6 Register | | | | | | | | | |
|-------------------------------------|------|--|--|--|--|--|--|--|--|
| 15 14 13 12 11 10 9 8 | | | | | | | | | |
| pkt_err_cnt_15_0 | | | | | | | | | |
| R-0b | | | | | | | | | |
| 7 6 5 4 3 2 1 0 | | | | | | | | | |
| pkt_err_cnt_15_0 | | | | | | | | | |
| | R-0b | | | | | | | | |

Table 8-91. PRBS_STATUS_6 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|------------------|------|-------|--|
| 15-0 | pkt_err_cnt_15_0 | R | | bits [15:0] of counter which records number or PRBS erroneous bytes received. This field gets cleared when bit[15] or bit[14] is written as 1 to register 0x001B |



8.6.2.66 PRBS_STATUS_7 Register (Address = 623h) [Reset = 0000h]

PRBS_STATUS_7 is shown in PRBS_STATUS_7 Register and described in PRBS_STATUS_7 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-81. PRBS_STATUS_7 Register | | | | | | | | | | |
|-------------------------------------|-----------------------|--|----|----|--|--|--|--|--|--|
| 15 | 15 14 13 12 11 10 9 8 | | | | | | | | | |
| pkt_err_cnt_31_16 | | | | | | | | | | |
| R-0b | | | | | | | | | | |
| 7 6 5 4 3 2 1 0 | | | | | | | | | | |
| pkt_err_cnt_31_16 | | | | | | | | | | |
| | | | R- | 0b | | | | | | |

Table 8-92. PRBS_STATUS_7 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|---|
| 15-0 | pkt_err_cnt_31_16 | R | | bits [31:16] of counter which records number or PRBS erroneous bytes received. This field gets cleared when bit[15] or bit[14] is written as 1 to register 0x001B |



8.6.2.67 PRBS_CTRL_4 Register (Address = 624h) [Reset = 5511h]

PRBS_CTRL_4 is shown in PRBS_CTRL_4 Register and described in PRBS_CTRL_4 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-82. PRBS_CTRL_4 Register | | | | | | | | | |
|-----------------------------------|-------|-----------------------|----|----|-------------|---|---|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
| cfg_pkt_data | | | | | | | | | |
| R/W-1010101b | | | | | | | | | |
| 7 | 6 | 5 4 3 2 1 0 | | | | | 0 | | |
| cfg_pkt | _mode | cfg_pattern_vld_bytes | | | cfg_pkt_cnt | | | | |
| R/W | /-0b | R/W-10b | | | R/W-1b | | | | |
| | | | | | | | | | |

Table 8-93. PRBS_CTRL_4 Register Field Descriptions

| Bit | Field | Туре | Reset | Description | | |
|------|-----------------------|------|----------|--|--|--|
| 15-8 | cfg_pkt_data | R/W | 1010101b | Fixed data to be sent in Fix data mode | | |
| 7-6 | cfg_pkt_mode | R/W | 0b | Selects the type of data sent | | |
| | | | | 0b = Incremental Data | | |
| | | | | 1b = Fixed Data | | |
| | | | | 10b = PRBS Data (Random Data) | | |
| | | | | 11b = PRBS Data (Random Data) | | |
| 5-3 | cfg_pattern_vld_bytes | R/W | 10b | Number of bytes of valid pattern in packet (Max - 6) | | |
| 2-0 | cfg_pkt_cnt | R/W | 1b | Configures the number of MAC packets to be transmitted by packet | | |
| | | | | generator | | |
| | | | | 0b = 1 packet | | |
| | | | | 1b = 10 packets | | |
| | | | | 10b = 100 packets | | |
| | | | | 11b = 1000 packets | | |
| | | | | 100b = 10000 packets | | |
| | | | | 101b = 100000 packets | | |
| | | | | 110b = 1000000 packets | | |
| | | | | 111b = Continuous packets | | |
| | | | | | | |

8.6.2.68 PATTERN_CTRL_1 Register (Address = 625h) [Reset = 0000h]

PATTERN_CTRL_1 is shown in PATTERN_CTRL_1 Register and described in PATTERN_CTRL_1 Register Field Descriptions.

Return to the DP83TC814 Registers.

| 15 14 13 12 11 10 9 8 pattern_15_0 R/W-0b 7 6 5 4 3 2 1 0 pattern_15_0 | Figure 8-83. PATTERN_CTRL_1 Register | | | | | | | | | | |
|--|--------------------------------------|-----------------------|--|--|--|--|--|--|--|--|--|
| R/W-0b 7 6 5 4 3 2 1 0 | 15 | 15 14 13 12 11 10 9 8 | | | | | | | | | |
| 7 6 5 4 3 2 1 0 | pattern_15_0 | | | | | | | | | | |
| | R/W-0b | | | | | | | | | | |
| pattern_15_0 | 7 6 5 4 3 2 1 0 | | | | | | | | | | |
| | pattern_15_0 | | | | | | | | | | |
| R/W-0b | | R/W-0b | | | | | | | | | |

Table 8-94. PATTERN_CTRL_1 Register Field Descriptions

| Bit | Field Type | | Reset | Description |
|------|--------------|-----|-------|----------------------|
| 15-0 | pattern_15_0 | R/W | 0b | Bits 15:0 of pattern |



8.6.2.69 PATTERN_CTRL_2 Register (Address = 626h) [Reset = 0000h]

PATTERN_CTRL_2 is shown in PATTERN_CTRL_2 Register and described in PATTERN_CTRL_2 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-84. PATTERN_CTRL_2 Register | | | | | | | | | | |
|--------------------------------------|-----------------------|---|---|---|---|---|---|--|--|--|
| 15 | 15 14 13 12 11 10 9 8 | | | | | | | | | |
| pattern_31_16 | | | | | | | | | | |
| R/W-0b | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| pattern_31_16 | | | | | | | | | | |
| | R/W-0b | | | | | | | | | |

Table 8-95. PATTERN_CTRL_2 Register Field Descriptions

| Bit | Bit Field | | Reset | Description |
|------|---------------|-----|-------|-----------------------|
| 15-0 | pattern_31_16 | R/W | 0b | Bits 31:16 of pattern |

8.6.2.70 PATTERN_CTRL_3 Register (Address = 627h) [Reset = 0000h]

PATTERN_CTRL_3 is shown in PATTERN_CTRL_3 Register and described in PATTERN_CTRL_3 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-85. PATTERN_CTRL_3 Register | | | | | | | | | | |
|--------------------------------------|-----------------------|---|---|---|---|---|---|--|--|--|
| 15 | 15 14 13 12 11 10 9 8 | | | | | | | | | |
| pattern_47_32 | | | | | | | | | | |
| R/W-0b | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| pattern_47_32 | | | | | | | | | | |
| | R/W-0b | | | | | | | | | |

Table 8-96. PATTERN_CTRL_3 Register Field Descriptions

| Bit | Bit Field Type | | Reset | Description |
|------|----------------|-----|-------|-----------------------|
| 15-0 | pattern_47_32 | R/W | 0b | Bits 47:32 of pattern |



8.6.2.71 PMATCH_CTRL_1 Register (Address = 628h) [Reset = 0000h]

PMATCH_CTRL_1 is shown in PMATCH_CTRL_1 Register and described in PMATCH_CTRL_1 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-86. PMATCH_CTRL_1 Register | | | | | | | | | | |
|-------------------------------------|--------|----|----|----|----|---|---|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| pmatch_data_15_0 | | | | | | | | | | |
| R/W-0b | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| pmatch_data_15_0 | | | | | | | | | | |
| | R/W-0b | | | | | | | | | |

Table 8-97. PMATCH_CTRL_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|------------------|------|-------|---|
| 15-0 | pmatch_data_15_0 | R/W | 0b | Bits 15:0 of Perfect Match Data - used for DA (destination address) match |



8.6.2.72 PMATCH_CTRL_2 Register (Address = 629h) [Reset = 0000h]

PMATCH_CTRL_2 is shown in PMATCH_CTRL_2 Register and described in PMATCH_CTRL_2 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-87. PMATCH_CTRL_2 Register | | | | | | | | | | |
|-------------------------------------|-------------------|----|----|----|----|---|---|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| pmatch_data_31_16 | | | | | | | | | | |
| R/W-0b | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| | pmatch_data_31_16 | | | | | | | | | |
| | R/W-0b | | | | | | | | | |
| | | | | | | | | | | |

Table 8-98. PMATCH_CTRL_2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|--|
| 15-0 | pmatch_data_31_16 | R/W | 0b | Bits 31:16 of Perfect Match Data - used for DA (destination address) match |



8.6.2.73 PMATCH_CTRL_3 Register (Address = 62Ah) [Reset = 0000h]

PMATCH_CTRL_3 is shown in PMATCH_CTRL_3 Register and described in PMATCH_CTRL_3 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-88. PMATCH_CTRL_3 Register | | | | | | | | | | |
|-------------------------------------|-------------------|----|----|----|----|---|---|--|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | |
| pmatch_data_47_32 | | | | | | | | | | |
| R/W-0b | | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| | pmatch_data_47_32 | | | | | | | | | |
| | R/W-0b | | | | | | | | | |
| | | | | | | | | | | |

Table 8-99. PMATCH_CTRL_3 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------------|------|-------|--|
| 15-0 | pmatch_data_47_32 | R/W | 0b | Bits 47:32 of Perfect Match Data - used for DA (destination address) match |



8.6.2.74 TX_PKT_CNT_1 Register (Address = 639h) [Reset = 0000h]

TX_PKT_CNT_1 is shown in TX_PKT_CNT_1 Register and described in TX_PKT_CNT_1 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-89. TX_PKT_CNT_1 Register | | | | | | | | | |
|------------------------------------|----|----|----|----|----|---|---|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
| tx_pkt_cnt_15_0 | | | | | | | | | |
| Ob | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| tx_pkt_cnt_15_0 | | | | | | | | | |
| | Ob | | | | | | | | |
| | | | | | | | | | |

Table 8-100. TX_PKT_CNT_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------|------|-------|---|
| 15-0 | tx_pkt_cnt_15_0 | | 0b | Lower 16 bits of Tx packet counter Note : Register is cleared when 0x60F, 0x610, 0x611 are read in sequence |



8.6.2.75 TX_PKT_CNT_2 Register (Address = 63Ah) [Reset = 0000h]

TX_PKT_CNT_2 is shown in TX_PKT_CNT_2 Register and described in TX_PKT_CNT_2 Register Field Descriptions.

Return to the DP83TC814 Registers.

| | Figure 8-90. TX_PKT_CNT_2 Register | | | | | | | | |
|----|------------------------------------|----|----------|----------|----|---|---|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
| | tx_pkt_cnt_31_16 | | | | | | | | |
| | Ob | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | | | tx_pkt_c | nt_31_16 | | | | | |
| | | | C | b | | | | | |
| | | | | | | | | | |

Table 8-101. TX_PKT_CNT_2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|------------------|------|-------|---|
| 15-0 | tx_pkt_cnt_31_16 | | 0b | Upper 16 bits of Tx packet counter Note : Register is cleared when 0x60F, 0x610, 0x611 are read in sequence |



8.6.2.76 TX_PKT_CNT_3 Register (Address = 63Bh) [Reset = 0000h]

TX_PKT_CNT_3 is shown in TX_PKT_CNT_3 Register and described in TX_PKT_CNT_3 Register Field Descriptions.

Return to the DP83TC814 Registers.

| | Figure 8-91. TX_PKT_CNT_3 Register | | | | | | | |
|----|------------------------------------|----|---------|---------|----|---|---|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| | tx_err_pkt_cnt | | | | | | | |
| | Ob | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | | | tx_err_ | pkt_cnt | | | | |
| | | | 0 | b | | | | |
| | | | | | | | | |

Table 8-102. TX_PKT_CNT_3 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------|------|-------|--|
| 15-0 | tx_err_pkt_cnt | | 0b | Tx packet w error (CRC error) counter Note : Register is cleared when 0x60F, 0x610, 0x611 are read in sequence |



8.6.2.77 RX_PKT_CNT_1 Register (Address = 63Ch) [Reset = 0000h]

RX_PKT_CNT_1 is shown in RX_PKT_CNT_1 Register and described in RX_PKT_CNT_1 Register Field Descriptions.

Return to the DP83TC814 Registers.

| | Figure 8-92. RX_PKT_CNT_1 Register | | | | | | | |
|----|------------------------------------|----|----------|----------|----|---|---|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| | rx_pkt_cnt_15_0 | | | | | | | |
| | Ob | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | | | rx_pkt_c | ont_15_0 | | | | |
| | | | 0 | b | | | | |
| | | | | | | | | |

Table 8-103. RX_PKT_CNT_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------|------|-------|---|
| 15-0 | rx_pkt_cnt_15_0 | | 0b | Lower 16 bits of Rx packet counter Note : Register is cleared when 0x612, 0x613, 0x614 are read in sequence |



8.6.2.78 RX_PKT_CNT_2 Register (Address = 63Dh) [Reset = 0000h]

RX_PKT_CNT_2 is shown in RX_PKT_CNT_2 Register and described in RX_PKT_CNT_2 Register Field Descriptions.

Return to the DP83TC814 Registers.

| | | Figure | ə 8-93. RX_PI | KT_CNT_2 Re | gister | | | | |
|----|------------------|--------|---------------|-------------|--------|---|---|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
| | rx_pkt_cnt_31_16 | | | | | | | | |
| | 0b | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | | | rx_pkt_c | nt_31_16 | | | | | |
| | Ob | | | | | | | | |
| | | | | | | | | | |

Table 8-104. RX_PKT_CNT_2 Register Field Descriptions

| B | it | Field | Туре | Reset | Description |
|----|-----|------------------|------|-------|---|
| 15 | 5-0 | rx_pkt_cnt_31_16 | | 0b | Upper 16 bits of Rx packet counter Note : Register is cleared when 0x612, 0x613, 0x614 are read in sequence |



8.6.2.79 RX_PKT_CNT_3 Register (Address = 63Eh) [Reset = 0000h]

RX_PKT_CNT_3 is shown in RX_PKT_CNT_3 Register and described in RX_PKT_CNT_3 Register Field Descriptions.

Return to the DP83TC814 Registers.

| | | Figure | e 8-94. RX_PK | T_CNT_3 Re | gister | | | | |
|----|----------------|--------|---------------|------------|--------|---|---|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
| | rx_err_pkt_cnt | | | | | | | | |
| Ob | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | | | rx_err_l | pkt_cnt | | | | | |
| | | | 01 | b | | | | | |
| | | | | | | | | | |

Table 8-105. RX_PKT_CNT_3 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|----------------|------|-------|--|
| 15-0 | rx_err_pkt_cnt | | | Rx packet w error (CRC error) counter Note : Register is cleared when 0x612, 0x613, 0x614 are read in sequence |



8.6.2.80 RMII_CTRL_1 Register (Address = 648h) [Reset = 0120h]

RMII_CTRL_1 is shown in RMII_CTRL_1 Register and described in RMII_CTRL_1 Register Field Descriptions. Return to the DP83TC814 Registers.

Figure 8-95. RMII_CTRL_1 Register 15 14 13 12 10 9 8 11 RESERVED cfg_rmii_dis_del cfg_rmii_half_full_th ayed_txd_en R/W-0b R-0b R/W-10b 2 7 3 0 6 5 4 1 cfg_rmii_half_fu cfg_rmii_mode cfg_rmii_bypass cfg_xi_50 RESERVED RESERVED cfg_rmii_rev1_0 cfg_rmii_enh ll_th afifo_en R/W-10b R/W-0b R/W-1b R/W-0b R/W-0b R/W-0b R/W-0b R/W-0b

Table 8-106. RMII_CTRL_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|---------------------------------|------|-------|---|
| 15-11 | RESERVED | R | 0b | Reserved |
| 10 | cfg_rmii_dis_delayed_txd_ en | R/W | Ob | If set, disables delay of TXD in RMII mode |
| 9-7 | cfg_rmii_half_full_th | R/W | 10b | FIFO Half Full Threshold in nibbles for the RMII Rx FIFO |
| 6 | cfg_rmii_mode | R/W | ОЬ | 1 = RMII enabled 0 = RMII disabled if({RX_D2_strap, RX_D1_strap} == 2'b01) reset_val = 1 else reset_val = 0 0b = RMII disabled 1b = RMII enabled |
| 5 | cfg_rmii_bypass_afifo_en | R/W | 1b | 1= RMII async fifo bypass enable 0= RMII async fifo not bypassed 0b = RMII async fifo not bypassed 1b = RMII async fifo bypass enable |
| 4 | cfg_xi_50 | R/W | Ob | XI sel for RMII mode if({RX_D2_strap, RX_D1_strap, RX_D0_strap} == 3'b010) reset_val = 1 else reset_val = 0 |
| 3 | RESERVED | R/W | 0b | Reserved |
| 2 | RESERVED | R/W | 0b | Reserved |
| 1 | cfg_rmii_rev1_0 | R/W | 0b | RMII Rev1.0 enable bit |
| 0 | cfg_rmii_enh | R/W | 0b | RMII enahnced mode enable bit |



8.6.2.81 RMII_STATUS_1 Register (Address = 649h) [Reset = 0000h]

RMII_STATUS_1 is shown in RMII_STATUS_1 Register and described in RMII_STATUS_1 Register Field Descriptions.

Return to the DP83TC814 Registers.

| | | Figure | e 8-96. RMII_S | STATUS_1 Reg | gister | | | |
|----------------|--|--------|----------------|--------------|--------|------|---|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| | RESERVED | | | | | | | |
| | R-0b | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | RESERVED rmii_af_unf_err rmii_af_ovf_err | | | | | | | |
| R-0b R-0b R-0b | | | | | | R-0b | | |
| | | | | | | | | |

Table 8-107. RMII_STATUS_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------|------|-------|---|
| 15-2 | RESERVED | R | 0b | Reserved |
| 1 | rmii_af_unf_err | R | 0b | Clear on read bit RMII fifo undeflow error status |
| 0 | rmii_af_ovf_err | R | 0b | Clear on Read bit RMII fifo overflow status |



8.6.2.82 RMII_OVERRIDE_CTRL Register (Address = 64Ah) [Reset = 0010h]

RMII_OVERRIDE_CTRL is shown in RMII_OVERRIDE_CTRL Register and described in RMII_OVERRIDE_CTRL Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-97. RMII_OVERRIDE_CTRL Register

| | | J · · · · | _ | _ | - J | | |
|----------|----------|-----------|------------------|---------------|----------|----------|----------|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| | | RESERVED | cfg_clk50_tx_dll | cfg_clk50_dll | RESERVED | | |
| | | R-0b | R/W-0b | R/W-0b | R/W-0b | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| RESERVED | RESERVED | RESERVED | RESERVED | RESERVED | RESERVED | RESERVED | RESERVED |
| R/W-0b | R/W-0b | R/W-0b | R/W-1b | R/W-0b | R/W-0b | R/W-0b | R/W-0b |

Table 8-108. RMII_OVERRIDE_CTRL Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|------------------|------|-------|--|
| 15-11 | RESERVED | R | 0b | Reserved |
| 10 | cfg_clk50_tx_dll | R/W | 0b | 1 = use 50M DLL clock in RMII master for TX 0 = legacy mode if({RX_D2_strap, RX_D1_strap, RX_D0_strap} == 3'b011) reset_val = 1 else reset_val = 0 0b = legacy mode 1b = use 50M DLL clock in RMII master for TX |
| 9 | cfg_clk50_dll | R/W | 0b | 1 = use 50M DLL clock in RMII slave for RX 0 = use legacy mode if({RX_D2_strap, RX_D1_strap, RX_D0_strap} == 3'b010) reset_val = 1 else reset_val = 0 0b = use legacy mode 1b = use 50M DLL clock in RMII slave for RX |
| 8 | RESERVED | R/W | 0b | Reserved |
| 7 | RESERVED | R/W | 0b | Reserved |
| 6 | RESERVED | R/W | 0b | Reserved |
| 5 | RESERVED | R/W | 0b | Reserved |
| 4 | RESERVED | R/W | 1b | Reserved |
| 3 | RESERVED | R/W | 0b | Reserved |
| 2 | RESERVED | R/W | 0b | Reserved |
| 1 | RESERVED | R/W | 0b | Reserved |
| 0 | RESERVED | R/W | 0b | Reserved |



8.6.2.83 dsp_reg_71 Register (Address = 871h) [Reset = 0000h]

dsp_reg_71 is shown in dsp_reg_71 Register and described in dsp_reg_71 Register Field Descriptions.

Return to the DP83TC814 Registers.

| 15 14 13 12 11 10 9 8 RESERVED R-0b 7 6 5 4 3 2 1 0 | Figure 8-98. dsp_reg_71 Register | | | | | | | | |
|---|----------------------------------|----------|----|---------------|----|--|--|--|--|
| R-0b | 11 10 9 | 12 | 13 | 14 | 15 | | | | |
| | RESERVED | | | | | | | | |
| 7 6 5 4 3 2 1 0 | R-0b | | | | | | | | |
| | 3 2 1 | 4 | 5 | 6 | 7 | | | | |
| worst_sqi_out RESERVED sqi_out RESER | sqi_out | RESERVED | | worst_sqi_out | | | | | |
| 0b R-0b R-0b R-0 | R-0b | R-0b | | 0b | | | | | |

Table 8-109. dsp_reg_71 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|---------------|------|-------|---------------------------------|
| 15-8 | RESERVED | R | 0b | Reserved |
| 7-5 | worst_sqi_out | | 0b | Worst SQI value since last read |
| 4 | RESERVED | R | 0b | Reserved |
| 3-1 | sqi_out | R | 0b | SQI value |
| 0 | RESERVED | R | 0b | Reserved |



8.6.2.84 MMD1_PMA_CTRL_1 Register (Address = 1000h) [Reset = 0000h]

MMD1_PMA_CTRL_1 is shown in MMD1_PMA_CTRL_1 Register and described in MMD1_PMA_CTRL_1 Register Field Descriptions.

Return to the DP83TC814 Registers.

| Figure 8-99. MMD1_PMA_CTRL_1 Register | | | | | | | | | |
|---------------------------------------|-----------------------|----------|----|----|----|---|---|--|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | |
| PMA_reset | | RESERVED | | | | | | | |
| R/W-0b | R/W-0b R-0b | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | |
| | RESERVED PMA_loopback | | | | | | | | |
| | R-0b R/W-0b | | | | | | | | |

Table 8-110. MMD1_PMA_CTRL_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description | |
|------|--------------|------|-------|--|--|
| 15 | PMA_reset | R/W | 0b | 0 = PMA not reset 1= PMA reset 0b = PMA not reset | |
| | | | | UD = PMA not reset | |
| | | | | 1b = PMA reset | |
| 14-1 | RESERVED | R | 0b | Reserved | |
| 0 | PMA_loopback | R/W | 0b | 0 = PMA loopback not set 1= PMA loopback set | |
| | | | | 0b = PMA loopback not set | |
| | | | | 1b = PMA loopback set | |



8.6.2.85 MMD1_PMA_STATUS_1 Register (Address = 1001h) [Reset = 0000h]

MMD1_PMA_STATUS_1 is shown in MMD1_PMA_STATUS_1 Register and described in MMD1_PMA_STATUS_1 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-100. MMD1_PMA_STATUS_1 Register

| | | U U | _ | | _ 0 | | |
|----|----------|-----|------|------|-----|------|------|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| | | | RESE | RVED | | | |
| | | | R- | 0b | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | RESERVED | | | | | RESE | RVED |
| | R-0b | | | | | R-(| 0b |
| | | | | | | | |

Table 8-111. MMD1_PMA_STATUS_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-------------|------|-------|---|
| 15-3 | RESERVED | R | 0b | Reserved |
| 2 | link_status | R | 0b | link status from link monitor state machine 0b = link status is down 1b = link status is up |
| 1-0 | RESERVED | R | 0b | Reserved |



8.6.2.86 MMD1_PMA_STAUS_2 Register (Address = 1007h) [Reset = 003Dh]

MMD1_PMA_STAUS_2 is shown in MMD1_PMA_STAUS_2 Register and described in MMD1_PMA_STAUS_2 **Register Field Descriptions.**

Return to the DP83TC814 Registers.

| | Figure 8-101. MMD1_PMA_STAUS_2 Register | | | | | | | | | |
|------|---|----|-----------------|---|---|---|---|--|--|--|
| 15 | 14 | 13 | 13 12 11 10 9 8 | | | | | | | |
| | RESERVED | | | | | | | | | |
| | R-0b | | | | | | | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| RESE | RESERVED PMA/PMD type selection | | | | | | | | | |
| R | R-0b R-111101b | | | | | | | | | |
| L | | | | | | | | | | |

Table 8-112. MMD1_PMA_STAUS_2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|------------------------|------|---------|---|
| 15-6 | RESERVED | R | 0b | Reserved |
| 5-0 | PMA/PMD type selection | R | 111101Ь | PMA or PMD type selection field 1111xb = reserved for future use 11100b = reserved for future use 1110xxb = reserved for future use 110xxxb = reserved for future use 11101b = 100BASE-T1 PMA or PMD |

8.6.2.87 MMD1_PMA_EXT_ABILITY_1 Register (Address = 100Bh) [Reset = 0800h]

MMD1_PMA_EXT_ABILITY_1 is shown in MMD1_PMA_EXT_ABILITY_1 Register and described in MMD1_PMA_EXT_ABILITY_1 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-102. MMD1_PMA_EXT_ABILITY_1 Register

| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
|----|----------|------|----|----------------------------------|----|----------|---|
| | RESE | RVED | | BASE-T1 extended abilities | | RESERVED | |
| | R-0b | | | | | R-0b | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | RESERVED | | | | | | |
| | R-0b | | | | | | |
| | | | | | | | |

Table 8-113. MMD1_PMA_EXT_ABILITY_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|----------------------------|------|-------|---|
| 15-12 | RESERVED | R | 0b | Reserved |
| 11 | BASE-T1 extended abilities | R | 1b | 1 = PMA/PMD has BASE-T1 extended abilities listed in register 18 in MMD1 0 = PMA/PMD does not have BASE-T1 extended abilities 0b = PMA/PMD does not have BASE-T1 extended abilities 1b = PMA/PMD has BASE-T1 extended abilities listed in register 18 in MMD1 |
| 10-0 | RESERVED | R | 0b | Reserved |



8.6.2.88 MMD1_PMA_EXT_ABILITY_2 Register (Address = 1012h) [Reset = 0001h]

MMD1_PMA_EXT_ABILITY_2 is shown in MMD1_PMA_EXT_ABILITY_2 Register and described in MMD1_PMA_EXT_ABILITY_2 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-103. MMD1_PMA_EXT_ABILITY_2 Register

| | | • | | | _ 0 | | | |
|----|----|--------------------|-------------|----|-----|---|------|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| | | | RESERVED | | | | | |
| | | | R- | 0b | | | | |
| 7 | 6 | 5 | 5 4 3 2 1 0 | | | | | |
| | | RESERVED 100BA abi | | | | | | |
| | | | R-0b | | | | R-1b | |

Table 8-114. MMD1_PMA_EXT_ABILITY_2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|--------------------|------|-------|--|
| 15-1 | RESERVED | R | 0b | Reserved |
| 0 | 100BASE-T1 ability | R | | 1 = PMA/PMD is able to perform 100BASE-T1 0 = PMA/PMD is not able to perform 100BASE-T1 0b = PMA/PMD is not able to perform 100BASE-T1 1b = PMA/PMD is able to perform 100BASE-T1 |



8.6.2.89 MMD1_PMA_CTRL_2 Register (Address = 1834h) [Reset = 8000h]

MMD1_PMA_CTRL_2 is shown in MMD1_PMA_CTRL_2 Register and described in MMD1_PMA_CTRL_2 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-104. MMD1_PMA_CTRL_2 Register

| 15 14 13 12 11 10 9 8 master_slave_man_cfg_en brk_ms_cfg R^{M} | | | | | | | | |
|--|------|------------|------|----|------|----------|--------|---|
| man_cfg_en R R-1b R/W-0b R-0b 7 6 5 4 3 2 1 0 RESERVED type selection | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| 7 6 5 4 3 2 1 0 RESERVED type selection | | brk_ms_cfg | | | RESE | RVED | | |
| RESERVED type selection | R-1b | R/W-0b | | | R- | 0b | | |
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| R-0b R-0b | | RESE | RVED | | | type sel | ection | |
| | | R- | 0b | | | R-0 |)b | |

Table 8-115. MMD1_PMA_CTRL_2 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|------|-----------------------------|------|-------|--|
| 15 | master_slave_man_cfg_e n | R | 1b | Value always 1 |
| 14 | brk_ms_cfg | R/W | 0b | 1 = Configure PHY as MASTER 0 = Configure PHY as SLAVE pkg_36: reset_val = LED_0_strap pkg_28: reset_val = RX_D3_strap 0b = Configure PHY as SLAVE 1b = Configure PHY as MASTER |
| 13-4 | RESERVED | R | 0b | Reserved |
| 3-0 | type selection | R | 0b | type selection field 1xxxb = Reserved for future use 01xxb = Reserved for future use 001xb = Reserved for future use 0001b = Reserved for future use 0b = 100BASE-T1 |



8.6.2.90 MMD1_PMA_TEST_MODE_CTRL Register (Address = 1836h) [Reset = 0000h]

MMD1_PMA_TEST_MODE_CTRL is shown in MMD1_PMA_TEST_MODE_CTRL Register and described in MMD1_PMA_TEST_MODE_CTRL Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-105. MMD1_PMA_TEST_MODE_CTRL Register

| | | 0 | | _ | _ 0 | | | |
|----|---------------|----|----------|----|--------|---|---|--|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | |
| | brk_test_mode | | RESERVED | | | | | |
| | R/W-0b | | | | R/W-0b | | | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| | RESERVED | | | | | | | |
| | R/W-0b | | | | | | | |
| | | | | | | | | |

Table 8-116. MMD1_PMA_TEST_MODE_CTRL Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|---------------|------|-------|---|
| 15-13 | brk_test_mode | R/W | Ob | 100BASE-T1 test mode control 000b = Normal mode operation 001b = Test mode 1 010b = Test mode 2 011b = Reserved 100b = Test mode 4 101b = Test mode 5 110b = Reserved 111b = Reserved |
| 12-0 | RESERVED | R/W | 0b | Reserved |



8.6.2.91 MMD3_PCS_CTRL_1 Register (Address = 3000h) [Reset = 0000h]

MMD3_PCS_CTRL_1 is shown in MMD3_PCS_CTRL_1 Register and described in MMD3_PCS_CTRL_1 Register Field Descriptions.

Return to the DP83TC814 Registers.

Figure 8-106. MMD3_PCS_CTRL_1 Register

| | | | · · · · · · · · · · · · · · · · · · · | | | | |
|-----------|--------------|----|---------------------------------------|----|------------------------|------|------|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| PCS_Reset | PCS_loopback | | RESERVED | | rx_clock_stoppa ble | RESE | RVED |
| R/W-0b | R/W-0b | | R-0b | | R/W-0b | R-0b | |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| RESERVED | | | | | | | |
| R-0b | | | | | | | |
| | | | | | | | |

Table 8-117. MMD3_PCS_CTRL_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|--------------------|------|-------|--|
| 15 | PCS_Reset | R/W | 0b | Reset bit, Self Clear. When write to this bit 1: 1. reset the registers (not vendor specific) at MMD3/MMD7. 2. Reset brk_top Please notice: This register is WSC (write-self-clear) and not read-only! |
| 14 | PCS_loopback | R/W | 0b | This bit is cleared by PCS_Reset |
| 13-11 | RESERVED | R | 0b | Reserved |
| 10 | rx_clock_stoppable | R/W | 0b | RW, reset value = 1. 1= PHY may stop receive clock during LPI 0= Clock not stoppable Note: this flop implemented at glue logic |
| 9-0 | RESERVED | R | 0b | Reserved |



8.6.2.92 MMD3_PCS_Status_1 Register (Address = 3001h) [Reset = 0000h]

MMD3_PCS_Status_1 is shown in MMD3_PCS_Status_1 Register and described in MMD3_PCS_Status_1 Register Field Descriptions.

Return to the DP83TC814 Registers.

| | | Figure 8 | -107. MMD3_F | PCS_Status_1 | Register | | |
|----------|------------------------|----------|--------------|---------------------|---------------------|-----------------------|-----------------------|
| 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| | RESE | RVED | | TX_LPI_receive d | RX_LPI_receive d | Tx_LPI_indicati on | Rx_LPI_indicati on |
| | R-0 | Ob | | R-0b | R-0b | R-0b | R-0b |
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| RESERVED | tx_clock_stoppa ble | | | RESE | RVED | | |
| R-0b | R-0b | | | R- | 0b | | |

Table 8-118. MMD3_PCS_Status_1 Register Field Descriptions

| Bit | Field | Туре | Reset | Description |
|-------|--------------------|------|-------|--|
| 15-12 | RESERVED | R | 0b | Reserved |
| 11 | TX_LPI_received | R | 0b | RO/LH 0b = LPI not received 1b = Tx PCS hs received LPI |
| 10 | RX_LPI_received | R | 0b | RO/LH 0b = LPI not received 1b = Rx PCS hs received LPI |
| 9 | Tx_LPI_indication | R | 0b | 1= TX PCS is currently receiving LPI 0= PCS is not currently receiving LPI 0b = PCS is not currently receiving LPI 1b = TX PCS is currently receiving LPI |
| 8 | Rx_LPI_indication | R | 0b | 1= RX PCS is currently receiving LPI 0= PCS is not currently receiving LPI 0b = PCS is not currently receiving LPI 1b = RX PCS is currently receiving LPI |
| 7 | RESERVED | R | 0b | Reserved |
| 6 | tx_clock_stoppable | R | 0b | 1= the MAC may stop the clock during LPI 0= Clock not stoppable 0b = Clock not stoppable 1b = the MAC may stop the clock during LPI |
| 5-0 | RESERVED | R | 0b | Reserved |



9 Application and Implementation

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

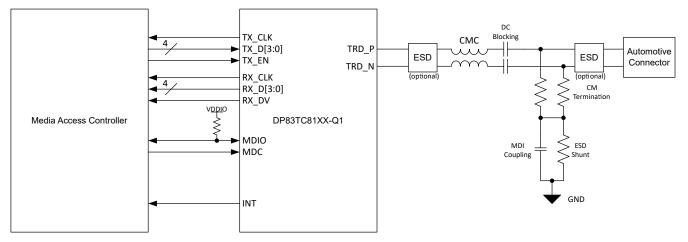
9.1 Application Information

The DP83TC814 is a single-port 100-Mbps Automotive Ethernet PHY. It supports IEEE 802.3bw and allows for connections to an Ethernet MAC through MII, RMII, RGMII, or SGMII. When using the device for Ethernet applications, it is necessary to meet certain requirements for normal operation. The following subsections are intended to assist in appropriate component selection and required connections.

Note Refer to SNLA389 Application Note for more information about the register settings used for compliance testing. It is necessary to use these register settings in order to achieve the same performance as observed during compliance testing.

9.2 Typical Applications

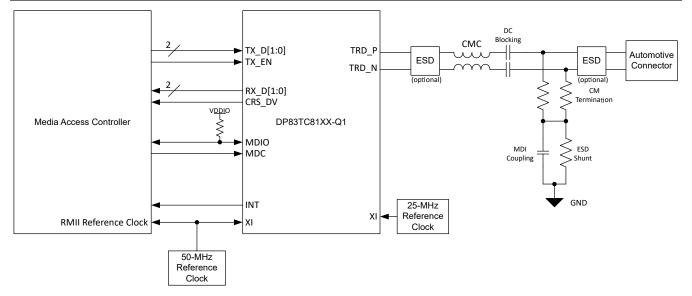
Figure 9-1 through Figure 9-5 show some the typical applications for the DP83TC814x-Q1.





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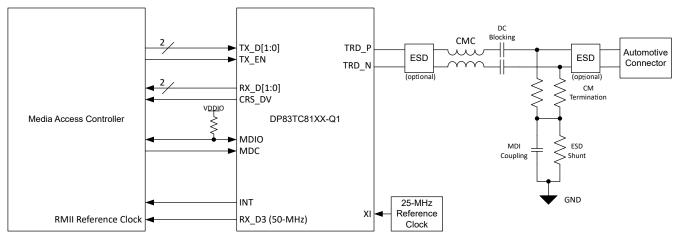
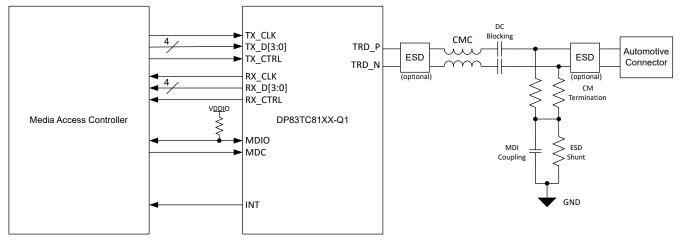


Figure 9-3. Typical Application (RMII Master)







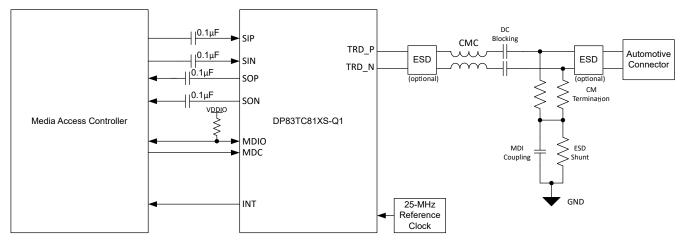


Figure 9-5. Typical Application (SGMII)



9.2.1 Design Requirements

For these typical applications, use the following as design parameters from the table below. Refer to *Power Supply Recommendations* section for detailed connection diagram.

| DESIGN PARAMETER | EXAMPLE VALUE | | | | | | | | |
|--|--|--|--|--|--|--|--|--|--|
| V _{DDIO} | 1.8 V, 2.5 V, or 3.3 V | | | | | | | | |
| V _{DDMAC} | 1.8 V, 2.5 V, or 3.3 V | | | | | | | | |
| V _{DDA} | 3.3 V | | | | | | | | |
| Decoupling capacitors V_{DDIO} ⁽²⁾ ⁽³⁾ | 1.8 V, 2.5 V, or 3.3 V | | | | | | | | |
| (Optional) ferrite bead for V _{DDIO} ⁽³⁾ | 1 kΩ at 100 MHz (BLM18KG601SH1D) | | | | | | | | |
| Decoupling capacitors V _{DDMAC} ⁽²⁾ | 0.01 µF, 0.47 µF | | | | | | | | |
| Ferrite bead for V _{DDMAC} | 1 kΩ at 100 MHz (BLM18KG601SH1D) 0.01 μF, 0.47 μF 1 kΩ at 100 MHz (BLM18KG601SH1D) 0.01 μF, 0.47 μF 1 kΩ at 100 MHz (BLM18KG601SH1D) | | | | | | | | |
| Decoupling capacitors V _{DDA} ⁽²⁾ | 0.01 µF, 0.47 µF | | | | | | | | |
| (Optional) ferrite bead for V _{DDA} | 1 kΩ at 100 MHz (BLM18KG601SH1D) | | | | | | | | |
| Decoupling capacitors | 0.1 µF | | | | | | | | |
| V _{DDA} (pin 7) | | | | | | | | | |
| DC Blocking Capacitors ⁽²⁾ | 0.1 µF | | | | | | | | |
| Common-Mode Choke | 200 µH | | | | | | | | |
| Common Mode Termination Resistors ⁽¹⁾ | 1 kΩ | | | | | | | | |
| MDI Coupling Capacitor ⁽²⁾ | 4.7 nF | | | | | | | | |
| ESD Shunt ⁽²⁾ | 100 kΩ | | | | | | | | |
| Reference Clock | 25 MHz | | | | | | | | |

Table 9-1. Design Parameters

(1) 1% tolerance components are recommended.

(2) 10% tolerance components are recommended.

(3) If VDDIO is separate from VDDMAC then additional ferrite bead and 0.47µF capacitor will be required on VDDIO.

9.2.1.1 Physical Medium Attachment

There must be no metal running beneath the common-mode choke. CMCs can inject noise into metal beneath them, which can affect the emissions and immunity performance of the system. Because the DP83TC814S-Q1 is a voltage mode line driver, no external termination resistors are required. The ESD shunt and MDI coupling capacitor must be connected to ground. Ensure that the common mode termination resistors are 1% tolerance or better to improve differential coupling.



9.2.1.1.1 Common-Mode Choke Recommendations

The following CMCs are recommended for use with the DP83TC814S-Q1 :

Table 9-2. Recommended CMCs

| MANUFACTURER | PART NUMBER |
|-------------------|----------------|
| Pulse Electronics | AE2002 |
| Murata | DLW43MH201XK2L |
| Murata | DLW32MH201XK2 |
| TDK | ACT1210L-201 |

| PARAMETER | ТҮР | UNITS | CONDITIONS |
|------------------------------------|------|-------|--------------|
| Insertion Loss | -0.5 | dB | 1 – 30 MHz |
| Insention Loss | -1.0 | dB | 30 – 60 MHz |
| Return Loss | -26 | dB | 1 – 30 MHz |
| Return Loss | -20 | dB | 30 – 60 MHz |
| | -24 | dB | 1 MHz |
| Common-Mode Rejection | -42 | dB | 10 – 100 MHz |
| | -25 | dB | 400 MHz |
| | -70 | dB | 1 – 10 MHz |
| Differential Common-Mode Rejection | -50 | dB | 100 MHz |
| | -24 | dB | 1000 MHz |

Table 9-3. CMC Electrical Specifications



9.2.2 Detailed Design Procedure

When creating a new system design with an Ethernet PHY, follow this schematic capture procedure:

- 1. Select desired PHY hardware configurations in table Table 8-17.
- 2. Use the Electrical Characteristics table, the Table 8-15 table and the Table 8-16 table to select the correct external bootstrap resistors.
- 3. If using LEDs, ensure the correct external circuit is applied as shown in Figure 8-15.
- 4. Select an appropriate clock source that adheres to either the CMOS-level oscillator or crystal resonator requirements within the Electrical Characteristics table.
- 5. Select a CMC, a list of recommended CMCs are located in Table 9-2.
- 6. Add common-mode termination, DC-blocking capacitors, an MDI-coupling capacitor, and an ESD shunt found in Table 9-1.
- 7. Ensure that there is sufficient supply decoupling on VDDIO and VDDA supply pins.
- 8. Add an external pullup resistor (tie to VDDIO) on MDIO line.
- 9. If operating with SGMII, place 0.1-µF, DC-blocking capacitors between the MAC and PHY SGMII pins.

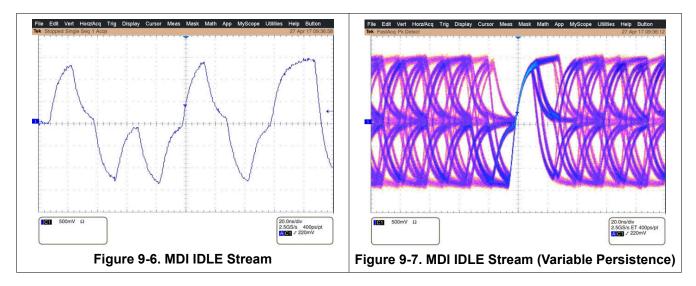
The following layout procedure must be followed:

- 1. Locate the PHY near the edge of the board so that short MDI traces can be routed to the desired connector.
- 2. Place the MDI external components: CMC, DC-blocking capacitors, CM termination, MDI-coupling capacitor, and ESD shunt.
- 3. Create a top-layer metal pour keepout under the CMC.
- 4. Ensure that the MDI TRD_M and TRD_P traces are routed such that they are $100-\Omega$ differential.
- 5. Place the clock source near the XI and XO pins.
- 6. Ensure that when configured for MII, RMII, or RGMII operation, the xMII pins are routed 50- Ω and are single-ended with reference to ground.
- 7. Ensure that transmit path xMII pins are routed such that setup and hold timing does not violate the PHY requirements.
- 8. Ensure that receive path xMII pins are routed such that setup and hold timing does not violate the MAC requirements.
- 9. Ensure that when configured for SGMII operation, the xMII RX_P, RX_M, TX_P, and TX_M pins are routed 100-Ω differential.
- 10. Place the MDIO pullup close to the PHY.



9.2.3 Application Curves

The following curves were obtained using the PHY evaluation module under nominal conditions.

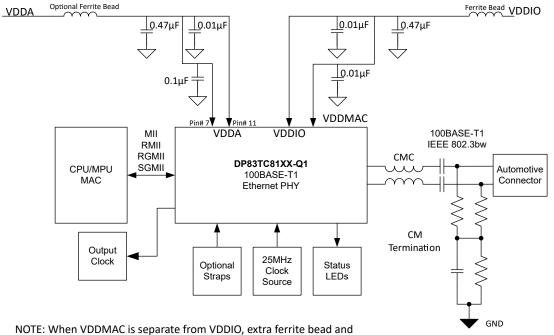




10 Power Supply Recommendations

The DP83TC814S-Q1 is capable of operating with a wide range of IO supply voltages (3.3 V, 2.5 V, or 1.8 V). No power supply sequencing is required. The recommended power supply de-coupling network is shown in the figure below. For improved conducted emissions, an optional ferrite bead may be placed between the supply and the PHY de-coupling network.

Typical application block diagram along with supply and peripherals is shown below.



0.47uF capacitor should be used for decoupling.

Figure 10-1. Typical Application With Peripherals

When VDDIO and VDDMAC are separate, both voltage rails should have a dedicated network of ferrite bead, 0.47uF, and 0.01uF capacitors.



Current Consumption Break-Down

The following table highlights the break down of power consumption in active mode for each supply rail, specifically highlighting the split between VDDMAC and VDDIO.

| VOLTAGE RAIL | VOLTAGE (V) | MAX CURRENT (mA) ¹ |
|-------------------|-------------|-------------------------------|
| | MII | |
| VDDA | 3.3 | 63 |
| VDDIO | 3.3 | 4 |
| | 2.5 | 3 |
| | 1.8 | 2 |
| VDDMAC | 3.3 | 20 |
| | 2.5 | 15 |
| | 1.8 | 11 |
| VDDA (pin #7) | 3.3 | 2 |
| | RMII | |
| VDDA | 3.3 | 63 |
| VDDIO | 3.3 | 6 |
| | 2.5 | 4 |
| | 1.8 | 3 |
| VDDMAC | 3.3 | 17 |
| | 2.5 | 13 |
| | 1.8 | 10 |
| VDDA (pin #7) | 3.3 | 2 |
| | RGMII | |
| VDDA | 3.3 | 63 |
| VDDIO | 3.3 | 4 |
| | 2.5 | 3 |
| | 1.8 | 2 |
| VDDMAC | 3.3 | 17 |
| | 2.5 | 13 |
| | 1.8 | 10 |
| VDDA (pin #7) | 3.3 | 2 |
| (bb) ((piii iii)) | SGMII | |
| VDDA | 3.3 | 95 |
| | | |
| VDDIO | 3.3 | 4 3 |
| | 1.8 | 2 |
| VDDMAC | 3.3 | 8 |
| VDDIVIAC | 2.5 | 6 |
| | 1.8 | 4 |
| | | |
| VDDA (pin #7) | 3.3 | 2 |

1. Current consumption measured across voltage, temperature, and process with active data communication.



11 Layout 11.1 Layout Guidelines

11.1.1 Signal Traces

PCB traces are lossy and long traces can degrade signal quality. Traces must be kept short as possible. Unless mentioned otherwise, all signal traces must be $50-\Omega$, single-ended impedance. Differential traces must be $50-\Omega$ single-ended and $100-\Omega$ differential. Take care to ensure impedance is controlled throughout. Impedance discontinuities will cause reflections leading to emissions and signal integrity issues. Stubs must be avoided on all signal traces, especially differential signal pairs.

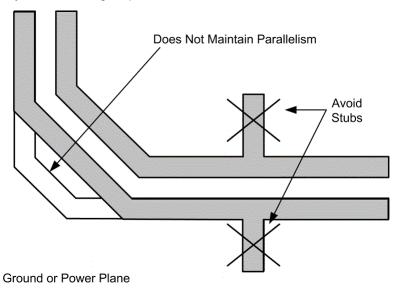


Figure 11-1. Differential Signal Trace Routing

Within the differential pairs, trace lengths must be run parallel to each other and matched in length. Matched lengths minimize delay differences, avoiding an increase in common mode noise and emissions. Length matching is also important for MAC interface connections. All transmit signal traces must be length matched to each other and all receive signal traces must be length matched to each other. For SGMII differential traces, it is recommended to keep the skew mismatch below 20ps.

Ideally, there must be no crossover on signal path traces. High speed signal traces must be routed on internal layers to improved EMC performance. However, vias present impedance discontinuities and must be minimized when possible. Route trace pairs on the same layer. Signals on different layers must not cross each other without at least one return path plane between them. Differential pairs must always have a constant coupling distance between them. For convenience and efficiency, TI recommends routing critical signals first (that is, MDI differential pairs, reference clock, and MAC IF traces).

11.1.2 Return Path

A general best practice is to have a solid return path beneath all signal traces. This return path can be a continuous ground or DC power plane. Reducing the width of the return path can potentially affect the impedance of the signal trace. This effect is more prominent when the width of the return path is comparable to the width of the signal trace. Breaks in return path between the signal traces should be avoided at all cost. A signal crossing a split plane may cause unpredictable return path currents and could impact signal quality and result in emissions issues.



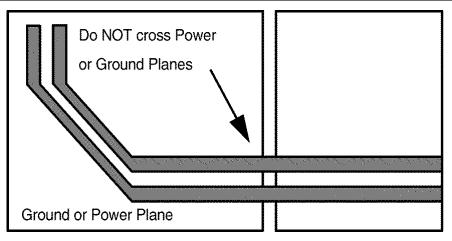


Figure 11-2. Power and Ground Plane Breaks

11.1.3 Metal Pour

All metal pours that are not signals or power must be tied to ground. There must be no floating metal in the system, and there must be no metal between differential traces.

11.1.4 PCB Layer Stacking

To meet signal integrity and performance requirements, minimum four-layer PCB is recommended. However, a six-layer PCB and above must be used when possible.

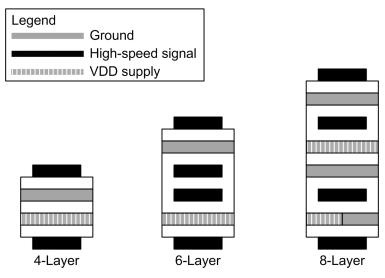
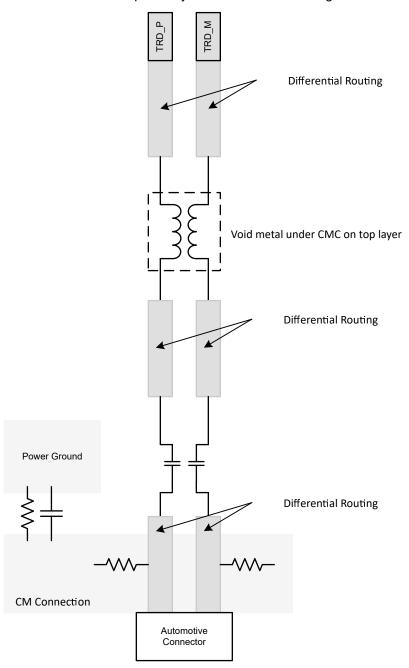


Figure 11-3. Recommended PCB Layer Stack-Up



11.2 Layout Example

There is an evaluation board references for the DP83TC814-Q1. The DP83TC812EVM-MC is a media converter board which can be used for interoperability and bit error rate testing.







12 Device and Documentation Support

12.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

12.2 Support Resources

TI E2E[™] support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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12.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

12.5 Glossary

TI Glossary This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



PACKAGING INFORMATION

| Orderable Device | Status | Package Type | | Pins | - | | Lead finish/ | MSL Peak Temp | Op Temp (°C) | Device Marking | Samples |
|------------------|--------|--------------|---------|------|------|--------------|---------------|---------------------|--------------|----------------|---------|
| | (1) | | Drawing | | Qty | (2) | Ball material | (3) | | (4/5) | |
| DP83TC814RRHARQ1 | ACTIVE | VQFN | RHA | 36 | 2500 | RoHS & Green | NIPDAU | Level-3-260C-168 HR | -40 to 125 | 814R | Samples |
| DP83TC814RRHATQ1 | ACTIVE | VQFN | RHA | 36 | 250 | RoHS & Green | NIPDAU | Level-3-260C-168 HR | -40 to 125 | 814R | Samples |
| DP83TC814SRHARQ1 | ACTIVE | VQFN | RHA | 36 | 2500 | RoHS & Green | NIPDAU | Level-3-260C-168 HR | -40 to 125 | 814S | Samples |
| DP83TC814SRHATQ1 | ACTIVE | VQFN | RHA | 36 | 250 | RoHS & Green | NIPDAU | Level-3-260C-168 HR | -40 to 125 | 814S | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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Texas

*All dimensions are nominal

STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| DP83TC814RRHARQ1 | VQFN | RHA | 36 | 2500 | 330.0 | 16.4 | 6.3 | 6.3 | 1.1 | 12.0 | 16.0 | Q2 |
| DP83TC814RRHATQ1 | VQFN | RHA | 36 | 250 | 180.0 | 16.4 | 6.3 | 6.3 | 1.1 | 12.0 | 16.0 | Q2 |
| DP83TC814SRHARQ1 | VQFN | RHA | 36 | 2500 | 330.0 | 16.4 | 6.3 | 6.3 | 1.1 | 12.0 | 16.0 | Q2 |
| DP83TC814SRHATQ1 | VQFN | RHA | 36 | 250 | 180.0 | 16.4 | 6.3 | 6.3 | 1.1 | 12.0 | 16.0 | Q2 |



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PACKAGE MATERIALS INFORMATION

3-Jun-2022



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| DP83TC814RRHARQ1 | VQFN | RHA | 36 | 2500 | 367.0 | 367.0 | 35.0 |
| DP83TC814RRHATQ1 | VQFN | RHA | 36 | 250 | 210.0 | 185.0 | 35.0 |
| DP83TC814SRHARQ1 | VQFN | RHA | 36 | 2500 | 367.0 | 367.0 | 35.0 |
| DP83TC814SRHATQ1 | VQFN | RHA | 36 | 250 | 210.0 | 185.0 | 35.0 |

RHA 36

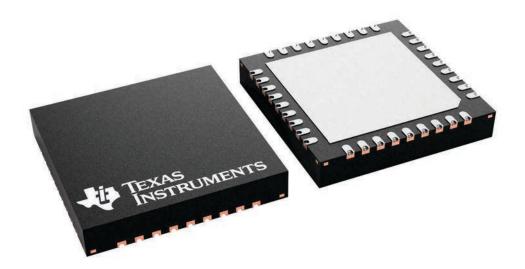
6 x 6, 0.5 mm pitch

GENERIC PACKAGE VIEW

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





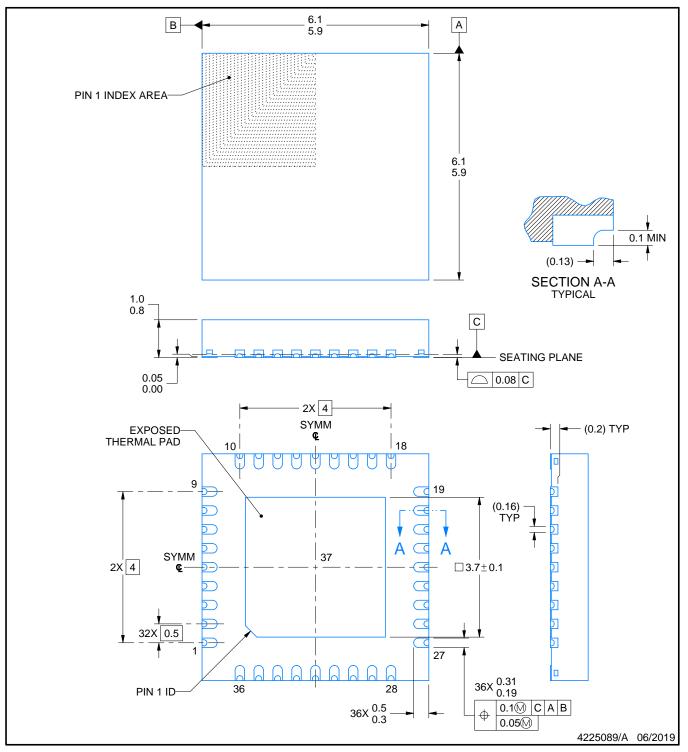
RHA0036A



PACKAGE OUTLINE

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

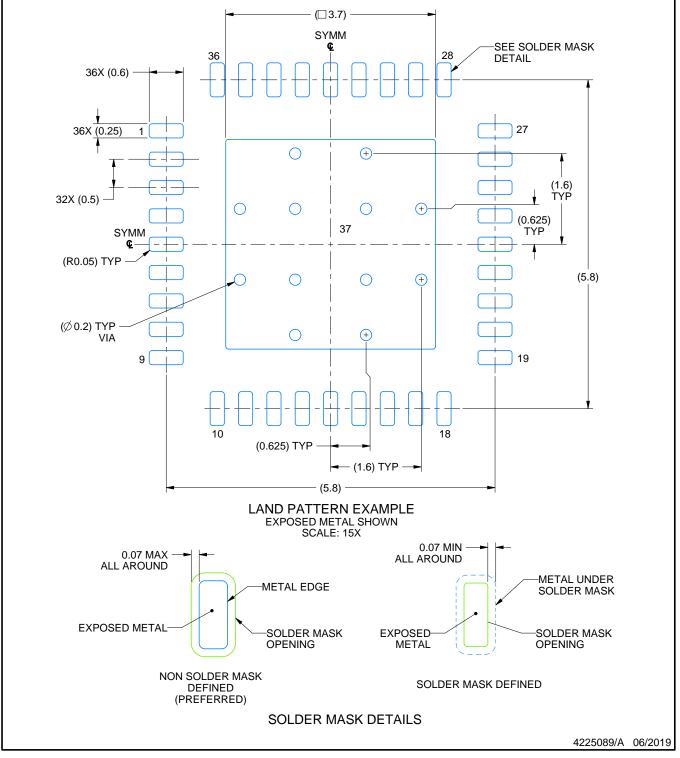


RHA0036A

EXAMPLE BOARD LAYOUT

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

 This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

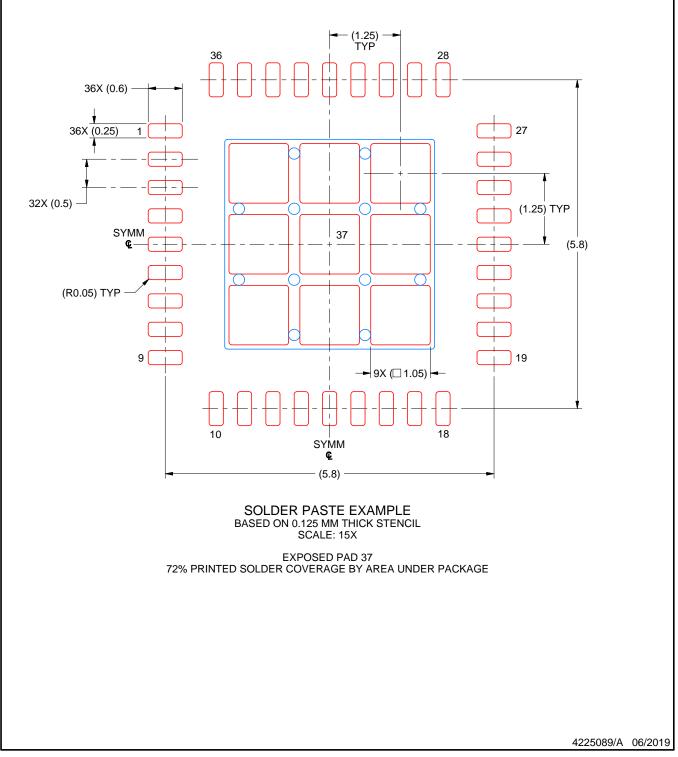


RHA0036A

EXAMPLE STENCIL DESIGN

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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